

## TL07xx Low-Noise FET-Input Operational Amplifiers

### 1 Features

- High slew rate: 20 V/ $\mu$ s (TL07xH, typ)
- Low offset voltage: 1 mV (TL07xH, typ)
- Low offset voltage drift: 2  $\mu$ V/ $^{\circ}$ C
- Low power consumption: 940  $\mu$ A/ch (TL07xH, typ)
- Wide common-mode and differential voltage ranges
  - Common-mode input voltage range includes  $V_{CC+}$
- Low input bias and offset currents
- Low noise:  $V_n = 18 \text{ nV}/\sqrt{\text{Hz}}$  (typ) at  $f = 1 \text{ kHz}$
- Output short-circuit protection
- Low total harmonic distortion: 0.003% (typ)
- Wide supply voltage:  $\pm 2.25 \text{ V}$  to  $\pm 20 \text{ V}$ , 4.5 V to 40 V

### 2 Applications

- [Solar energy: string and central inverter](#)
- [Motor drives: AC and servo drive control and power stage modules](#)
- [Single phase online UPS](#)
- [Three phase UPS](#)
- [Pro audio mixers](#)
- [Battery test equipment](#)

### 3 Description

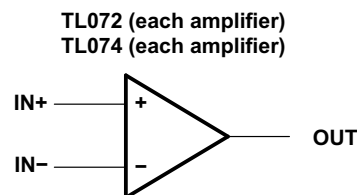
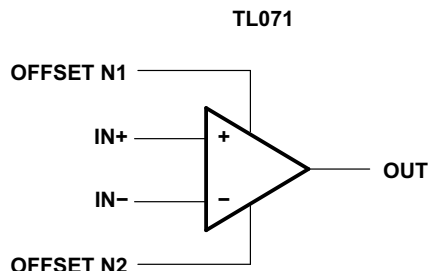
The TL07xH (TL071H, TL072H, and TL074H) family of devices are the next-generation versions of the industry-standard TL07x (TL071, TL072, and TL074) devices. These devices provide outstanding value for cost-sensitive applications, with features including low offset (1 mV, typical), high slew rate (20 V/ $\mu$ s), and common-mode input to the positive supply. High ESD

(1.5 kV, HBM), integrated EMI and RF filters, and operation across the full  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$  enable the TL07xH devices to be used in the most rugged and demanding applications.

#### Device Information

| PART NUMBER <sup>(1)</sup> | PACKAGE     | BODY SIZE (NOM)           |
|----------------------------|-------------|---------------------------|
| TL071x                     | PDIP (8)    | 9.59 mm $\times$ 6.35 mm  |
|                            | SC70 (5)    | 2.00 mm $\times$ 1.25 mm  |
|                            | SO (8)      | 6.20 mm $\times$ 5.30 mm  |
|                            | SOIC (8)    | 4.90 mm $\times$ 3.90 mm  |
|                            | SOT-23 (5)  | 1.60 mm $\times$ 1.20 mm  |
| TL072x                     | PDIP (8)    | 9.59 mm $\times$ 6.35 mm  |
|                            | SO (8)      | 6.20 mm $\times$ 5.30 mm  |
|                            | SOIC (8)    | 4.90 mm $\times$ 3.90 mm  |
|                            | SOT-23 (8)  | 2.90 mm $\times$ 1.60 mm  |
|                            | TSSOP (8)   | 4.40 mm $\times$ 3.00 mm  |
| TL072M                     | CDIP (8)    | 9.59 mm $\times$ 6.67 mm  |
|                            | CFP (10)    | 6.12 mm $\times$ 3.56 mm  |
|                            | LCCC (20)   | 8.89 mm $\times$ 8.89 mm  |
| TL074x                     | PDIP (14)   | 19.30 mm $\times$ 6.35 mm |
|                            | SO (14)     | 10.30 mm $\times$ 5.30 mm |
|                            | SOIC (14)   | 8.65 mm $\times$ 3.91 mm  |
|                            | SOT-23 (14) | 4.20 mm $\times$ 2.00 mm  |
|                            | SSOP (14)   | 6.20 mm $\times$ 5.30 mm  |
|                            | TSSOP (14)  | 5.00 mm $\times$ 4.40 mm  |
| TL074M                     | CDIP (14)   | 19.56 mm $\times$ 6.92 mm |
|                            | CFP (14)    | 9.21 mm $\times$ 6.29 mm  |
|                            | LCCC (20)   | 8.89 mm $\times$ 8.89 mm  |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



Copyright © 2017, Texas Instruments Incorporated

#### Logic Symbols



## Table of Contents

|                                                                         |    |                                                                          |    |
|-------------------------------------------------------------------------|----|--------------------------------------------------------------------------|----|
| <b>1 Features</b> .....                                                 | 1  | 6.22 Electrical Characteristics: TL071M, TL072M.....                     | 23 |
| <b>2 Applications</b> .....                                             | 1  | 6.23 Electrical Characteristics: TL074M.....                             | 24 |
| <b>3 Description</b> .....                                              | 1  | 6.24 Switching Characteristics: TL07xM.....                              | 25 |
| <b>4 Revision History</b> .....                                         | 2  | 6.25 Switching Characteristics: TL07xC, TL07xAC,<br>TL07xBC, TL07xI..... | 25 |
| <b>5 Pin Configuration and Functions</b> .....                          | 5  | 6.26 Typical Characteristics: TL07xH.....                                | 26 |
| <b>6 Specifications</b> .....                                           | 12 | 6.27 Typical Characteristics: All Devices Except<br>TL07xH.....          | 33 |
| 6.1 Absolute Maximum Ratings: TL07xH .....                              | 12 | <b>7 Parameter Measurement Information</b> .....                         | 37 |
| 6.2 Absolute Maximum Ratings: All Devices Except<br>TL07xH.....         | 12 | <b>8 Detailed Description</b> .....                                      | 38 |
| 6.3 ESD Ratings: TL07xH .....                                           | 12 | 8.1 Overview.....                                                        | 38 |
| 6.4 ESD Ratings: All Devices Except TL07xH.....                         | 13 | 8.2 Functional Block Diagram.....                                        | 38 |
| 6.5 Recommended Operating Conditions: TL07xH .....                      | 13 | 8.3 Feature Description.....                                             | 39 |
| 6.6 Recommended Operating Conditions: All<br>Devices Except TL07xH..... | 13 | 8.4 Device Functional Modes.....                                         | 39 |
| 6.7 Thermal Information for Single Channel: TL071H ...                  | 13 | <b>9 Application and Implementation</b> .....                            | 40 |
| 6.8 Thermal Information: TL071x.....                                    | 14 | 9.1 Application Information.....                                         | 40 |
| 6.9 Thermal Information for Dual Channel: TL072H .....                  | 14 | 9.2 Typical Application.....                                             | 40 |
| 6.10 Thermal Information: TL072x.....                                   | 14 | 9.3 Unity Gain Buffer.....                                               | 41 |
| 6.11 Thermal Information: TL072x (cont.).....                           | 15 | 9.4 System Examples.....                                                 | 42 |
| 6.12 Thermal Information for Quad Channel: TL074H ...                   | 15 | <b>10 Power Supply Recommendations</b> .....                             | 43 |
| 6.13 Thermal Information: TL074x.....                                   | 15 | <b>11 Layout</b> .....                                                   | 43 |
| 6.14 Thermal Information: TL074x (cont.).....                           | 16 | 11.1 Layout Guidelines.....                                              | 43 |
| 6.15 Thermal Information: TL074x (cont.).....                           | 16 | 11.2 Layout Example.....                                                 | 44 |
| 6.16 Thermal Information.....                                           | 16 | <b>12 Device and Documentation Support</b> .....                         | 45 |
| 6.17 Electrical Characteristics: TL07xH .....                           | 17 | 12.1 Receiving Notification of Documentation Updates.....                | 45 |
| 6.18 Electrical Characteristics: TL071C, TL072C,<br>TL074C.....         | 19 | 12.2 Support Resources.....                                              | 45 |
| 6.19 Electrical Characteristics: TL071AC, TL072AC,<br>TL074AC.....      | 20 | 12.3 Trademarks.....                                                     | 45 |
| 6.20 Electrical Characteristics: TL071BC, TL072BC,<br>TL074BC.....      | 21 | 12.4 Electrostatic Discharge Caution.....                                | 45 |
| 6.21 Electrical Characteristics: TL071I, TL072I,<br>TL074I.....         | 22 | 12.5 Glossary.....                                                       | 45 |
|                                                                         |    | <b>13 Mechanical, Packaging, and Orderable<br/>Information</b> .....     | 45 |

## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

|                                                                                                               |             |
|---------------------------------------------------------------------------------------------------------------|-------------|
| <b>Changes from Revision S (July 2021) to Revision T (December 2021)</b> .....                                | <b>Page</b> |
| • Corrected DCK pinout diagram and table in <i>Pin Configurations and Functions</i> section.....              | 5           |
| <b>Changes from Revision R (June 2021) to Revision S (July 2021)</b> .....                                    | <b>Page</b> |
| • Deleted preview note from TL071H SOIC (8), SOT-23 (5) and SC70 (5) packages throughout the data sheet       | 1           |
| <b>Changes from Revision Q (June 2021) to Revision R (June 2021)</b> .....                                    | <b>Page</b> |
| • Deleted preview note from TL072H SOIC (8), SOT-23 (8) and TSSOP (8) packages throughout the data sheet..... | 1           |
| • Added ESD information for TL072H.....                                                                       | 12          |
| • Added I <sub>Q</sub> spec for TL072H.....                                                                   | 17          |
| <b>Changes from Revision P (November 2020) to Revision Q (June 2021)</b> .....                                | <b>Page</b> |
| • Deleted VSSOP (8) package from the <i>Device Information</i> section.....                                   | 1           |

|                                                                                                                    |    |
|--------------------------------------------------------------------------------------------------------------------|----|
| • Added DBV, DCK, and D packages to TL071H in <i>Pin Configuration and Functions</i> section.....                  | 5  |
| • Deleted DGK package from TL072x in <i>Pin Configuration and Functions</i> section.....                           | 5  |
| • Deleted tables with duplicate information from the <i>Specifications</i> section.....                            | 12 |
| • Added D, DCK, and DBV package thermal information in Thermal Information for Single Channel: TL071H section..... | 13 |
| • Added D, DDF, and PW package thermal information in Thermal Information for Dual Channel: TL072H section.....    | 14 |
| • Added $I_B$ and $I_{OS}$ specification for single channel DCK and DBV package.....                               | 17 |
| • Added $I_Q$ spec for TL071H.....                                                                                 | 17 |
| • Deleted <i>Related Links</i> section from the <i>Device and Documentation Support</i> section.....               | 45 |

| Changes from Revision O (October 2020) to Revision P (November 2020)                                                    | Page |
|-------------------------------------------------------------------------------------------------------------------------|------|
| • Added SOIC and TSSOP package thermal information in <i>Thermal Information for Quad Channel: TL074H</i> section ..... | 15   |
| • Added <i>Typical Characteristics:TL07xH</i> section in <i>Specifications</i> section.....                             | 26   |

| Changes from Revision N (July 2017) to Revision O (October 2020)                                                            | Page |
|-----------------------------------------------------------------------------------------------------------------------------|------|
| • Updated the numbering format for tables, figures, and cross-references throughout the document.....                       | 1    |
| • Features of TL07xH added to the <i>Features</i> section.....                                                              | 1    |
| • Added link to applications in the <i>Applications</i> section.....                                                        | 1    |
| • Added TL07xH in the <i>Description</i> section.....                                                                       | 1    |
| • Added TL07xH device in the <i>Device Information</i> section.....                                                         | 1    |
| • Added SOT-23 (14), VSSOP (8), SOT-23 (8), SC70 (5), and SOT-23 (5) packages to the <i>Device Information</i> section..... | 1    |
| • Added TSSOP, VSSOP and DDF packages to TL072x in <i>Pin Configuration and Functions</i> section.....                      | 5    |
| • Added DYY package to TL074x in <i>Pin Configuration and Functions</i> section.....                                        | 5    |
| • Removed Table of Graphs from the <i>Typical Characteristics</i> section.....                                              | 33   |
| • Deleted reference to obsolete documentation in <i>Layout Guidelines</i> section.....                                      | 43   |
| • Removed <i>Related Documentation</i> section.....                                                                         | 45   |

| Changes from Revision M (February 2014) to Revision N (July 2017)                                                                       | Page |
|-----------------------------------------------------------------------------------------------------------------------------------------|------|
| • Updated data sheet text to latest documentation and translation standards.....                                                        | 1    |
| • Added TL072M and TL074M devices to data sheet .....                                                                                   | 1    |
| • Rewrote text in <i>Description</i> section .....                                                                                      | 1    |
| • Changed TL07x 8-pin PDIP package to 8-pin CDIP package in <i>Device Information</i> table .....                                       | 1    |
| • Deleted 20-pin LCCC package from <i>Device Information</i> table .....                                                                | 1    |
| • Added 2017 copyright statement to front page schematic.....                                                                           | 1    |
| • Deleted TL071x FK (LCCC) pinout drawing and pinout table in <i>Pin Configurations and Functions</i> section .....                     | 5    |
| • Updated pinout diagrams and pinout tables in <i>Pin Configurations and Functions</i> section .....                                    | 5    |
| • Deleted differential input voltage parameter from <i>Absolute Maximum Ratings</i> table .....                                         | 12   |
| • Deleted table notes from <i>Absolute Maximum Ratings</i> table .....                                                                  | 12   |
| • Added new table note to <i>Absolute Maximum Ratings</i> table .....                                                                   | 12   |
| • Changed minimum supply voltage value from –18 V to –0.3 V in <i>Absolute Maximum Ratings</i> table.....                               | 12   |
| • Changed maximum supply voltage from 18 V to 36 V in <i>Absolute Maximum Ratings</i> table.....                                        | 12   |
| • Changed minimum input voltage value from –15 V to $V_{CC-} - 0.3$ V in <i>Absolute Maximum Ratings</i> table.....                     | 12   |
| • Changed maximum input voltage from 15 V to $V_{CC+} + 36$ V in <i>Absolute Maximum Ratings</i> table.....                             | 12   |
| • Added input clamp current parameter to <i>Absolute Maximum Ratings</i> table .....                                                    | 12   |
| • Changed common-mode voltage maximum value from $V_{CC+} - 4$ V to $V_{CC+}$ in the <i>Recommended Operating Conditions</i> table..... | 13   |
| • Changed devices in <i>Recommended Operating Conditions</i> table from TL07xA and TL07xB to TL07xAC and TL07xBC .....                  | 13   |

|                                                                                                                             |    |
|-----------------------------------------------------------------------------------------------------------------------------|----|
| • Added TL07xl operating free-air temperature minimum value of –40°C to <i>Recommended Operating Conditions</i> table ..... | 13 |
| • Added U (CFP) package thermal values to <i>Thermal Information: TL072x (cont.)</i> table.....                             | 15 |
| • Added W (CFP) package thermal values to <i>Thermal Information: TL074x (cont.)</i> table.....                             | 16 |
| • Added <a href="#">Figure 6-59</a> to <i>Typical Characteristics</i> section.....                                          | 33 |
| • Added second <i>Typical Application</i> section application curves .....                                                  | 41 |
| • Reformatted document references in <i>Layout Guidelines</i> section .....                                                 | 43 |

---

|                                                                              |             |
|------------------------------------------------------------------------------|-------------|
| <b>Changes from Revision L (February 2014) to Revision M (February 2014)</b> | <b>Page</b> |
|------------------------------------------------------------------------------|-------------|

|                                                                                                                                                                                                                                                                                                                |   |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|
| • Added <i>Device Information</i> table, <i>Pin Configuration and Functions</i> section, <i>ESD Ratings</i> table, <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section..... | 1 |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|

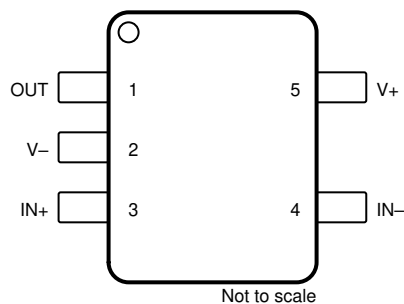
---

|                                                                             |             |
|-----------------------------------------------------------------------------|-------------|
| <b>Changes from Revision K (January 2014) to Revision L (February 2014)</b> | <b>Page</b> |
|-----------------------------------------------------------------------------|-------------|

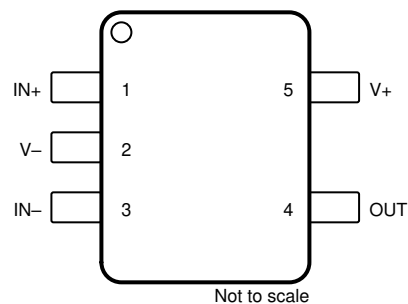
|                                                          |    |
|----------------------------------------------------------|----|
| • Moved $T_{stg}$ to <i>Handling Ratings</i> table ..... | 13 |
|----------------------------------------------------------|----|

---

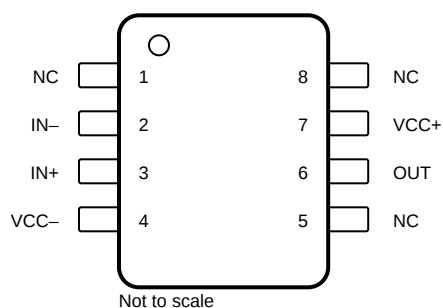
## 5 Pin Configuration and Functions



**Figure 5-1. TL071H DBV Package  
5-Pin SOT-23  
(Top View)**



**Figure 5-2. TL071H DCK Package  
5-Pin SC70  
(Top View)**

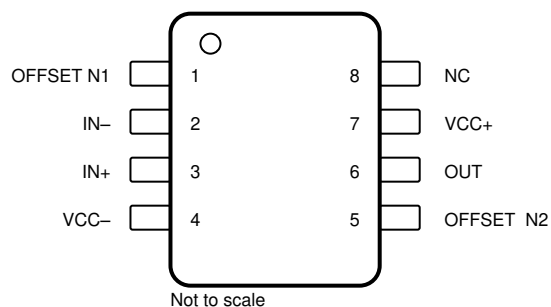


NC- no internal connection

**Figure 5-3. TL071H D Package  
8-Pin SOIC  
(Top View)**

**Table 5-1. Pin Functions: TL071H**

| NAME | PIN |     |   | I/O | DESCRIPTION        |
|------|-----|-----|---|-----|--------------------|
|      | DBV | DCK | D |     |                    |
| IN–  | 4   | 3   | 2 | I   | Inverting input    |
| IN+  | 3   | 1   | 3 | I   | Noninverting input |
| NC   | —   | —   | 8 | —   | Do not connect     |
| NC   | —   | —   | 1 | —   | Do not connect     |
| NC   | —   | —   | 5 | —   | Do not connect     |
| OUT  | 1   | 4   | 6 | O   | Output             |
| VCC– | 2   | 2   | 4 | —   | Power supply       |
| VCC+ | 5   | 5   | 7 | —   | Power supply       |

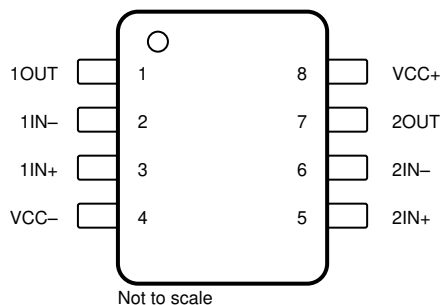


NC- no internal connection

**Figure 5-4. TL071x D, P, and PS Package  
 8-Pin SOIC, PDIP, and SO  
 (Top View)**

**Table 5-2. Pin Functions: TL071x**

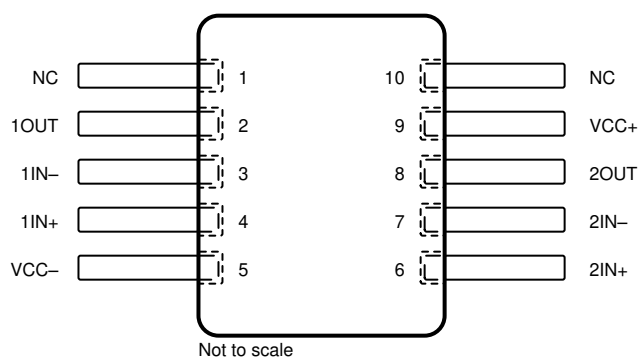
| PIN       |     | I/O | DESCRIPTION             |
|-----------|-----|-----|-------------------------|
| NAME      | NO. |     |                         |
| IN-       | 2   | I   | Inverting input         |
| IN+       | 3   | I   | Noninverting input      |
| NC        | 8   | —   | Do not connect          |
| OFFSET N1 | 1   | —   | Input offset adjustment |
| OFFSET N2 | 5   | —   | Input offset adjustment |
| OUT       | 6   | O   | Output                  |
| VCC-      | 4   | —   | Power supply            |
| VCC+      | 7   | —   | Power supply            |



**Figure 5-5. TL072x D, DDF, JG, P, PS, and PW Package  
8-Pin SOIC, SOT-23 (8), CDIP, PDIP, SO, and TSSOP  
(Top View)**

**Table 5-3. Pin Functions: TL072x**

| PIN  |     | I/O | DESCRIPTION        |
|------|-----|-----|--------------------|
| NAME | NO. |     |                    |
| 1IN- | 2   | I   | Inverting input    |
| 1IN+ | 3   | I   | Noninverting input |
| 1OUT | 1   | O   | Output             |
| 2IN- | 6   | I   | Inverting input    |
| 2IN+ | 5   | I   | Noninverting input |
| 2OUT | 7   | O   | Output             |
| VCC- | 4   | —   | Power supply       |
| VCC+ | 8   | —   | Power supply       |



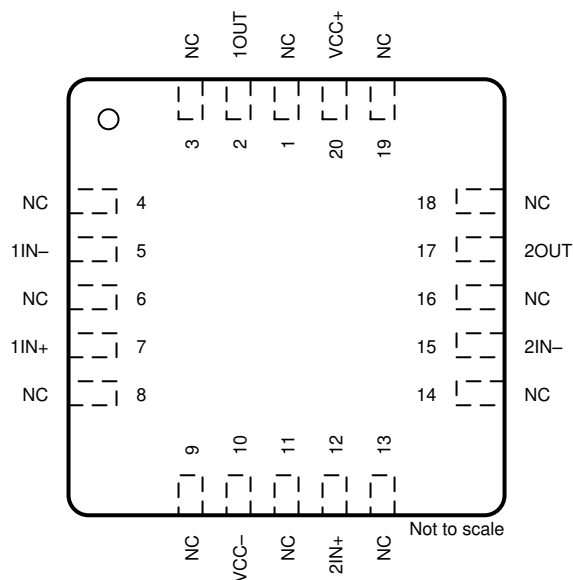
NC- no internal connection

**Figure 5-6. TL072x U Package  
10-Pin CFP  
(Top View)**

**Table 5-4. Pin Functions: TL072x**

| PIN  |       | I/O | DESCRIPTION        |
|------|-------|-----|--------------------|
| NAME | NO.   |     |                    |
| 1IN- | 3     | I   | Inverting input    |
| 1IN+ | 4     | I   | Noninverting input |
| 1OUT | 2     | O   | Output             |
| 2IN- | 7     | I   | Inverting input    |
| 2IN+ | 6     | I   | Noninverting input |
| 2OUT | 8     | O   | Output             |
| NC   | 1, 10 | —   | Do not connect     |
| VCC- | 5     | —   | Power supply       |
| VCC+ | 9     | —   | Power supply       |



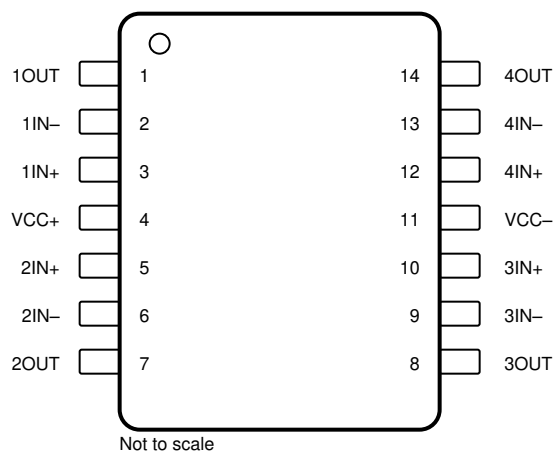


NC- no internal connection

**Figure 5-7. TL072 FK Package  
20-Pin LCCC  
(Top View)**

**Table 5-5. Pin Functions: TL072x**

| PIN  |                                                | I/O | DESCRIPTION        |
|------|------------------------------------------------|-----|--------------------|
| NAME | NO.                                            |     |                    |
| 1IN– | 5                                              | I   | Inverting input    |
| 1IN+ | 7                                              | I   | Noninverting input |
| 1OUT | 2                                              | O   | Output             |
| 2IN– | 15                                             | I   | Inverting input    |
| 2IN+ | 12                                             | I   | Noninverting input |
| 2OUT | 17                                             | O   | Output             |
| NC   | 1, 3, 4, 6, 8,<br>9, 11, 13, 14,<br>16, 18, 19 | —   | Do not connect     |
| VCC– | 10                                             | —   | Power supply       |
| VCC+ | 20                                             | —   | Power supply       |



**Figure 5-8. TL074x D, N, NS, PW, J, DYY, and W Package  
 14-Pin SOIC, PDIP, SO, TSSOP, CDIP, SOT-23 (14), and CFP  
 (Top View)**

**Table 5-6. Pin Functions: TL074x**

| PIN               |     | I/O | DESCRIPTION        |
|-------------------|-----|-----|--------------------|
| NAME              | NO. |     |                    |
| 1IN–              | 2   | I   | Inverting input    |
| 1IN+              | 3   | I   | Noninverting input |
| 1OUT              | 1   | O   | Output             |
| 2IN–              | 6   | I   | Inverting input    |
| 2IN+              | 5   | I   | Noninverting input |
| 2OUT              | 7   | O   | Output             |
| 3IN–              | 9   | I   | Inverting input    |
| 3IN+              | 10  | I   | Noninverting input |
| 3OUT              | 8   | O   | Output             |
| 4IN–              | 13  | I   | Inverting input    |
| 4IN+              | 12  | I   | Noninverting input |
| 4OUT              | 14  | O   | Output             |
| V <sub>CC</sub> – | 11  | —   | Power supply       |
| V <sub>CC</sub> + | 4   | —   | Power supply       |



### Table 5-7. Pin Functions: TL074x

Product Folder Links: [TL071](#) [TL071A](#) [TL071B](#) [TL071H](#) [TL072](#) [TL072A](#) [TL072B](#) [TL072H](#) [TL072M](#) [TL074](#) [TL074A](#)  
[TL074B](#) [TL074H](#) [TL074M](#)

## 6 Specifications

### 6.1 Absolute Maximum Ratings: TL07xH

over operating ambient temperature range (unless otherwise noted) <sup>(1)</sup>

|                                               |                                     | MIN               | MAX               | UNIT |
|-----------------------------------------------|-------------------------------------|-------------------|-------------------|------|
| Supply voltage, $V_S = (V_{CC+}) - (V_{CC-})$ |                                     | 0                 | 42                | V    |
| Signal input pins                             | Common-mode voltage <sup>(3)</sup>  | $(V_{CC-}) - 0.5$ | $(V_{CC+}) + 0.5$ | V    |
|                                               | Differential voltage <sup>(3)</sup> |                   | $V_S + 0.2$       | V    |
|                                               | Current <sup>(3)</sup>              | -10               | 10                | mA   |
| Output short-circuit <sup>(2)</sup>           |                                     | Continuous        |                   |      |
| Operating ambient temperature, $T_A$          |                                     | -55               | 150               | °C   |
| Junction temperature, $T_J$                   |                                     |                   | 150               | °C   |
| Storage temperature, $T_{stg}$                |                                     | -65               | 150               | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Short-circuit to ground, one amplifier per package.
- (3) Input pins are diode-clamped to the power-supply rails. Input signals that may swing more than 0.5 V beyond the supply rails must be current limited to 10 mA or less.

### 6.2 Absolute Maximum Ratings: All Devices Except TL07xH

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

|                     |                                                              | MIN             | MAX            | UNIT |
|---------------------|--------------------------------------------------------------|-----------------|----------------|------|
| $V_{CC+} - V_{CC-}$ | Supply voltage                                               | -0.3            | 36             | V    |
| $V_I$               | Input voltage <sup>(3)</sup>                                 | $V_{CC-} - 0.3$ | $V_{CC-} + 36$ | V    |
| $I_{IK}$            | Input clamp current                                          |                 | -50            | mA   |
|                     | Duration of output short circuit <sup>(2)</sup>              | Unlimited       |                |      |
| $T_J$               | Operating virtual junction temperature                       |                 | 150            | °C   |
|                     | Case temperature for 60 seconds - FK package                 |                 | 260            | °C   |
|                     | Lead temperature 1.8 mm (1/16 inch) from case for 10 seconds |                 | 300            | °C   |
| $T_{stg}$           | Storage temperature                                          | -65             | 150            | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The output may be shorted to ground or to either supply. Temperature and supply voltages must be limited to ensure that the dissipation rating is not exceeded.
- (3) Differential voltage only limited by input voltage.

### 6.3 ESD Ratings: TL07xH

|                    |                         |                                                                                | VALUE | UNIT |
|--------------------|-------------------------|--------------------------------------------------------------------------------|-------|------|
| TL074H             |                         |                                                                                |       |      |
| V <sub>(ESD)</sub> | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±1500 | V    |
|                    |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1000 |      |
| TL072H and TL071H  |                         |                                                                                |       |      |
| V <sub>(ESD)</sub> | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 | V    |
|                    |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1000 |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

## 6.4 ESD Ratings: All Devices Except TL07xH

|                                            |                                                                                | VALUE | UNIT |
|--------------------------------------------|--------------------------------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 | V    |
|                                            | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1000 |      |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

## 6.5 Recommended Operating Conditions: TL07xH

over operating ambient temperature range (unless otherwise noted)

|                |                                                           | MIN                     | MAX                       | UNIT |
|----------------|-----------------------------------------------------------|-------------------------|---------------------------|------|
| V <sub>S</sub> | Supply voltage, (V <sub>CC+</sub> ) – (V <sub>CC–</sub> ) | 4.5                     | 40                        | V    |
| V <sub>I</sub> | Input voltage range                                       | (V <sub>CC–</sub> ) + 2 | (V <sub>CC+</sub> ) + 0.1 | V    |
| T <sub>A</sub> | Specified temperature                                     | –40                     | 125                       | °C   |

## 6.6 Recommended Operating Conditions: All Devices Except TL07xH

over operating free-air temperature range (unless otherwise noted)

|                  |                                | MIN                      | MAX              | UNIT |    |
|------------------|--------------------------------|--------------------------|------------------|------|----|
| V <sub>CC+</sub> | Supply voltage <sup>(1)</sup>  | 5                        | 15               | V    |    |
| V <sub>CC−</sub> | Supply voltage <sup>(1)</sup>  | −5                       | −15              | V    |    |
| V <sub>CM</sub>  | Common-mode voltage            | V <sub>CC−</sub> + 4     | V <sub>CC+</sub> | V    |    |
| T <sub>A</sub>   | Operating free-air temperature | TL07xM                   | −55              | 125  | °C |
|                  |                                | TL08xQ                   | −40              | 125  |    |
|                  |                                | TL07xI                   | −40              | 85   |    |
|                  |                                | TL07xAC, TL07xBC, TL07xC | 0                | 70   |    |

(1) V<sub>CC+</sub> and V<sub>CC–</sub> are not required to be of equal magnitude, provided that the total V<sub>CC</sub> (V<sub>CC+</sub> – V<sub>CC–</sub>) is between 10 V and 30 V.

## 6.7 Thermal Information for Single Channel: TL071H

| THERMAL METRIC <sup>(1)</sup> |                                              | TL071H      |               |                 | UNIT |
|-------------------------------|----------------------------------------------|-------------|---------------|-----------------|------|
|                               |                                              | D<br>(SOIC) | DCK<br>(SC70) | DBV<br>(SOT-23) |      |
|                               |                                              | 8 PINS      | 5 PINS        | 5 PINS          |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 158.8       | 217.5         | 212.2           | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 98.6        | 113.1         | 111.1           | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 102.3       | 63.8          | 79.4            | °C/W |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 45.8        | 34.8          | 51.8            | °C/W |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 101.5       | 63.5          | 79.0            | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | N/A         | N/A           | N/A             | °C/W |

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

## 6.8 Thermal Information: TL071x

| THERMAL METRIC <sup>(1)</sup> |                                           | TL071x   |          |         | UNIT |
|-------------------------------|-------------------------------------------|----------|----------|---------|------|
|                               |                                           | D (SOIC) | P (PDIP) | PS (SO) |      |
|                               |                                           | 8 PINS   | 8 PINS   | 8 PINS  |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance    | 97       | 85       | 95      | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance | —        | —        | —       | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.9 Thermal Information for Dual Channel: TL072H

| THERMAL METRIC <sup>(1)</sup> |                                              | TL072H   |              |            | UNIT |
|-------------------------------|----------------------------------------------|----------|--------------|------------|------|
|                               |                                              | D (SOIC) | DDF (SOT-23) | PW (TSSOP) |      |
|                               |                                              | 8 PINS   | 8 PINS       | 8 PINS     |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 147.8    | 181.5        | 200.3      | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 88.2     | 112.5        | 89.4       | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 91.4     | 98.2         | 131.0      | °C/W |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 36.8     | 17.2         | 22.2       | °C/W |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 90.6     | 97.6         | 129.3      | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | N/A      | N/A          | N/A        | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report, [SPRA953](#).

## 6.10 Thermal Information: TL072x

| THERMAL METRIC <sup>(1)</sup> |                                           | TL072x   |           |          |         | UNIT |
|-------------------------------|-------------------------------------------|----------|-----------|----------|---------|------|
|                               |                                           | D (SOIC) | JG (CDIP) | P (PDIP) | PS (SO) |      |
|                               |                                           | 8 PINS   | 8 PINS    | 8 PINS   | 8 PINS  |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance    | 97       | —         | 85       | 95      | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance | —        | 15.05     | —        | —       | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.11 Thermal Information: TL072x (cont.)

| THERMAL METRIC <sup>(1)</sup> |                                              | TL072x     |         |           | UNIT |
|-------------------------------|----------------------------------------------|------------|---------|-----------|------|
|                               |                                              | PW (TSSOP) | U (CFP) | FK (LCCC) |      |
|                               |                                              | 8 PINS     | 10 PINS | 20 PINS   |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 150        | 169.8   | —         | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | —          | 62.1    | 5.61      | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | —          | 176.2   | —         | °C/W |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | —          | 48.4    | —         | °C/W |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | —          | 144.1   | —         | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | —          | 5.4     | —         | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.12 Thermal Information for Quad Channel: TL074H

| THERMAL METRIC <sup>(1)</sup> |                                              | TL074H   |                             |            | UNIT |
|-------------------------------|----------------------------------------------|----------|-----------------------------|------------|------|
|                               |                                              | D (SOIC) | DYY <sup>(2)</sup> (SOT-23) | PW (TSSOP) |      |
|                               |                                              | 14 PINS  | 14 PINS                     | 14 PINS    |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 114.2    | TBD                         | 134.4      | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 70.3     | TBD                         | 62.6       | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 70.2     | TBD                         | 77.6       | °C/W |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 28.8     | TBD                         | 13.0       | °C/W |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 69.8     | TBD                         | 77.0       | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | N/A      | TBD                         | N/A        | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report, [SPRA953](#).  
(2) This package option is preview for TL074H.

## 6.13 Thermal Information: TL074x

| THERMAL METRIC <sup>(1)</sup> |                                           | TL074x   |          |         | UNIT |
|-------------------------------|-------------------------------------------|----------|----------|---------|------|
|                               |                                           | D (SOIC) | N (PDIP) | NS (SO) |      |
|                               |                                           | 14 PINS  | 14 PINS  | 14 PINS |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance    | 86       | 80       | 76      | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance | —        | —        | —       | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.14 Thermal Information: TL074x (cont).

| THERMAL METRIC <sup>(1)</sup> |                                              | TL074x   |            |         | UNIT |
|-------------------------------|----------------------------------------------|----------|------------|---------|------|
|                               |                                              | J (CDIP) | PW (TSSOP) | W (CFP) |      |
|                               |                                              | 14 PINS  | 14 PINS    | 14 PINS |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | —        | 113        | 128.8   | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 14.5     | —          | 56.1    | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | —        | —          | 127.6   | °C/W |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | —        | —          | 29      | °C/W |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | —        | —          | 106.1   | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | —        | —          | 0.5     | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.15 Thermal Information: TL074x (cont).

| THERMAL METRIC <sup>(1)</sup> |                                           | TL074x    | UNIT |
|-------------------------------|-------------------------------------------|-----------|------|
|                               |                                           | FK (LCCC) |      |
|                               |                                           | 20 PINS   |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance    | —         | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance | 5.61      | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.16 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                           | TL071/TL072/TL074 |         |           |          |         |          |         |         |         |            | UNIT |         |
|-------------------------------|-------------------------------------------|-------------------|---------|-----------|----------|---------|----------|---------|---------|---------|------------|------|---------|
|                               |                                           | D (SOIC)          |         | FK (LCCC) | J (CDIP) |         | N (PDIP) |         | NS (SO) |         | PW (TSSOP) |      |         |
|                               |                                           | 8 PINS            | 14 PINS | 20 PINS   | 8 PINS   | 14 PINS | 8 PINS   | 14 PINS | 8 PINS  | 14 PINS | 8 PINS     |      | 14 PINS |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance    | 97                | 86      | —         | —        | —       | 85       | 80      | 95      | 76      | 150        | 113  | °C/W    |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance | —                 | —       | 5.61      | 15.05    | 14.5    | —        | —       | —       | —       | —          | —    | °C/W    |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.



## 6.17 Electrical Characteristics: TL07xH

For  $V_S = (V_{CC+}) - (V_{CC-}) = 4.5 \text{ V to } 40 \text{ V}$  ( $\pm 2.25 \text{ V to } \pm 20 \text{ V}$ ) at  $T_A = 25^\circ\text{C}$ ,  $R_L = 10 \text{ k}\Omega$  connected to  $V_S / 2$ ,  $V_{CM} = V_S / 2$ , and  $V_{OUT} = V_S / 2$ , unless otherwise noted.

| PARAMETER            |                                          | TEST CONDITIONS                                                                                                                                                |                                                | MIN                       | TYP                 | MAX               | UNIT |
|----------------------|------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------|---------------------------|---------------------|-------------------|------|
| OFFSET VOLTAGE       |                                          |                                                                                                                                                                |                                                |                           |                     |                   |      |
| V <sub>OS</sub>      | Input offset voltage                     |                                                                                                                                                                |                                                | ±1                        | ±4                  | mV                |      |
|                      |                                          |                                                                                                                                                                | T <sub>A</sub> = −40°C to 125°C                |                           | ±5                  |                   |      |
| dV <sub>OS</sub> /dT | Input offset voltage drift               |                                                                                                                                                                | T <sub>A</sub> = −40°C to 125°C                | ±2                        |                     | µV/°C             |      |
| PSRR                 | Input offset voltage versus power supply | V <sub>S</sub> = 5 V to 40 V, V <sub>CM</sub> = V <sub>S</sub> / 2                                                                                             | T <sub>A</sub> = −40°C to 125°C                | ±1                        | ±10                 | µV/V              |      |
|                      | Channel separation                       | f = 0 Hz                                                                                                                                                       |                                                | 10                        |                     | µV/V              |      |
| INPUT BIAS CURRENT   |                                          |                                                                                                                                                                |                                                |                           |                     |                   |      |
| I <sub>B</sub>       | Input bias current                       |                                                                                                                                                                |                                                | ±1                        | ±120                | pA                |      |
|                      |                                          |                                                                                                                                                                | DCK and DBV packages                           | ±1                        | ±300                | pA                |      |
|                      |                                          |                                                                                                                                                                | T <sub>A</sub> = −40°C to 125°C <sup>(1)</sup> |                           | ±5                  | nA                |      |
| I <sub>OS</sub>      | Input offset current                     |                                                                                                                                                                |                                                | ±0.5                      | ±120                | pA                |      |
|                      |                                          |                                                                                                                                                                | DCK and DBV packages                           | ±0.5                      | ±250                | pA                |      |
|                      |                                          |                                                                                                                                                                | T <sub>A</sub> = −40°C to 125°C <sup>(1)</sup> |                           | ±5                  | nA                |      |
| NOISE                |                                          |                                                                                                                                                                |                                                |                           |                     |                   |      |
| E <sub>N</sub>       | Input voltage noise                      | f = 0.1 Hz to 10 Hz                                                                                                                                            |                                                | 9.2                       |                     | µV <sub>PP</sub>  |      |
|                      |                                          |                                                                                                                                                                |                                                | 1.4                       |                     | µV <sub>RMS</sub> |      |
| e <sub>N</sub>       | Input voltage noise density              | f = 1 kHz                                                                                                                                                      |                                                | 37                        |                     | nV/√Hz            |      |
|                      |                                          | f = 10 kHz                                                                                                                                                     |                                                | 21                        |                     |                   |      |
| i <sub>N</sub>       | Input current noise                      | f = 1 kHz                                                                                                                                                      |                                                | 80                        |                     | fA/√Hz            |      |
| INPUT VOLTAGE RANGE  |                                          |                                                                                                                                                                |                                                |                           |                     |                   |      |
| V <sub>CM</sub>      | Common-mode voltage range                |                                                                                                                                                                |                                                | (V <sub>CC−</sub> ) + 1.5 | (V <sub>CC+</sub> ) | V                 |      |
| CMRR                 | Common-mode rejection ratio              | V <sub>S</sub> = 40 V, (V <sub>CC−</sub> ) + 2.5 V < V <sub>CM</sub> < (V <sub>CC+</sub> ) − 1.5 V                                                             |                                                | 100                       | 105                 | dB                |      |
| CMRR                 | Common-mode rejection ratio              |                                                                                                                                                                | T <sub>A</sub> = −40°C to 125°C                | 95                        |                     | dB                |      |
| CMRR                 | Common-mode rejection ratio              | V <sub>S</sub> = 40 V, (V <sub>CC−</sub> ) + 2.5 V < V <sub>CM</sub> < (V <sub>CC+</sub> )                                                                     |                                                | 90                        | 105                 | dB                |      |
| CMRR                 | Common-mode rejection ratio              |                                                                                                                                                                | T <sub>A</sub> = −40°C to 125°C                | 80                        |                     | dB                |      |
| INPUT CAPACITANCE    |                                          |                                                                                                                                                                |                                                |                           |                     |                   |      |
| Z <sub>ID</sub>      | Differential                             |                                                                                                                                                                |                                                | 100    2                  |                     | MΩ    pF          |      |
| Z <sub>ICM</sub>     | Common-mode                              |                                                                                                                                                                |                                                | 6    1                    |                     | TΩ    pF          |      |
| OPEN-LOOP GAIN       |                                          |                                                                                                                                                                |                                                |                           |                     |                   |      |
| A <sub>OL</sub>      | Open-loop voltage gain                   | V <sub>S</sub> = 40 V, V <sub>CM</sub> = V <sub>S</sub> / 2, (V <sub>CC−</sub> ) + 0.3 V < V <sub>O</sub> < (V <sub>CC+</sub> ) − 0.3 V                        | T <sub>A</sub> = −40°C to 125°C                | 118                       | 125                 | dB                |      |
| A <sub>OL</sub>      | Open-loop voltage gain                   | V <sub>S</sub> = 40 V, V <sub>CM</sub> = V <sub>S</sub> / 2, R <sub>L</sub> = 2 kΩ, (V <sub>CC−</sub> ) + 1.2 V < V <sub>O</sub> < (V <sub>CC+</sub> ) − 1.2 V | T <sub>A</sub> = −40°C to 125°C                | 115                       | 120                 | dB                |      |
| FREQUENCY RESPONSE   |                                          |                                                                                                                                                                |                                                |                           |                     |                   |      |
| GBW                  | Gain-bandwidth product                   |                                                                                                                                                                |                                                | 5.25                      |                     | MHz               |      |
| SR                   | Slew rate                                | V <sub>S</sub> = 40 V, G = +1, C <sub>L</sub> = 20 pF                                                                                                          |                                                | 20                        |                     | V/µs              |      |
| t <sub>S</sub>       | Settling time                            | To 0.1%, V <sub>S</sub> = 40 V, V <sub>STEP</sub> = 10 V , G = +1, CL = 20 pF                                                                                  |                                                | 0.63                      |                     | µs                |      |
|                      |                                          | To 0.1%, V <sub>S</sub> = 40 V, V <sub>STEP</sub> = 2 V , G = +1, CL = 20 pF                                                                                   |                                                | 0.56                      |                     |                   |      |
|                      |                                          | To 0.01%, V <sub>S</sub> = 40 V, V <sub>STEP</sub> = 10 V , G = +1, CL = 20 pF                                                                                 |                                                | 0.91                      |                     |                   |      |
|                      |                                          | To 0.01%, V <sub>S</sub> = 40 V, V <sub>STEP</sub> = 2 V , G = +1, CL = 20 pF                                                                                  |                                                | 0.48                      |                     |                   |      |
|                      | Phase margin                             | G = +1, R <sub>L</sub> = 10kΩ, C <sub>L</sub> = 20 pF                                                                                                          |                                                | 56                        |                     | °                 |      |
|                      | Overload recovery time                   | V <sub>IN</sub> × gain > V <sub>S</sub>                                                                                                                        |                                                | 300                       |                     | ns                |      |

## 6.17 Electrical Characteristics: TL07xH (continued)

For  $V_S = (V_{CC+}) - (V_{CC-}) = 4.5\text{ V to }40\text{ V}$  ( $\pm 2.25\text{ V to } \pm 20\text{ V}$ ) at  $T_A = 25^\circ\text{C}$ ,  $R_L = 10\text{ k}\Omega$  connected to  $V_S / 2$ ,  $V_{CM} = V_S / 2$ , and  $V_{OUT} = V_S / 2$ , unless otherwise noted.

| PARAMETER         |                                   | TEST CONDITIONS                                                                      |                                               | MIN     | TYP  | MAX | UNIT |
|-------------------|-----------------------------------|--------------------------------------------------------------------------------------|-----------------------------------------------|---------|------|-----|------|
| THD+N             | Total harmonic distortion + noise | V <sub>S</sub> = 40 V, V <sub>O</sub> = 6 V <sub>RMS</sub> , G = +1, f = 1 kHz       |                                               | 0.00012 |      |     | %    |
| EMIRR             | EMI rejection ratio               | f = 1 GHz                                                                            |                                               | 53      |      |     | dB   |
| OUTPUT            |                                   |                                                                                      |                                               |         |      |     |      |
|                   | Voltage output swing from rail    | Positive rail headroom                                                               | V <sub>S</sub> = 40 V, R <sub>L</sub> = 10 kΩ | 115     | 210  | mV  |      |
|                   |                                   |                                                                                      | V <sub>S</sub> = 40 V, R <sub>L</sub> = 2 kΩ  | 520     | 965  |     |      |
|                   |                                   | Negative rail headroom                                                               | V <sub>S</sub> = 40 V, R <sub>L</sub> = 10 kΩ | 105     | 215  |     |      |
|                   |                                   |                                                                                      | V <sub>S</sub> = 40 V, R <sub>L</sub> = 2 kΩ  | 500     | 1030 |     |      |
| I <sub>SC</sub>   | Short-circuit current             |                                                                                      |                                               | ±26     |      |     | mA   |
| C <sub>LOAD</sub> | Capacitive load drive             |                                                                                      |                                               | 300     |      |     | pF   |
| Z <sub>O</sub>    | Open-loop output impedance        | f = 1 MHz, I <sub>O</sub> = 0 A                                                      |                                               | 125     |      |     | Ω    |
| POWER SUPPLY      |                                   |                                                                                      |                                               |         |      |     |      |
| I <sub>Q</sub>    | Quiescent current per amplifier   | I <sub>O</sub> = 0 A                                                                 |                                               | 937.5   | 1125 | μA  |      |
|                   |                                   | I <sub>O</sub> = 0 A, (TL071H)                                                       |                                               | 960     | 1156 |     |      |
|                   |                                   | I <sub>O</sub> = 0 A                                                                 | T <sub>A</sub> = −40°C to 125°C               |         | 1130 |     |      |
|                   |                                   | I <sub>O</sub> = 0 A, (TL072H)                                                       |                                               |         | 1143 |     |      |
|                   |                                   | I <sub>O</sub> = 0 A, (TL071H)                                                       |                                               |         | 1160 |     |      |
|                   | Turn-On Time                      | At T <sub>A</sub> = 25°C, V <sub>S</sub> = 40 V, V <sub>S</sub> ramp rate > 0.3 V/μs |                                               | 60      |      |     | μs   |

(1) Max  $I_B$  and  $I_{OS}$  data is specified based on characterization results.

## 6.18 Electrical Characteristics: TL071C, TL072C, TL074C

$V_{CC\pm} = \pm 15\text{ V}$  (unless otherwise noted)

| PARAMETER                         |                                                                       | TEST CONDITIONS <sup>(1)</sup> <sup>(2)</sup>                                          |                             | MIN | TYP              | MAX       | UNIT  |
|-----------------------------------|-----------------------------------------------------------------------|----------------------------------------------------------------------------------------|-----------------------------|-----|------------------|-----------|-------|
| V <sub>IO</sub>                   | Input offset voltage                                                  | V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω                                            | T <sub>A</sub> = 25°C       |     | 3                | 10        | mV    |
|                                   |                                                                       |                                                                                        | T <sub>A</sub> = Full range |     |                  | 13        |       |
| α                                 | Temperature coefficient of input offset voltage                       | V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω                                            | T <sub>A</sub> = Full range |     | 18               |           | μV/°C |
| I <sub>IO</sub>                   | Input offset current                                                  | V <sub>O</sub> = 0                                                                     | T <sub>A</sub> = 25°C       |     | 5                | 100       | pA    |
|                                   |                                                                       |                                                                                        | T <sub>A</sub> = Full range |     |                  | 10        | nA    |
| I <sub>IB</sub>                   | Input bias current <sup>(3)</sup>                                     | V <sub>O</sub> = 0                                                                     | T <sub>A</sub> = 25°C       |     | 65               | 200       | pA    |
|                                   |                                                                       |                                                                                        | T <sub>A</sub> = Full range |     |                  | 7         | nA    |
| V <sub>ICR</sub>                  | Common-mode input voltage range                                       | T <sub>A</sub> = 25°C                                                                  |                             |     | ±11              | –12 to 15 | V     |
| V <sub>OM</sub>                   | Maximum peak output voltage swing                                     | R <sub>L</sub> = 10 kΩ                                                                 | T <sub>A</sub> = 25°C       |     | ±12              | ±13.5     | V     |
|                                   |                                                                       | R <sub>L</sub> ≥ 10 kΩ                                                                 | T <sub>A</sub> = Full range |     | ±12              |           |       |
|                                   |                                                                       | R <sub>L</sub> ≥ 2 kΩ                                                                  |                             |     | ±10              |           |       |
| A <sub>VD</sub>                   | Large-signal differential voltage amplification                       | V <sub>O</sub> = ±10 V<br>R <sub>L</sub> ≥ 2 kΩ                                        | T <sub>A</sub> = 25°C       |     | 25               | 200       | V/mV  |
|                                   |                                                                       |                                                                                        | T <sub>A</sub> = Full range |     | 15               |           |       |
| B <sub>1</sub>                    | Utility-gain bandwidth                                                | T <sub>A</sub> = 25°C                                                                  |                             |     | 3                |           | MHz   |
| r <sub>I</sub>                    | Input resistance                                                      | T <sub>A</sub> = 25°C                                                                  |                             |     | 10 <sup>12</sup> |           | Ω     |
| CMRR                              | Common-mode rejection ratio                                           | V <sub>IC</sub> = V <sub>ICR(min)</sub><br>V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω | T <sub>A</sub> = 25°C       |     | 70               | 100       | dB    |
| k <sub>SVR</sub>                  | Supply voltage rejection ratio (ΔV <sub>CC±</sub> /ΔV <sub>IO</sub> ) | V <sub>CC</sub> = ±9 V to ±15 V<br>V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω         | T <sub>A</sub> = 25°C       |     | 70               | 100       | dB    |
| I <sub>CC</sub>                   | Supply current (each amplifier)                                       | V <sub>O</sub> = 0; no load                                                            | T <sub>A</sub> = 25°C       |     | 1.4              | 2.5       | mA    |
| V <sub>O1</sub> / V <sub>O2</sub> | Crosstalk attenuation                                                 | A <sub>VD</sub> = 100                                                                  | T <sub>A</sub> = 25°C       |     | 120              |           | dB    |

- (1) All characteristics are measured under open-loop conditions with zero common-mode voltage, unless otherwise specified.  
 (2) Full range is  $T_A = 0^\circ\text{C}$  to  $70^\circ\text{C}$ .  
 (3) Input bias currents of an FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive, as shown in Figure 6-40. Pulse techniques must be used that maintain the junction temperature as close to the ambient temperature as possible.

## 6.19 Electrical Characteristics: TL071AC, TL072AC, TL074AC

$V_{CC\pm} = \pm 15\text{ V}$  (unless otherwise noted)

| PARAMETER                         |                                                                        | TEST CONDITIONS <sup>(1)</sup> <sup>(2)</sup>                                          |                             | MIN | TYP              | MAX       | UNIT  |
|-----------------------------------|------------------------------------------------------------------------|----------------------------------------------------------------------------------------|-----------------------------|-----|------------------|-----------|-------|
| V <sub>IO</sub>                   | Input offset voltage                                                   | V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω                                            | T <sub>A</sub> = 25°C       |     | 3                | 6         | mV    |
|                                   |                                                                        |                                                                                        | T <sub>A</sub> = Full range |     |                  | 7.5       |       |
| α                                 | Temperature coefficient of input offset voltage                        | V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω                                            | T <sub>A</sub> = Full range |     | 18               |           | μV/°C |
| I <sub>IO</sub>                   | Input offset current                                                   | V <sub>O</sub> = 0                                                                     | T <sub>A</sub> = 25°C       |     | 5                | 100       | pA    |
|                                   |                                                                        |                                                                                        | T <sub>A</sub> = Full range |     |                  | 2         | nA    |
| I <sub>IB</sub>                   | Input bias current <sup>(3)</sup>                                      | V <sub>O</sub> = 0                                                                     | T <sub>A</sub> = 25°C       |     | 65               | 200       | pA    |
|                                   |                                                                        |                                                                                        | T <sub>A</sub> = Full range |     |                  | 7         | nA    |
| V <sub>ICR</sub>                  | Common-mode input voltage range                                        | T <sub>A</sub> = 25°C                                                                  |                             |     | ±11              | –12 to 15 | V     |
| V <sub>OM</sub>                   | Maximum peak output voltage swing                                      | R <sub>L</sub> = 10 kΩ                                                                 | T <sub>A</sub> = 25°C       |     | ±12              | ±13.5     | V     |
|                                   |                                                                        | R <sub>L</sub> ≥ 10 kΩ                                                                 | T <sub>A</sub> = Full range |     | ±12              |           |       |
|                                   |                                                                        | R <sub>L</sub> ≥ 2 kΩ                                                                  |                             |     | ±10              |           |       |
| A <sub>VD</sub>                   | Large-signal differential voltage amplification                        | V <sub>O</sub> = ±10 V<br>R <sub>L</sub> ≥ 2 kΩ                                        | T <sub>A</sub> = 25°C       |     | 50               | 200       | V/mV  |
|                                   |                                                                        |                                                                                        | T <sub>A</sub> = Full range |     | 25               |           |       |
| B <sub>1</sub>                    | Utility-gain bandwidth                                                 | T <sub>A</sub> = 25°C                                                                  |                             |     | 3                |           | MHz   |
| r <sub>I</sub>                    | Input resistance                                                       | T <sub>A</sub> = 25°C                                                                  |                             |     | 10 <sup>12</sup> |           | Ω     |
| CMRR                              | Common-mode rejection ratio                                            | V <sub>IC</sub> = V <sub>ICR(min)</sub><br>V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω | T <sub>A</sub> = 25°C       |     | 75               | 100       | dB    |
| k <sub>SVR</sub>                  | Supply-voltage rejection ratio (ΔV <sub>CC±</sub> / ΔV <sub>IO</sub> ) | V <sub>CC</sub> = ±9 V to ±15 V<br>V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω         | T <sub>A</sub> = 25°C       |     | 80               | 100       | dB    |
| I <sub>CC</sub>                   | Supply current (each amplifier)                                        | V <sub>O</sub> = 0; no load                                                            | T <sub>A</sub> = 25°C       |     | 1.4              | 2.5       | mA    |
| V <sub>O1</sub> / V <sub>O2</sub> | Crosstalk attenuation                                                  | A <sub>VD</sub> = 100                                                                  | T <sub>A</sub> = 25°C       |     | 120              |           | dB    |

- (1) All characteristics are measured under open-loop conditions with zero common-mode voltage, unless otherwise specified.  
 (2) Full range is  $T_A = 0^\circ\text{C}$  to  $70^\circ\text{C}$ .  
 (3) Input bias currents of an FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive, as shown in [Figure 6-40](#). Pulse techniques must be used that maintain the junction temperature as close to the ambient temperature as possible.

## 6.20 Electrical Characteristics: TL071BC, TL072BC, TL074BC

$V_{CC\pm} = \pm 15\text{ V}$  (unless otherwise noted)

| PARAMETER                         |                                                                       | TEST CONDITIONS <sup>(1)</sup> <sup>(2)</sup>                                          |                                                      | MIN | TYP              | MAX      | UNIT     |
|-----------------------------------|-----------------------------------------------------------------------|----------------------------------------------------------------------------------------|------------------------------------------------------|-----|------------------|----------|----------|
| V <sub>IO</sub>                   | Input offset voltage                                                  | V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω                                            | T <sub>A</sub> = 25°C<br>T <sub>A</sub> = Full range |     | 2                | 3<br>5   | mV       |
| α                                 | Temperature coefficient of input offset voltage                       | V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω                                            | T <sub>A</sub> = Full range                          |     | 18               |          | μV/°C    |
| I <sub>IO</sub>                   | Input offset current                                                  | V <sub>O</sub> = 0                                                                     | T <sub>A</sub> = 25°C<br>T <sub>A</sub> = Full range |     | 5                | 100<br>2 | pA<br>nA |
| I <sub>IB</sub>                   | Input bias current <sup>(3)</sup>                                     | V <sub>O</sub> = 0                                                                     | T <sub>A</sub> = 25°C<br>T <sub>A</sub> = Full range |     | 65               | 200<br>7 | pA<br>nA |
| V <sub>ICR</sub>                  | Common-mode input voltage range                                       | T <sub>A</sub> = 25°C                                                                  |                                                      | ±11 | –12 to 15        |          | V        |
| V <sub>OM</sub>                   | Maximum peak output voltage swing                                     | R <sub>L</sub> = 10 kΩ                                                                 | T <sub>A</sub> = 25°C                                | ±12 | ±13.5            |          | V        |
|                                   |                                                                       | R <sub>L</sub> ≥ 10 kΩ                                                                 | T <sub>A</sub> = Full range                          | ±12 |                  |          |          |
|                                   |                                                                       | R <sub>L</sub> ≥ 2 kΩ                                                                  |                                                      | ±10 |                  |          |          |
| A <sub>VD</sub>                   | Large-signal differential voltage amplification                       | V <sub>O</sub> = ±10 V<br>R <sub>L</sub> ≥ 2 kΩ                                        | T <sub>A</sub> = 25°C                                | 50  | 200              |          | V/mV     |
|                                   |                                                                       |                                                                                        | T <sub>A</sub> = Full range                          | 25  |                  |          |          |
| B <sub>1</sub>                    | Utility-gain bandwidth                                                | T <sub>A</sub> = 25°C                                                                  |                                                      |     | 3                |          | MHz      |
| r <sub>I</sub>                    | Input resistance                                                      | T <sub>A</sub> = 25°C                                                                  |                                                      |     | 10 <sup>12</sup> |          | Ω        |
| CMRR                              | Common-mode rejection ratio                                           | V <sub>IC</sub> = V <sub>ICR(min)</sub><br>V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω | T <sub>A</sub> = 25°C                                | 75  | 100              |          | dB       |
| k <sub>SVR</sub>                  | Supply-voltage rejection ratio (ΔV <sub>CC±</sub> /ΔV <sub>IO</sub> ) | V <sub>CC</sub> = ±9 V to ±15 V<br>V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω         | T <sub>A</sub> = 25°C                                | 80  | 100              |          | dB       |
| I <sub>CC</sub>                   | Supply current (each amplifier)                                       | V <sub>O</sub> = 0; no load                                                            | T <sub>A</sub> = 25°C                                |     | 1.4              | 2.5      | mA       |
| V <sub>O1</sub> / V <sub>O2</sub> | Crosstalk attenuation                                                 | A <sub>VD</sub> = 100                                                                  | T <sub>A</sub> = 25°C                                |     | 120              |          | dB       |

- (1) All characteristics are measured under open-loop conditions with zero common-mode voltage, unless otherwise specified.  
 (2) Full range is  $T_A = 0^\circ\text{C}$  to  $70^\circ\text{C}$ .  
 (3) Input bias currents of an FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive, as shown in [Figure 6-40](#). Pulse techniques must be used that maintain the junction temperature as close to the ambient temperature as possible.

## 6.21 Electrical Characteristics: TL071I, TL072I, TL074I

$V_{CC\pm} = \pm 15\text{ V}$  (unless otherwise noted)

| PARAMETER                         |                                                                       | TEST CONDITIONS <sup>(1)</sup> <sup>(2)</sup>                                          |                             | MIN | TYP              | MAX       | UNIT  |
|-----------------------------------|-----------------------------------------------------------------------|----------------------------------------------------------------------------------------|-----------------------------|-----|------------------|-----------|-------|
| V <sub>IO</sub>                   | Input offset voltage                                                  | V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω                                            | T <sub>A</sub> = 25°C       |     | 3                | 6         | mV    |
|                                   |                                                                       |                                                                                        | T <sub>A</sub> = Full range |     |                  | 8         |       |
| α                                 | Temperature coefficient of input offset voltage                       | V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω                                            | T <sub>A</sub> = Full range |     | 18               |           | μV/°C |
| I <sub>IO</sub>                   | Input offset current                                                  | V <sub>O</sub> = 0                                                                     | T <sub>A</sub> = 25°C       |     | 5                | 100       | pA    |
|                                   |                                                                       |                                                                                        | T <sub>A</sub> = Full range |     |                  | 2         | nA    |
| I <sub>IB</sub>                   | Input bias current <sup>(3)</sup>                                     | V <sub>O</sub> = 0                                                                     | T <sub>A</sub> = 25°C       |     | 65               | 200       | pA    |
|                                   |                                                                       |                                                                                        | T <sub>A</sub> = Full range |     |                  | 7         | nA    |
| V <sub>ICR</sub>                  | Common-mode input voltage range                                       | T <sub>A</sub> = 25°C                                                                  |                             |     | ±11              | –12 to 15 | V     |
| V <sub>OM</sub>                   | Maximum peak output voltage swing                                     | R <sub>L</sub> = 10 kΩ                                                                 | T <sub>A</sub> = 25°C       |     | ±12              | ±13.5     | V     |
|                                   |                                                                       | R <sub>L</sub> ≥ 10 kΩ                                                                 | T <sub>A</sub> = Full range |     | ±12              |           |       |
|                                   |                                                                       | R <sub>L</sub> ≥ 2 kΩ                                                                  |                             |     | ±10              |           |       |
| A <sub>VD</sub>                   | Large-signal differential voltage amplification                       | V <sub>O</sub> = ±10 V<br>R <sub>L</sub> ≥ 2 kΩ                                        | T <sub>A</sub> = 25°C       |     | 50               | 200       | V/mV  |
|                                   |                                                                       |                                                                                        | T <sub>A</sub> = Full range |     | 25               |           |       |
| B <sub>1</sub>                    | Utility-gain bandwidth                                                | T <sub>A</sub> = 25°C                                                                  |                             |     | 3                |           | MHz   |
| r <sub>I</sub>                    | Input resistance                                                      | T <sub>A</sub> = 25°C                                                                  |                             |     | 10 <sup>12</sup> |           | Ω     |
| CMRR                              | Common-mode rejection ratio                                           | V <sub>IC</sub> = V <sub>ICR(min)</sub><br>V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω | T <sub>A</sub> = 25°C       |     | 75               | 100       | dB    |
| k <sub>SVR</sub>                  | Supply-voltage rejection ratio (ΔV <sub>CC±</sub> /ΔV <sub>IO</sub> ) | V <sub>CC</sub> = ±9 V to ±15 V<br>V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω         | T <sub>A</sub> = 25°C       |     | 80               | 100       | dB    |
| I <sub>CC</sub>                   | Supply current (each amplifier)                                       | V <sub>O</sub> = 0; no load                                                            | T <sub>A</sub> = 25°C       |     | 1.4              | 2.5       | mA    |
| V <sub>O1</sub> / V <sub>O2</sub> | Crosstalk attenuation                                                 | A <sub>VD</sub> = 100                                                                  | T <sub>A</sub> = 25°C       |     | 120              |           | dB    |

(1) All characteristics are measured under open-loop conditions with zero common-mode voltage, unless otherwise specified.

(2)  $T_A = -40^\circ\text{C to } 85^\circ\text{C}$ .

(3) Input bias currents of an FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive, as shown in [Figure 6-40](#). Pulse techniques must be used that maintain the junction temperature as close to the ambient temperature as possible.

## 6.22 Electrical Characteristics: TL071M, TL072M

$V_{CC\pm} = \pm 15\text{ V}$  (unless otherwise noted)

| PARAMETER         |                                                                     | TEST CONDITIONS <sup>(1)</sup> <sup>(2)</sup>                                    |                           | MIN                | TYP        | MAX | UNIT                         |
|-------------------|---------------------------------------------------------------------|----------------------------------------------------------------------------------|---------------------------|--------------------|------------|-----|------------------------------|
| $V_{IO}$          | Input offset voltage                                                | $V_O = 0$<br>$R_S = 50\ \Omega$                                                  | $T_A = 25^\circ\text{C}$  |                    | 3          | 6   | mV                           |
|                   |                                                                     |                                                                                  | $T_A = \text{Full range}$ |                    |            | 9   |                              |
| $\alpha_{VIO}$    | Temperature coefficient of input offset voltage                     | $V_O = 0$<br>$R_S = 50\ \Omega$                                                  | $T_A = \text{Full range}$ |                    | 18         |     | $\mu\text{V}/^\circ\text{C}$ |
| $I_{IO}$          | Input offset current                                                | $V_O = 0$                                                                        | $T_A = 25^\circ\text{C}$  |                    | 5          | 100 | pA                           |
|                   |                                                                     |                                                                                  | $T_A = \text{Full range}$ |                    |            | 20  | nA                           |
| $I_{IB}$          | Input bias current                                                  | $V_O = 0$                                                                        | $T_A = 25^\circ\text{C}$  |                    | 65         | 200 | pA                           |
|                   |                                                                     |                                                                                  | $T_A = \text{Full range}$ |                    |            | 50  | nA                           |
| $V_{ICR}$         | Common-mode input voltage range                                     | $T_A = 25^\circ\text{C}$                                                         |                           | $\pm 11$ –12 to 15 |            |     | V                            |
| $V_{OM}$          | Maximum peak output voltage swing                                   | $R_L = 10\text{ k}\Omega$                                                        | $T_A = 25^\circ\text{C}$  | $\pm 12$           | $\pm 13.5$ |     | V                            |
|                   |                                                                     | $R_L \geq 10\text{ k}\Omega$                                                     | $T_A = \text{Full range}$ | $\pm 12$           |            |     |                              |
|                   |                                                                     | $R_L \geq 2\text{ k}\Omega$                                                      |                           | $\pm 10$           |            |     |                              |
| $A_{VD}$          | Large-signal differential voltage amplification                     | $V_O = \pm 10\text{ V}$<br>$R_L \geq 2\text{ k}\Omega$                           | $T_A = 25^\circ\text{C}$  | 35                 | 200        |     | V/mV                         |
|                   |                                                                     |                                                                                  | $T_A = \text{Full range}$ | 15                 |            |     |                              |
| $B_1$             | Unity-gain bandwidth                                                |                                                                                  |                           |                    | 3          |     | MHz                          |
| $r_i$             | Input resistance                                                    |                                                                                  |                           |                    | $10^{12}$  |     | $\Omega$                     |
| CMRR              | Common-mode rejection ratio                                         | $V_{IC} = V_{ICR(\min)}$<br>$V_O = 0$<br>$R_S = 50\ \Omega$                      | $T_A = 25^\circ\text{C}$  | 80                 | 86         |     | dB                           |
| $k_{SVR}$         | Supply-voltage rejection ratio ( $\Delta V_{CC\pm}/\Delta V_{IO}$ ) | $V_{CC} = \pm 9\text{ V to } \pm 15\text{ V}$<br>$V_O = 0$<br>$R_S = 50\ \Omega$ | $T_A = 25^\circ\text{C}$  | 80                 | 86         |     | dB                           |
| $I_{CC}$          | Supply current (each amplifier)                                     | $V_O = 0$ ; no load                                                              | $T_A = 25^\circ\text{C}$  |                    | 1.4        | 2.5 | mA                           |
| $V_{O1} / V_{O2}$ | Crosstalk attenuation                                               | $A_{VD} = 100$                                                                   | $T_A = 25^\circ\text{C}$  |                    | 120        |     | dB                           |

- (1) Input bias currents of an FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive, as shown in [Figure 6-40](#). Pulse techniques that maintain the junction temperature as close to the ambient temperature as possible must be used.
- (2) All characteristics are measured under open-loop conditions with zero common-mode voltage, unless otherwise specified. Full range is  $T_A = -55^\circ\text{C to } +125^\circ\text{C}$ .

## 6.23 Electrical Characteristics: TL074M

$V_{CC\pm} = \pm 15\text{ V}$  (unless otherwise noted)

| PARAMETER                         |                                                                       | TEST CONDITIONS (1) (2)                                                                |                             | MIN | TYP              | MAX       | UNIT  |
|-----------------------------------|-----------------------------------------------------------------------|----------------------------------------------------------------------------------------|-----------------------------|-----|------------------|-----------|-------|
| V <sub>IO</sub>                   | Input offset voltage                                                  | V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω                                            | T <sub>A</sub> = 25°C       |     | 3                | 9         | mV    |
|                                   |                                                                       |                                                                                        | T <sub>A</sub> = Full range |     |                  | 15        |       |
| α <sub>VIO</sub>                  | Temperature coefficient of input offset voltage                       | V <sub>O</sub> = 0, R <sub>S</sub> = 50 Ω                                              | T <sub>A</sub> = Full range |     | 18               |           | μV/°C |
| I <sub>IO</sub>                   | Input offset current                                                  | V <sub>O</sub> = 0                                                                     | T <sub>A</sub> = 25°C       |     | 5                | 100       | pA    |
|                                   |                                                                       |                                                                                        | T <sub>A</sub> = Full range |     |                  | 20        | nA    |
| I <sub>IB</sub>                   | Input bias current                                                    | V <sub>O</sub> = 0                                                                     | T <sub>A</sub> = 25°C       |     | 65               | 200       | pA    |
|                                   |                                                                       |                                                                                        | T <sub>A</sub> = Full range |     |                  | 20        | nA    |
| V <sub>ICR</sub>                  | Common-mode input voltage range                                       | T <sub>A</sub> = 25°C                                                                  |                             |     | ±11              | –12 to 15 | V     |
| V <sub>OM</sub>                   | Maximum peak output voltage swing                                     | R <sub>L</sub> = 10 kΩ                                                                 | T <sub>A</sub> = 25°C       |     | ±12              | ±13.5     | V     |
|                                   |                                                                       | R <sub>L</sub> ≥ 10 kΩ                                                                 | T <sub>A</sub> = Full range |     | ±12              |           |       |
|                                   |                                                                       | R <sub>L</sub> ≥ 2 kΩ                                                                  |                             |     | ±10              |           |       |
| A <sub>VD</sub>                   | Large-signal differential voltage amplification                       | V <sub>O</sub> = ±10 V<br>R <sub>L</sub> ≥ 2 kΩ                                        | T <sub>A</sub> = 25°C       |     | 35               | 200       | V/mV  |
|                                   |                                                                       |                                                                                        | T <sub>A</sub> = Full range |     | 15               |           |       |
| B <sub>1</sub>                    | Unity-gain bandwidth                                                  |                                                                                        |                             |     | 3                |           | MHz   |
| r <sub>i</sub>                    | Input resistance                                                      |                                                                                        |                             |     | 10 <sup>12</sup> |           | Ω     |
| CMRR                              | Common-mode rejection ratio                                           | V <sub>IC</sub> = V <sub>ICR(min)</sub><br>V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω | T <sub>A</sub> = 25°C       |     | 80               | 86        | dB    |
| k <sub>SVR</sub>                  | Supply-voltage rejection ratio (ΔV <sub>CC±</sub> /ΔV <sub>IO</sub> ) | V <sub>CC</sub> = ±9 V to ±15 V<br>V <sub>O</sub> = 0<br>R <sub>S</sub> = 50 Ω         | T <sub>A</sub> = 25°C       |     | 80               | 86        | dB    |
| I <sub>CC</sub>                   | Supply current (each amplifier)                                       | V <sub>O</sub> = 0; no load                                                            | T <sub>A</sub> = 25°C       |     | 1.4              | 2.5       | mA    |
| V <sub>O1</sub> / V <sub>O2</sub> | Crosstalk attenuation                                                 | A <sub>VD</sub> = 100                                                                  | T <sub>A</sub> = 25°C       |     | 120              |           | dB    |

- (1) Input bias currents of an FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive, as shown in [Figure 6-40](#). Pulse techniques that maintain the junction temperature as close to the ambient temperature as possible must be used.
- (2) All characteristics are measured under open-loop conditions with zero common-mode voltage, unless otherwise specified. Full range is  $T_A = -55^\circ\text{C to } +125^\circ\text{C}$ .



## 6.24 Switching Characteristics: TL07xM

$V_{CC\pm} = \pm 15\text{ V}$ ,  $T_A = 25^\circ\text{C}$

| PARAMETER |                                | TEST CONDITIONS                                                                    |                                                            | MIN | TYP    | MAX | UNIT                   |
|-----------|--------------------------------|------------------------------------------------------------------------------------|------------------------------------------------------------|-----|--------|-----|------------------------|
| SR        | Slew rate at unity gain        | $V_I = 10\text{ V}$<br>$C_L = 100\text{ pF}$                                       | $R_L = 2\text{ k}\Omega$<br>See <a href="#">Figure 7-1</a> | 5   | 13     |     | V/ $\mu\text{s}$       |
| $t_r$     | Rise-time overshoot factor     | $V_I = 20\text{ V}$<br>$C_L = 100\text{ pF}$                                       | $R_L = 2\text{ k}\Omega$<br>See <a href="#">Figure 7-1</a> |     | 0.1    |     | $\mu\text{s}$          |
|           |                                |                                                                                    |                                                            |     | 20%    |     |                        |
| $V_n$     | Equivalent input noise voltage | $R_S = 20\text{ }\Omega$                                                           | $f = 1\text{ kHz}$                                         |     | 18     |     | nV/ $\sqrt{\text{Hz}}$ |
|           |                                |                                                                                    | $f = 10\text{ Hz to }10\text{ kHz}$                        |     | 4      |     | $\mu\text{V}$          |
| $I_n$     | Equivalent input noise current | $R_S = 20\text{ }\Omega$                                                           | $f = 1\text{ kHz}$                                         |     | 0.01   |     | pA/ $\sqrt{\text{Hz}}$ |
| THD       | Total harmonic distortion      | $V_{\text{rms}} = 6\text{ V}$<br>$R_L \geq 2\text{ k}\Omega$<br>$f = 1\text{ kHz}$ | $A_{VD} = 1$<br>$R_S \leq 1\text{ k}\Omega$                |     | 0.003% |     |                        |

## 6.25 Switching Characteristics: TL07xC, TL07xAC, TL07xBC, TL07xI

$V_{CC\pm} = \pm 15\text{ V}$ ,  $T_A = 25^\circ\text{C}$

| PARAMETER |                                | TEST CONDITIONS                                                                    |                                                            | MIN | TYP    | MAX | UNIT                   |
|-----------|--------------------------------|------------------------------------------------------------------------------------|------------------------------------------------------------|-----|--------|-----|------------------------|
| SR        | Slew rate at unity gain        | $V_I = 10\text{ V}$<br>$C_L = 100\text{ pF}$                                       | $R_L = 2\text{ k}\Omega$<br>See <a href="#">Figure 7-1</a> | 8   | 13     |     | V/ $\mu\text{s}$       |
| $t_r$     | Rise-time overshoot factor     | $V_I = 20\text{ V}$<br>$C_L = 100\text{ pF}$                                       | $R_L = 2\text{ k}\Omega$<br>See <a href="#">Figure 7-1</a> |     | 0.1    |     | $\mu\text{s}$          |
|           |                                |                                                                                    |                                                            |     | 20%    |     |                        |
| $V_n$     | Equivalent input noise voltage | $R_S = 20\text{ }\Omega$                                                           | $f = 1\text{ kHz}$                                         |     | 18     |     | nV/ $\sqrt{\text{Hz}}$ |
|           |                                |                                                                                    | $f = 10\text{ Hz to }10\text{ kHz}$                        |     | 4      |     | $\mu\text{V}$          |
| $I_n$     | Equivalent input noise current | $R_S = 20\text{ }\Omega$                                                           | $f = 1\text{ kHz}$                                         |     | 0.01   |     | pA/ $\sqrt{\text{Hz}}$ |
| THD       | Total harmonic distortion      | $V_{\text{rms}} = 6\text{ V}$<br>$R_L \geq 2\text{ k}\Omega$<br>$f = 1\text{ kHz}$ | $A_{VD} = 1$<br>$R_S \leq 1\text{ k}\Omega$                |     | 0.003% |     |                        |

## 6.26 Typical Characteristics: TL07xH

at  $T_A = 25^\circ\text{C}$ ,  $V_S = 40\text{ V}$  ( $\pm 20\text{ V}$ ),  $V_{CM} = V_S / 2$ ,  $R_{LOAD} = 10\text{ k}\Omega$  connected to  $V_S / 2$ , and  $C_L = 20\text{ pF}$  (unless otherwise noted)

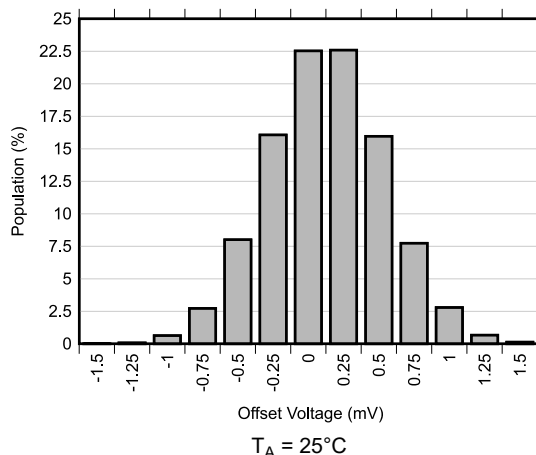


Figure 6-1. Offset Voltage Production Distribution

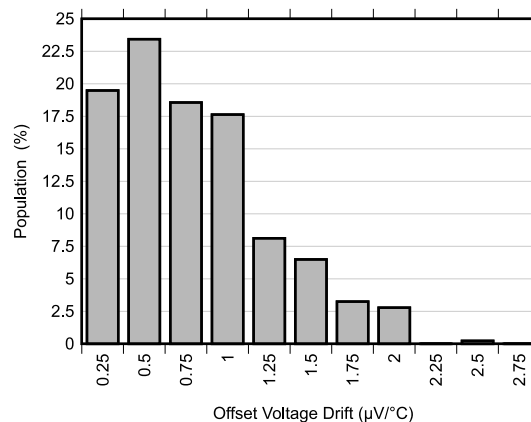


Figure 6-2. Offset Voltage Drift Distribution

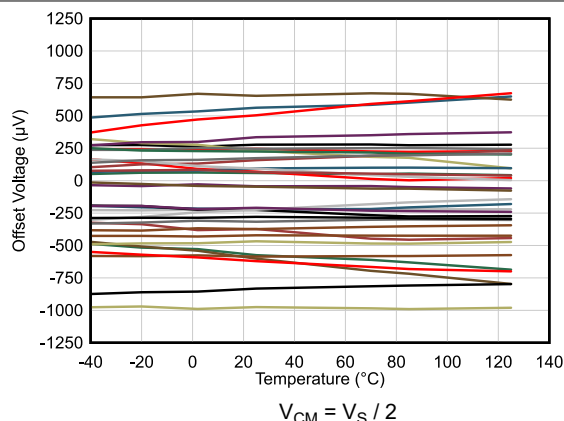


Figure 6-3. Offset Voltage vs Temperature

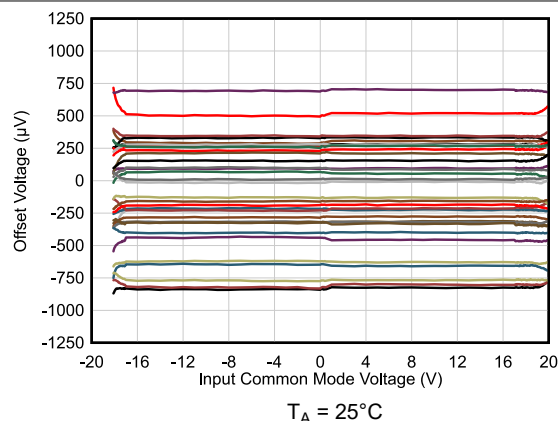


Figure 6-4. Offset Voltage vs Common-Mode Voltage

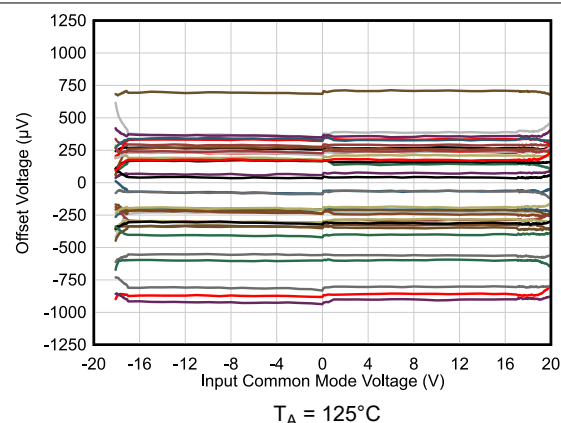


Figure 6-5. Offset Voltage vs Common-Mode Voltage

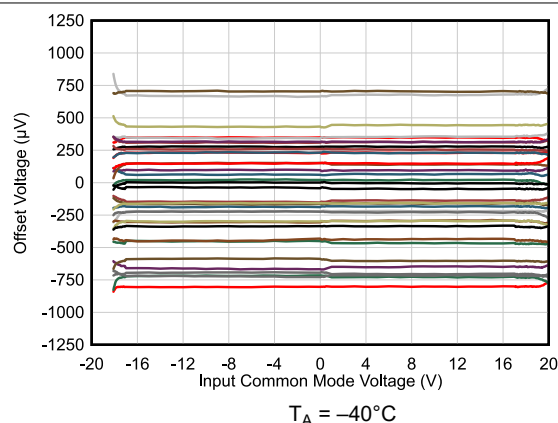


Figure 6-6. Offset Voltage vs Common-Mode Voltage

## 6.26 Typical Characteristics: TL07xH (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_S = 40\text{ V}$  ( $\pm 20\text{ V}$ ),  $V_{CM} = V_S / 2$ ,  $R_{LOAD} = 10\text{ k}\Omega$  connected to  $V_S / 2$ , and  $C_L = 20\text{ pF}$  (unless otherwise noted)

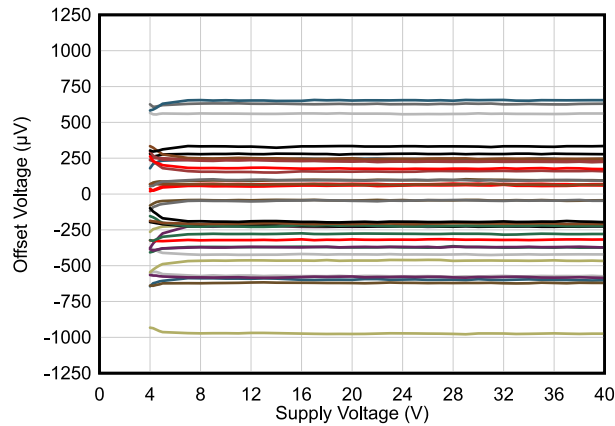


Figure 6-7. Offset Voltage vs Power Supply

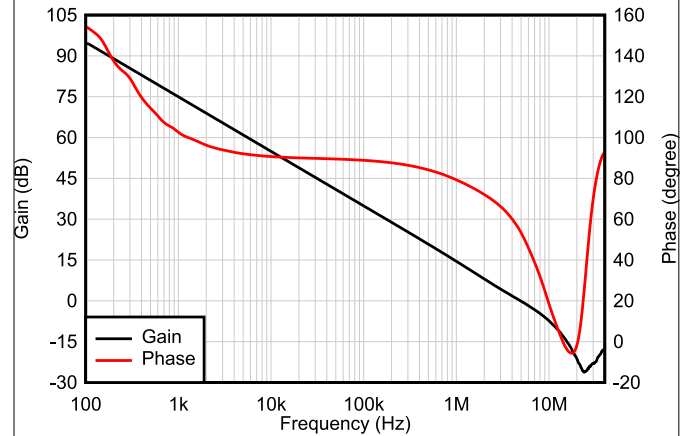


Figure 6-8. Open-Loop Gain and Phase vs Frequency

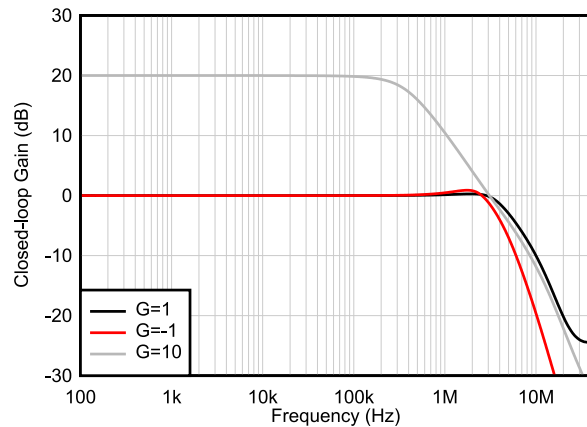


Figure 6-9. Closed-Loop Gain vs Frequency

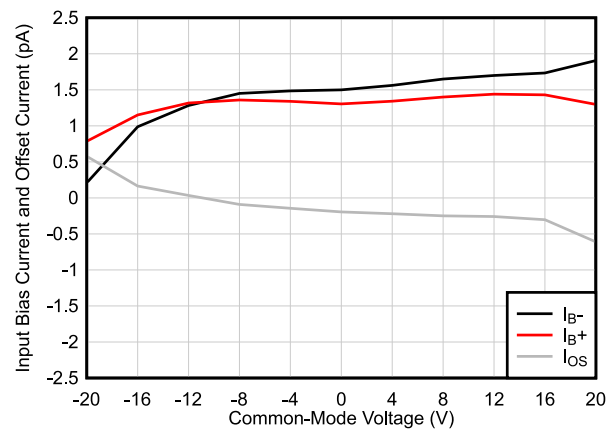


Figure 6-10. Input Bias Current vs Common-Mode Voltage

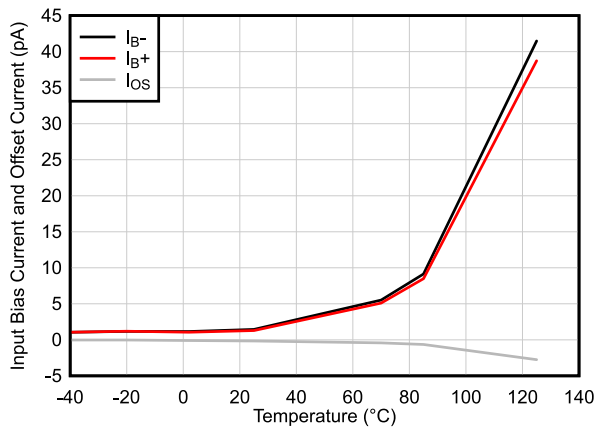


Figure 6-11. Input Bias Current vs Temperature

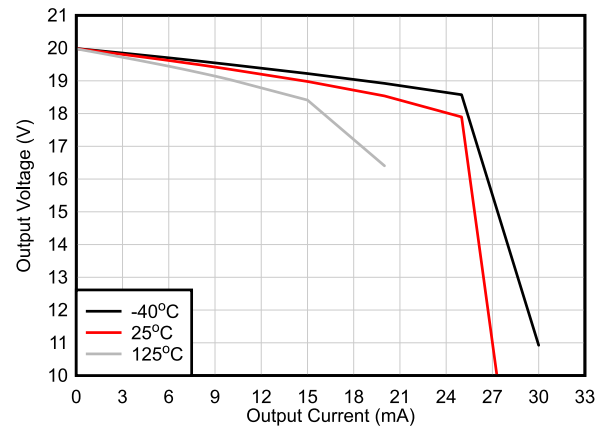


Figure 6-12. Output Voltage Swing vs Output Current (Sourcing)

## 6.26 Typical Characteristics: TL07xH (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_S = 40\text{ V}$  ( $\pm 20\text{ V}$ ),  $V_{CM} = V_S / 2$ ,  $R_{LOAD} = 10\text{ k}\Omega$  connected to  $V_S / 2$ , and  $C_L = 20\text{ pF}$  (unless otherwise noted)

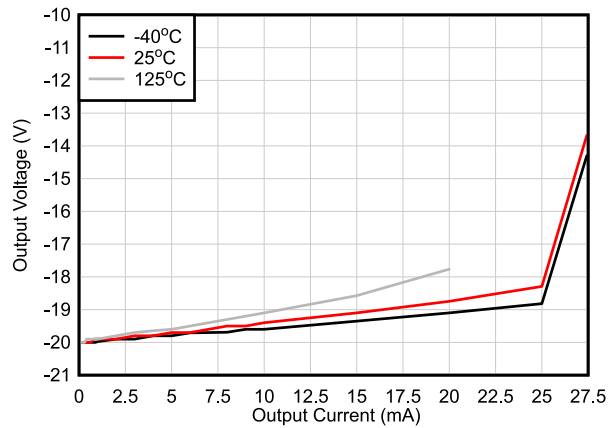


Figure 6-13. Output Voltage Swing vs Output Current (Sinking)

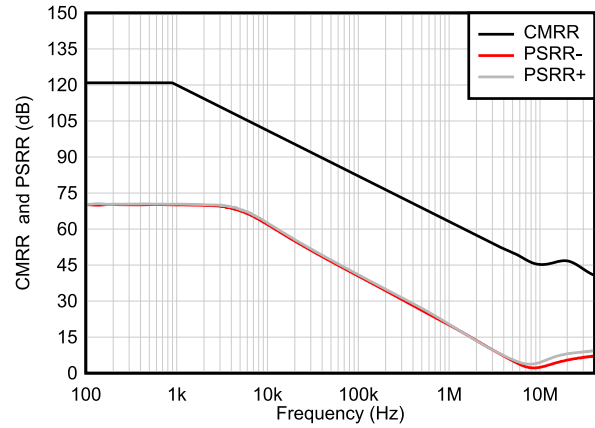


Figure 6-14. CMRR and PSRR vs Frequency

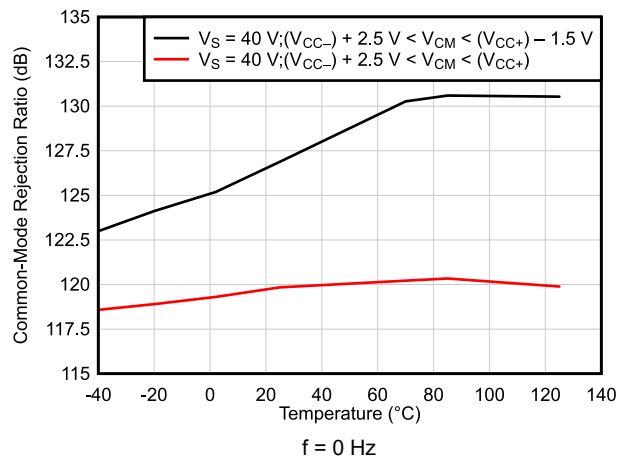


Figure 6-15. CMRR vs Temperature (dB)

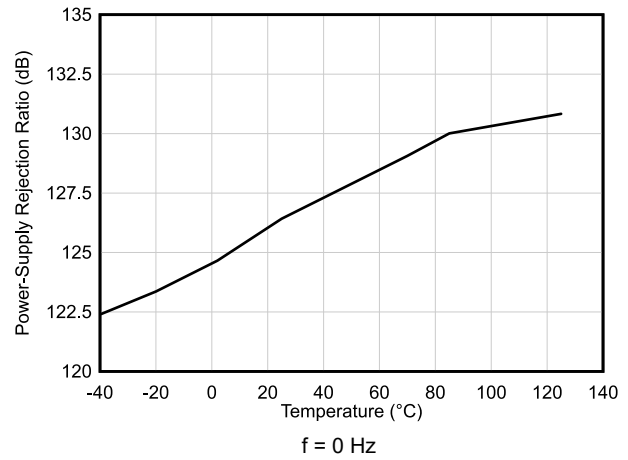


Figure 6-16. PSRR vs Temperature (dB)

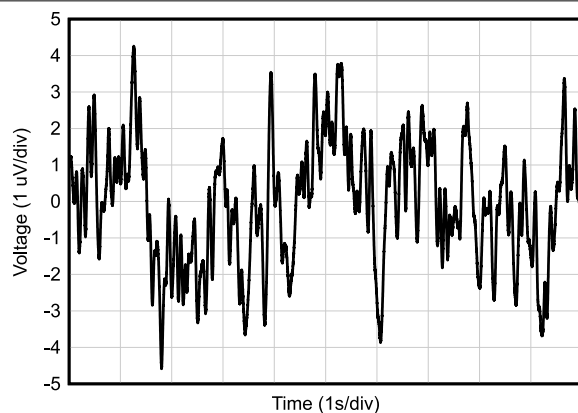


Figure 6-17. 0.1-Hz to 10-Hz Noise

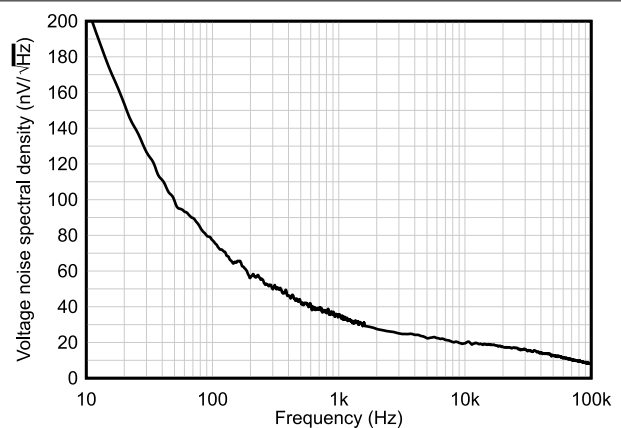


Figure 6-18. Input Voltage Noise Spectral Density vs Frequency

## 6.26 Typical Characteristics: TL07xH (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_S = 40\text{ V}$  ( $\pm 20\text{ V}$ ),  $V_{CM} = V_S / 2$ ,  $R_{LOAD} = 10\text{ k}\Omega$  connected to  $V_S / 2$ , and  $C_L = 20\text{ pF}$  (unless otherwise noted)

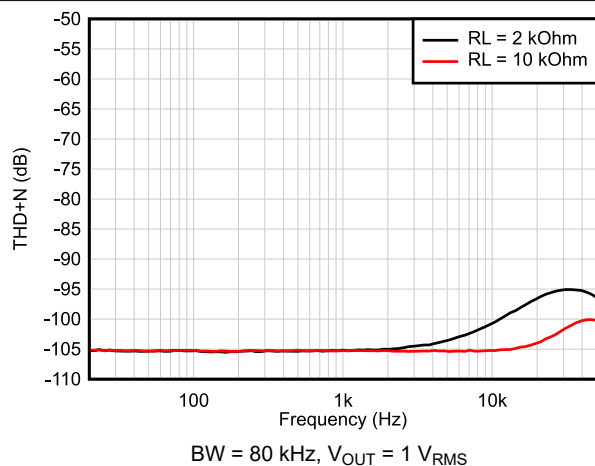


Figure 6-19. THD+N Ratio vs Frequency

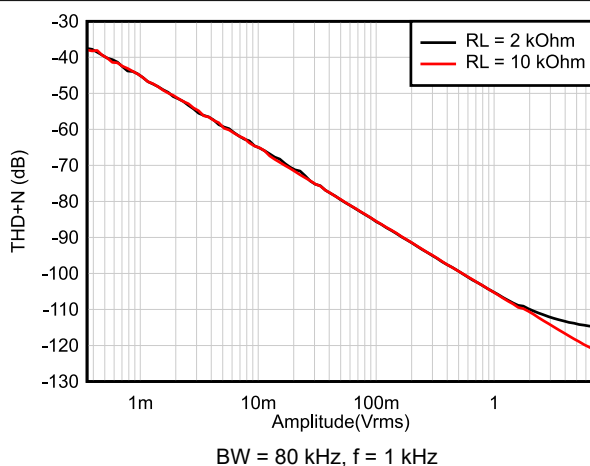


Figure 6-20. THD+N vs Output Amplitude

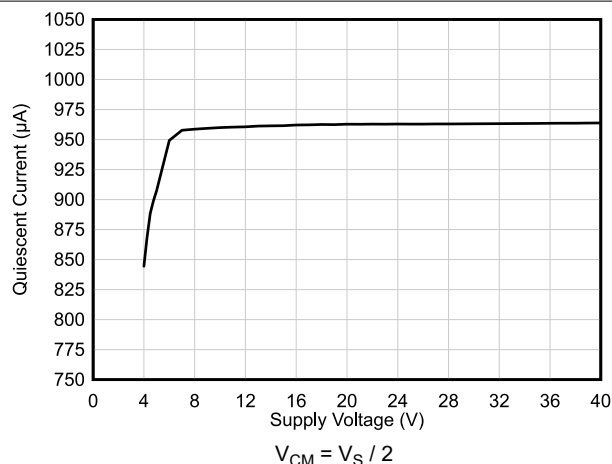


Figure 6-21. Quiescent Current vs Supply Voltage

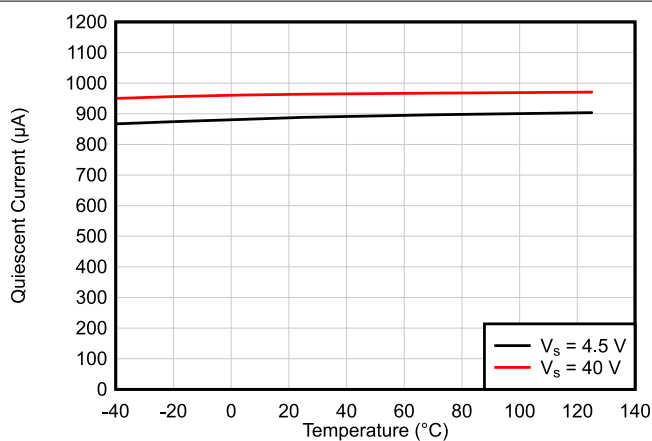


Figure 6-22. Quiescent Current vs Temperature

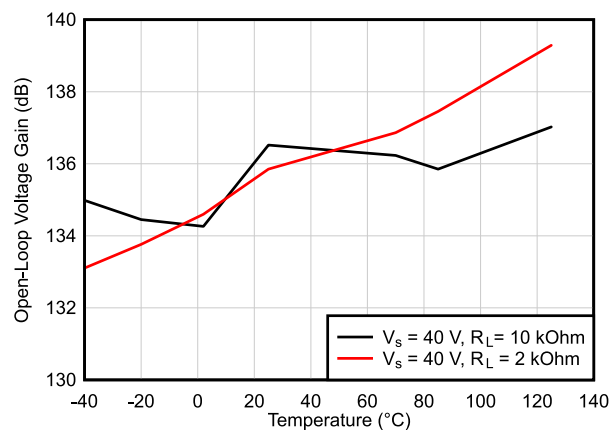


Figure 6-23. Open-Loop Voltage Gain vs Temperature (dB)

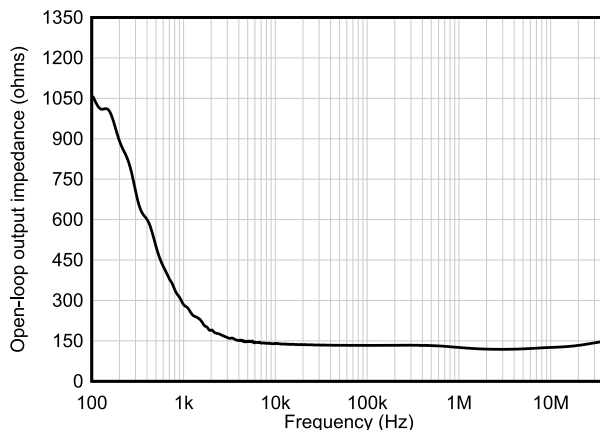


Figure 6-24. Open-Loop Output Impedance vs Frequency

## 6.26 Typical Characteristics: TL07xH (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_S = 40\text{ V}$  ( $\pm 20\text{ V}$ ),  $V_{CM} = V_S / 2$ ,  $R_{LOAD} = 10\text{ k}\Omega$  connected to  $V_S / 2$ , and  $C_L = 20\text{ pF}$  (unless otherwise noted)

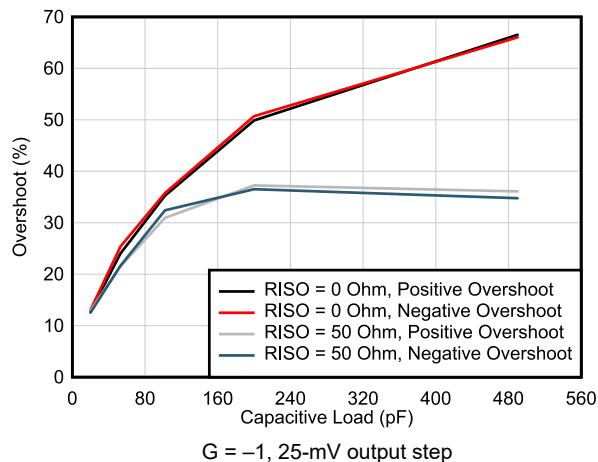


Figure 6-25. Small-Signal Overshoot vs Capacitive Load

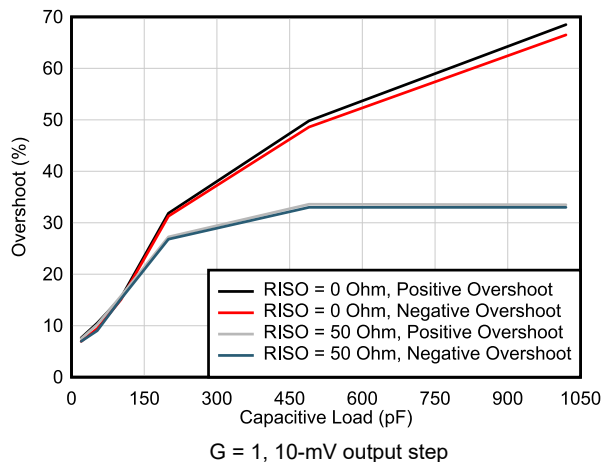


Figure 6-26. Small-Signal Overshoot vs Capacitive Load

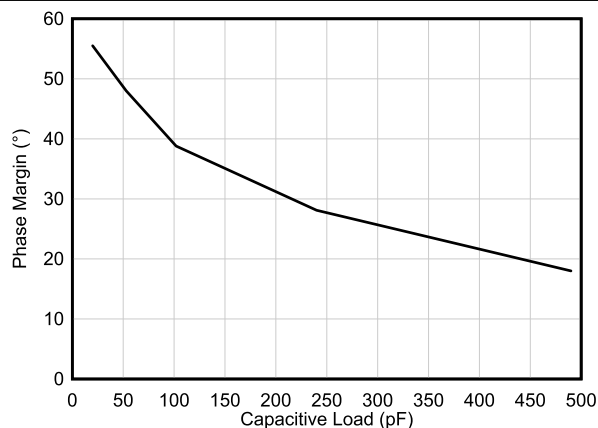


Figure 6-27. Phase Margin vs Capacitive Load

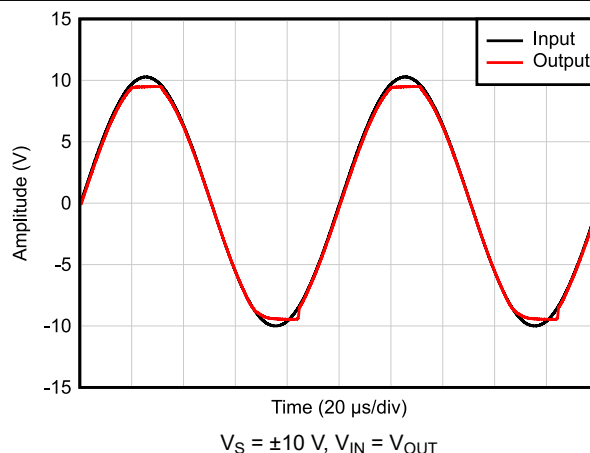


Figure 6-28. No Phase Reversal

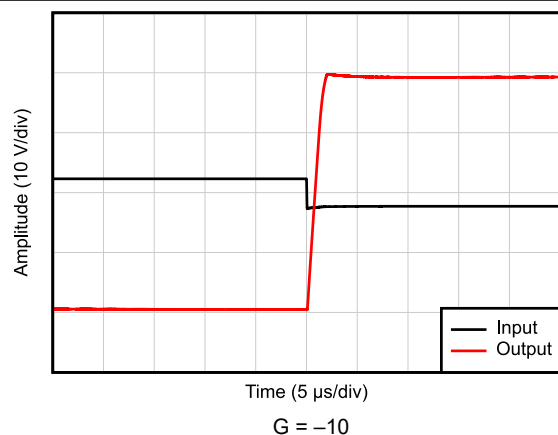


Figure 6-29. Positive Overload Recovery

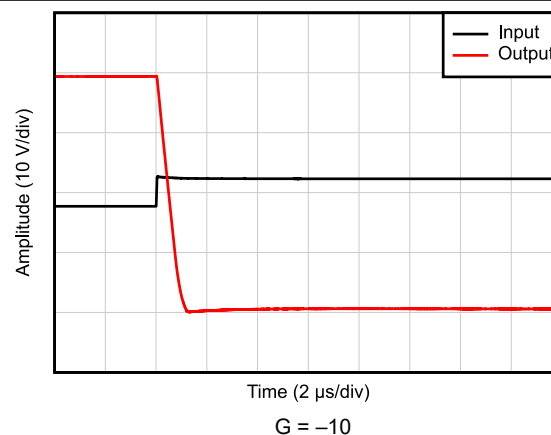
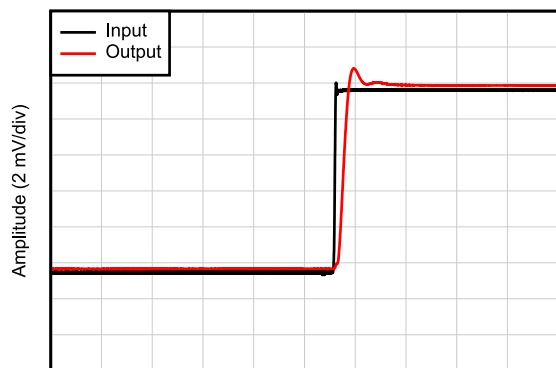


Figure 6-30. Negative Overload Recovery

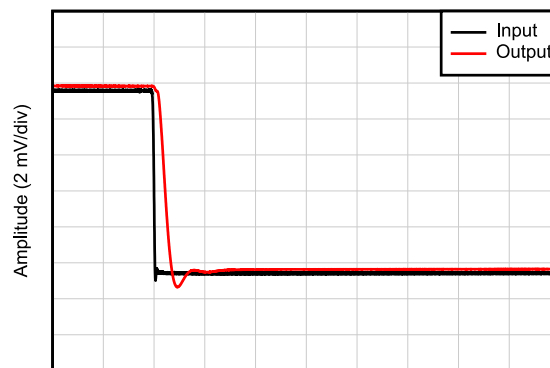
## 6.26 Typical Characteristics: TL07xH (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_S = 40\text{ V}$  ( $\pm 20\text{ V}$ ),  $V_{CM} = V_S / 2$ ,  $R_{LOAD} = 10\text{ k}\Omega$  connected to  $V_S / 2$ , and  $C_L = 20\text{ pF}$  (unless otherwise noted)



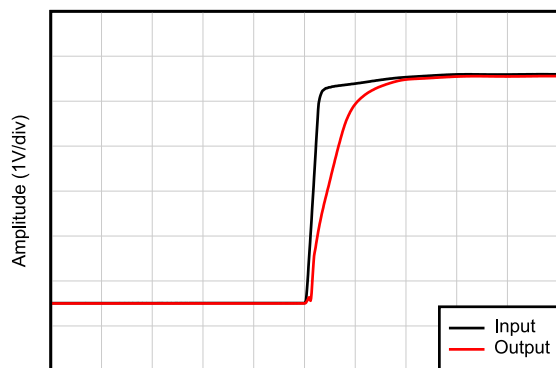
Time (200 ns/div)  
 $C_L = 20\text{ pF}$ ,  $G = 1$ , 10-mV step response

**Figure 6-31. Small-Signal Step Response, Rising**



Time (200 ns/div)  
 $C_L = 20\text{ pF}$ ,  $G = 1$ , 10-mV step response

**Figure 6-32. Small-Signal Step Response, Falling**



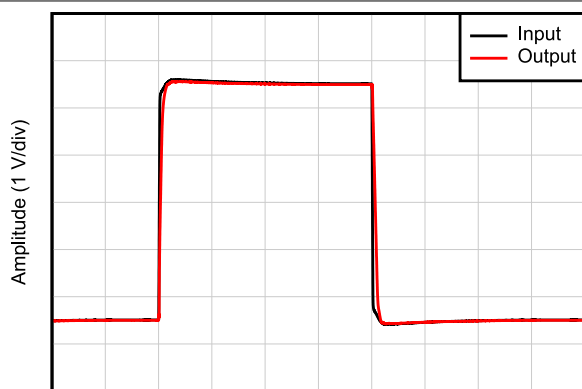
Time (200 ns/div)  
 $C_L = 20\text{ pF}$ ,  $G = 1$

**Figure 6-33. Large-Signal Step Response (Rising)**



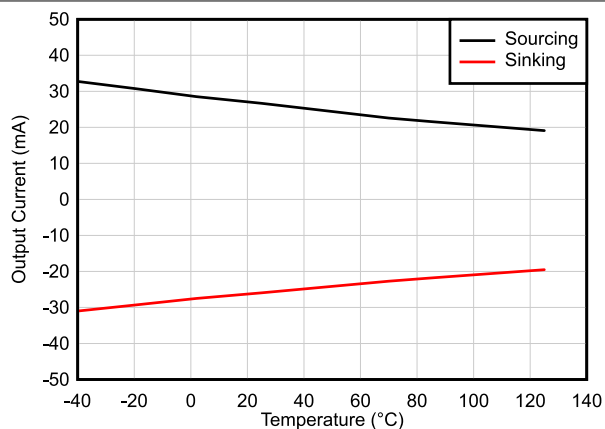
Time (200 ns/div)  
 $C_L = 20\text{ pF}$ ,  $G = 1$

**Figure 6-34. Large-Signal Step Response (Falling)**



Time (2.5  $\mu\text{s}$ /div)  
 $C_L = 20\text{ pF}$ ,  $G = 1$

**Figure 6-35. Large-Signal Step Response**



**Figure 6-36. Short-Circuit Current vs Temperature**

## 6.26 Typical Characteristics: TL07xH (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_S = 40\text{ V}$  ( $\pm 20\text{ V}$ ),  $V_{CM} = V_S / 2$ ,  $R_{LOAD} = 10\text{ k}\Omega$  connected to  $V_S / 2$ , and  $C_L = 20\text{ pF}$  (unless otherwise noted)

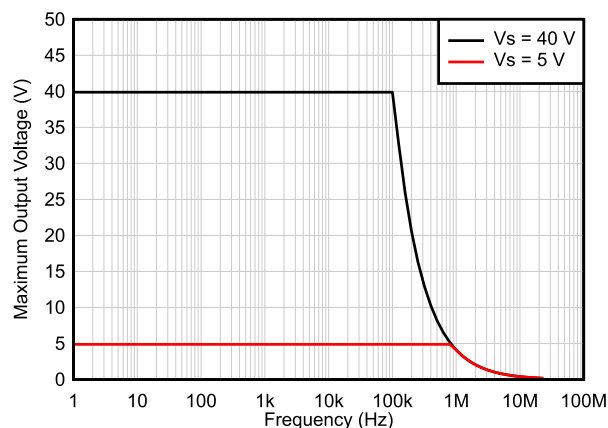


Figure 6-37. Maximum Output Voltage vs Frequency

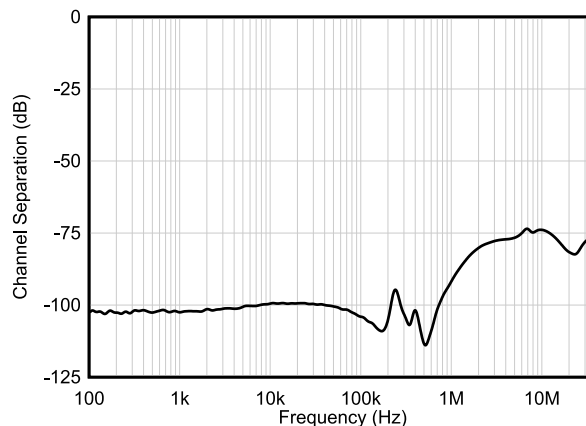


Figure 6-38. Channel Separation vs Frequency

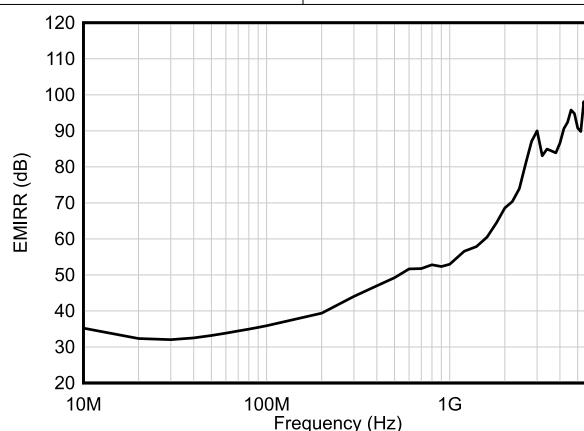


Figure 6-39. EMIRR (Electromagnetic Interference Rejection Ratio) vs Frequency



## 6.27 Typical Characteristics: All Devices Except TL07xH

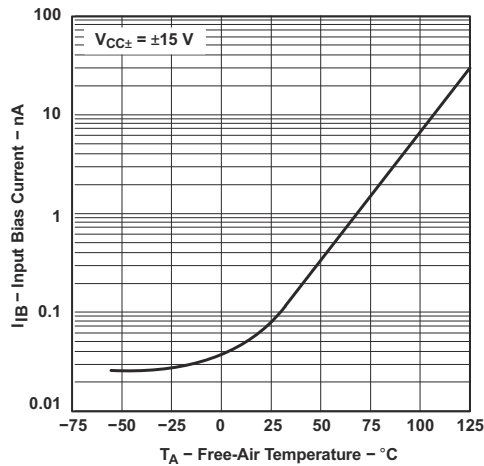


Figure 6-40. Input Bias Current vs Free-Air Temperature

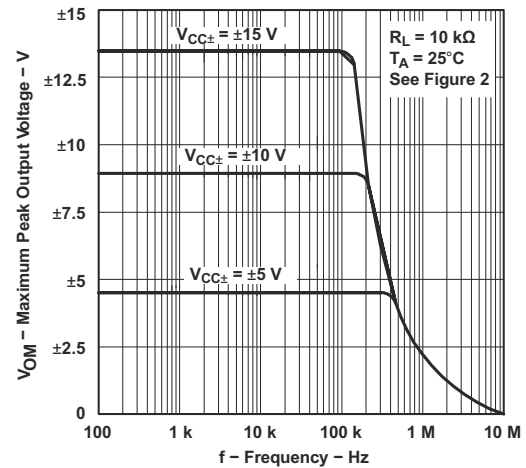


Figure 6-41. Maximum Peak Output Voltage vs Frequency

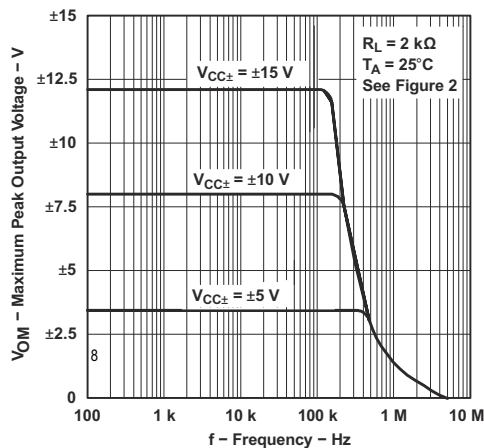


Figure 6-42. Maximum Peak Output Voltage vs Frequency

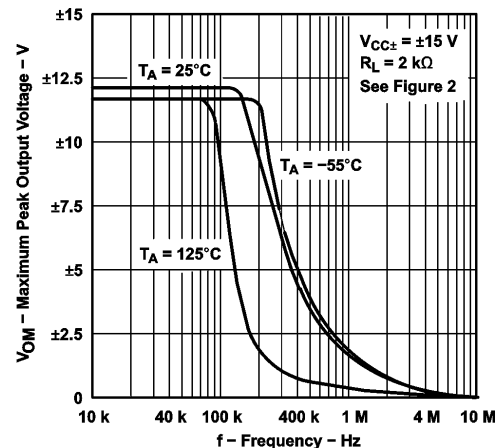


Figure 6-43. Maximum Peak Output Voltage vs Frequency

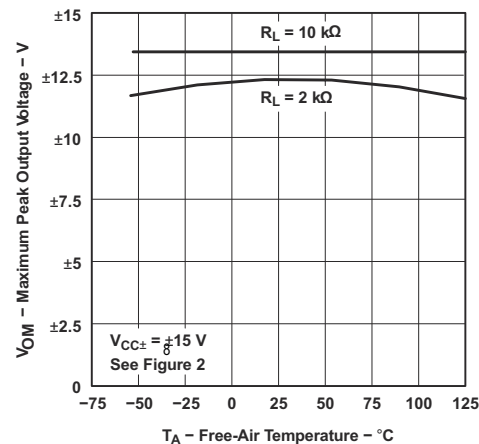


Figure 6-44. Maximum Peak Output Voltage vs Free-Air Temperature

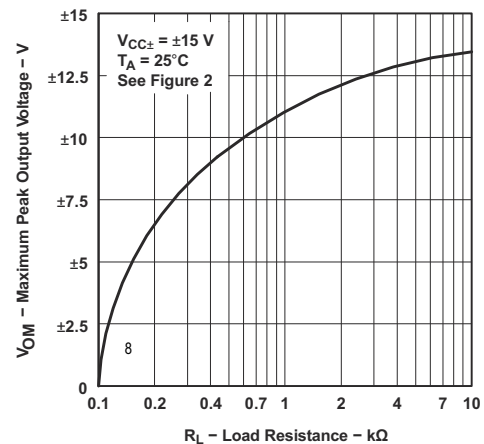


Figure 6-45. Maximum Peak Output Voltage vs Load Resistance

## 6.27 Typical Characteristics: All Devices Except TL07xH (continued)

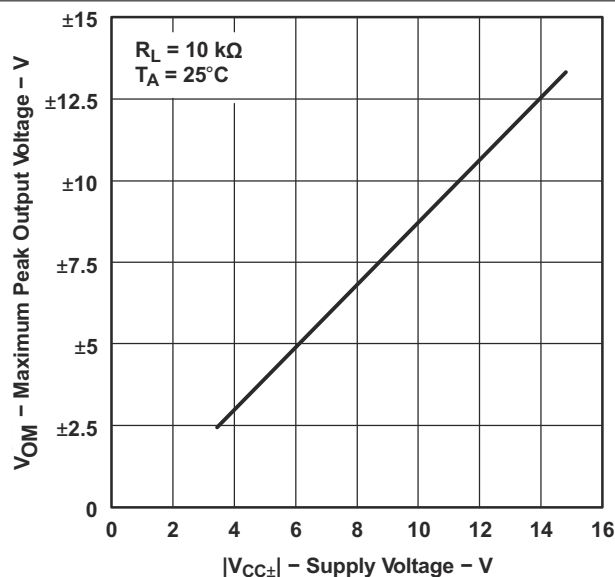


Figure 6-46. Maximum Peak Output Voltage vs Supply Voltage

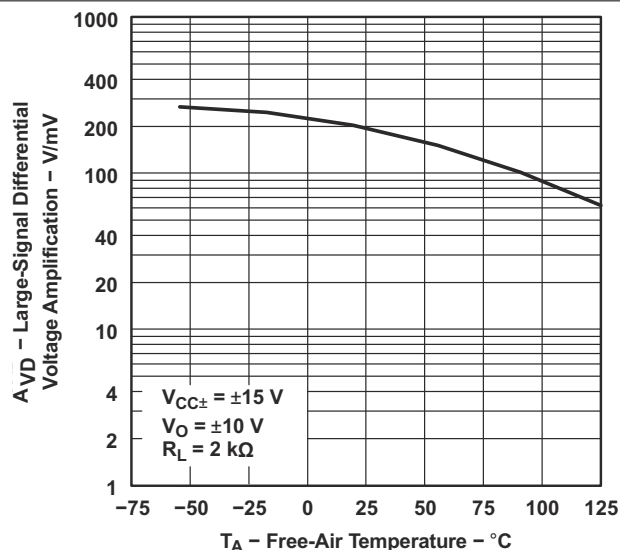


Figure 6-47. Large-Signal Differential Voltage Amplification vs Free-Air Temperature

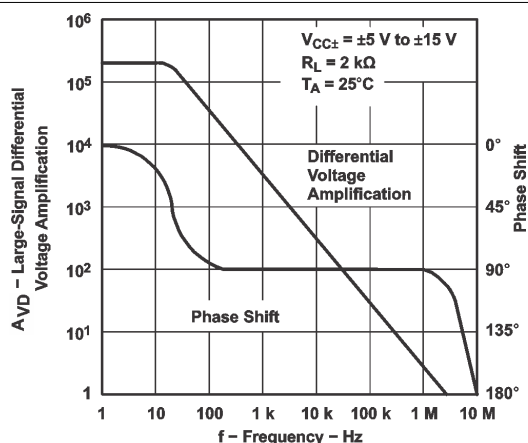


Figure 6-48. Large-Signal Differential Voltage Amplification and Phase Shift vs Frequency

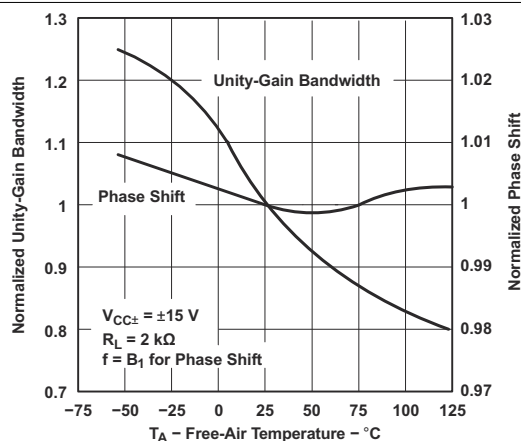


Figure 6-49. Normalized Unity-Gain Bandwidth and Phase Shift vs Free-Air Temperature

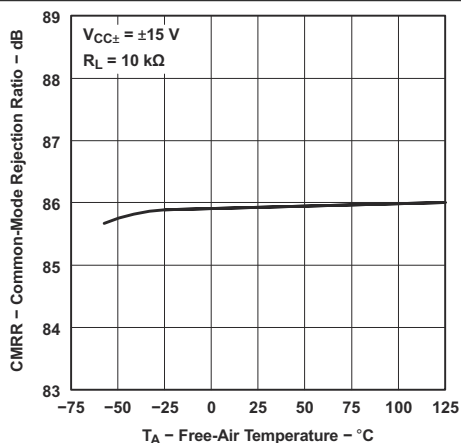


Figure 6-50. Common-Mode Rejection Ratio vs Free-Air Temperature

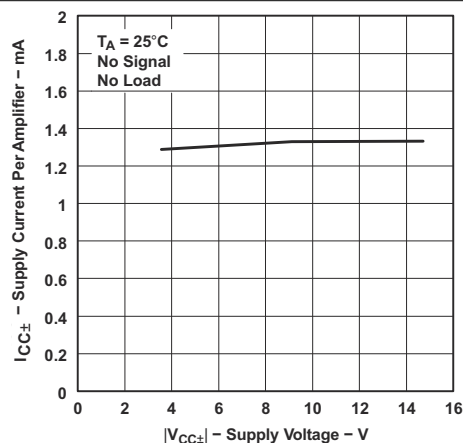


Figure 6-51. Supply Current Per Amplifier vs Supply Voltage

## 6.27 Typical Characteristics: All Devices Except TL07xH (continued)

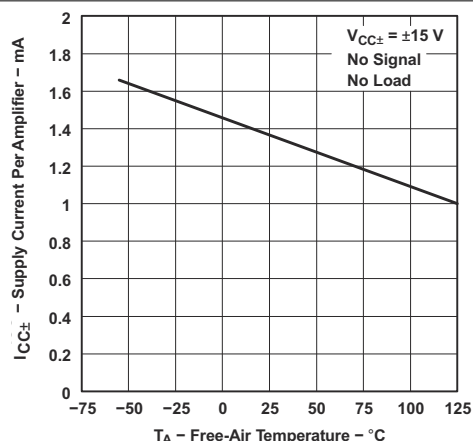


Figure 6-52. Supply Current Per Amplifier vs Free-Air Temperature

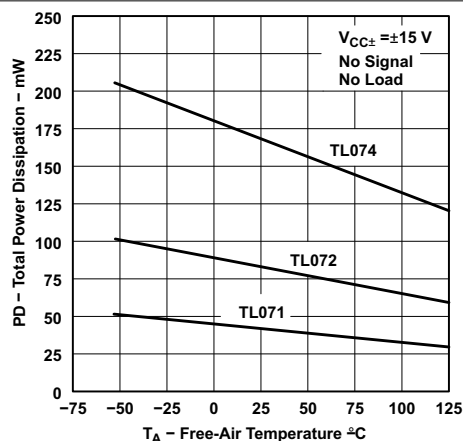


Figure 6-53. Total Power Dissipation vs Free-Air Temperature

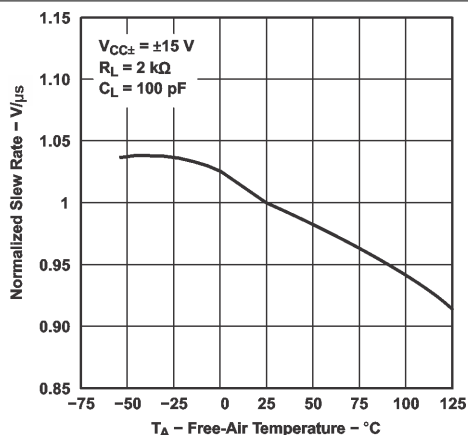


Figure 6-54. Normalized Slew Rate vs Free-Air Temperature

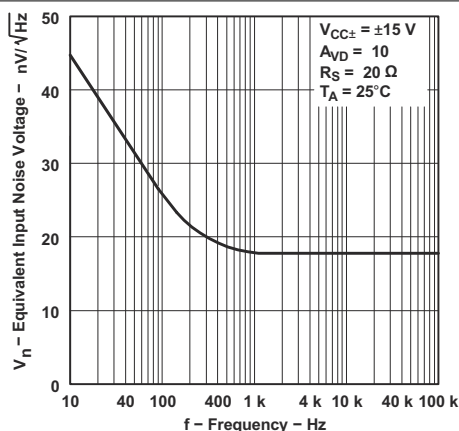


Figure 6-55. Equivalent Input Noise Voltage vs Frequency

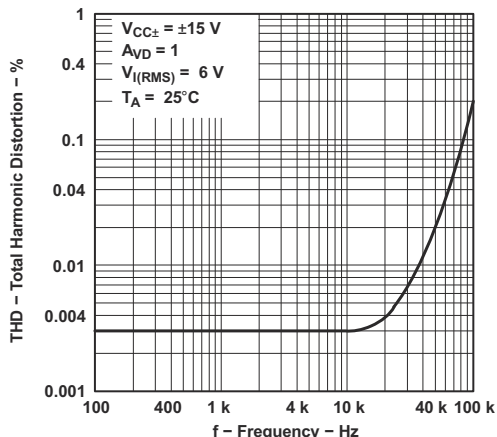


Figure 6-56. Total Harmonic Distortion vs Frequency

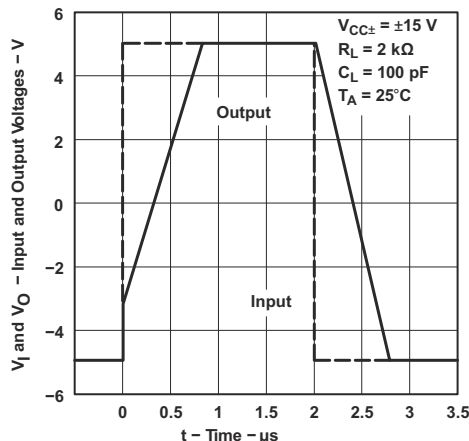


Figure 6-57. Voltage-Follower Large-Signal Pulse Response

## 6.27 Typical Characteristics: All Devices Except TL07xH (continued)

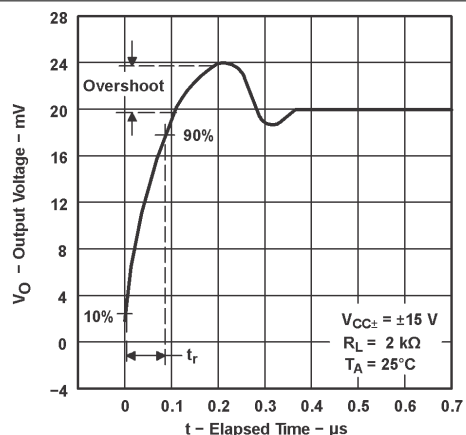


Figure 6-58. Output Voltage vs Elapsed Time

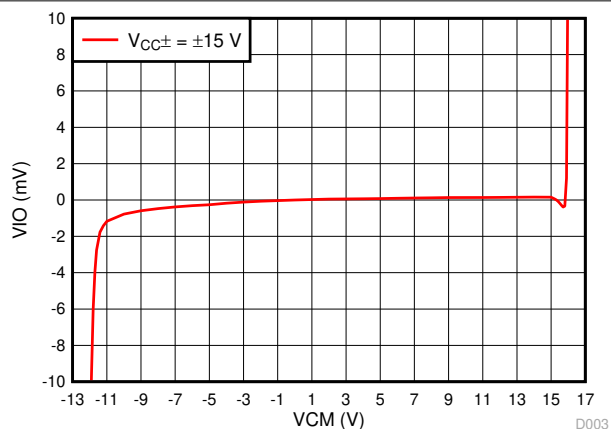


Figure 6-59.  $V_{IO}$  vs  $V_{CM}$

## 7 Parameter Measurement Information

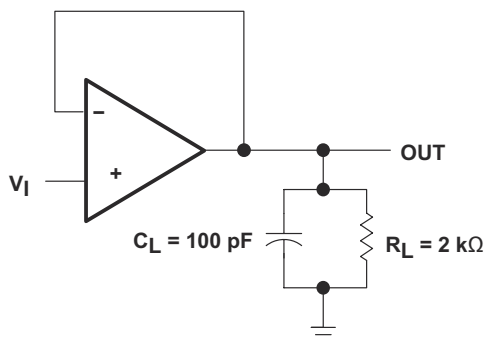


Figure 7-1. Unity-Gain Amplifier

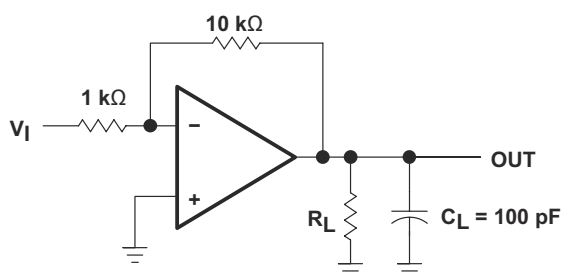


Figure 7-2. Gain-of-10 Inverting Amplifier

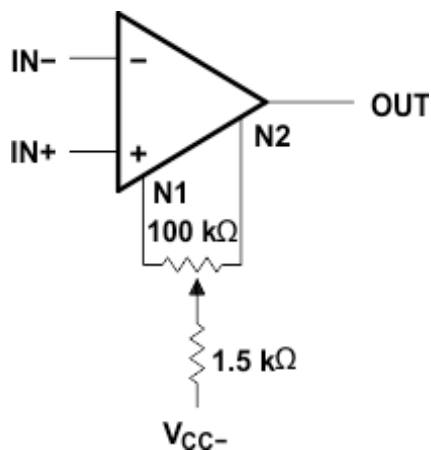


Figure 7-3. Input Offset-Voltage Null Circuit

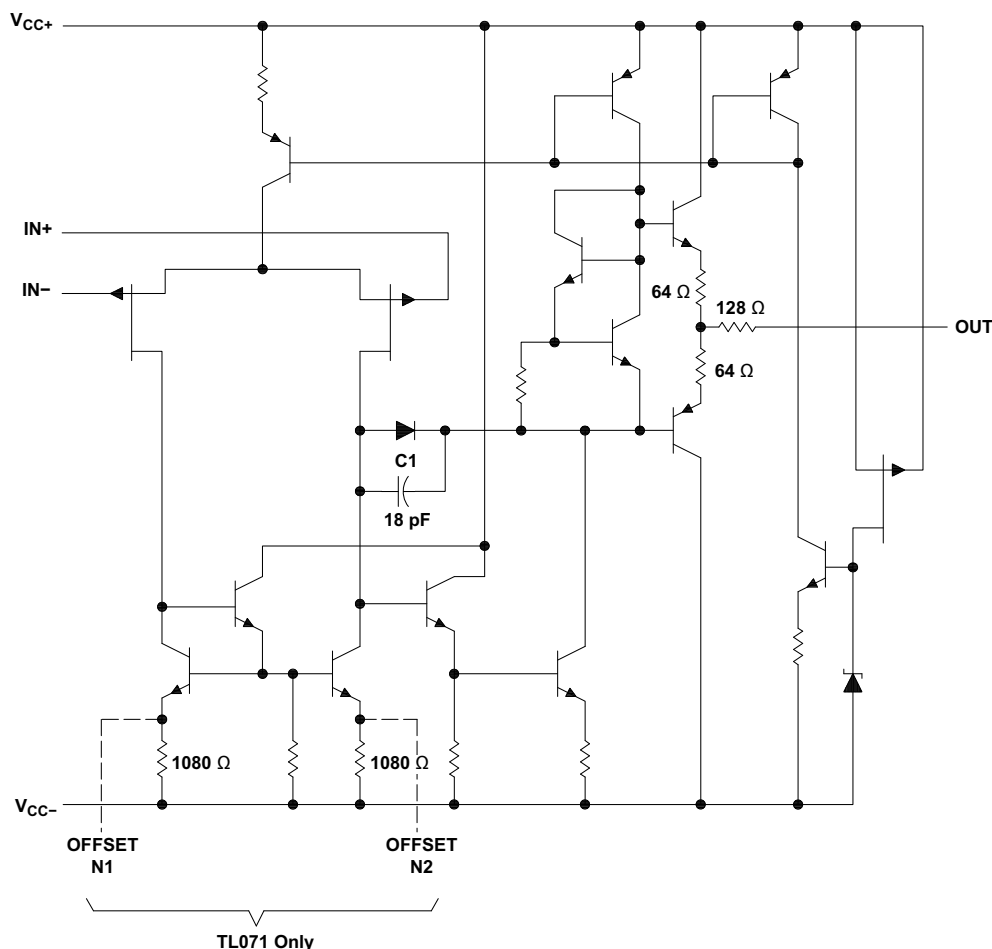
## 8 Detailed Description

### 8.1 Overview

The TL07xH (TL071H, TL072H, and TL074H) family of devices are the next-generation versions of the industry-standard TL07x (TL071, TL072, and TL074) devices. These devices provide outstanding value for cost-sensitive applications, with features including low offset (1 mV, typ), high slew rate (25 V/μs, typ), and common-mode input to the positive supply. High ESD (1.5 kV, HBM), integrated EMI and RF filters, and operation across the full  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$  enable the TL07xH devices to be used in the most rugged and demanding applications.

The C-suffix devices are characterized for operation from  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ . The I-suffix devices are characterized for operation from  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ . The M-suffix devices are characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .

### 8.2 Functional Block Diagram



All component values shown are nominal.

| COMPONENT COUNT† |       |       |       |
|------------------|-------|-------|-------|
| COMPONENT TYPE   | TL071 | TL072 | TL074 |
| Resistors        | 11    | 22    | 44    |
| Transistors      | 14    | 28    | 56    |
| JFET             | 2     | 4     | 6     |
| Diodes           | 1     | 2     | 4     |
| Capacitors       | 1     | 2     | 4     |
| epi-FET          | 1     | 2     | 4     |

† Includes bias and trim circuitry

## 8.3 Feature Description

The TL07xH family of devices improve many specifications as compared to the industry-standard TL07x family. Several comparisons of key specifications between these families are included below to show the advantages of the TL07xH family.

### 8.3.1 Total Harmonic Distortion

Harmonic distortions to an audio signal are created by electronic components in a circuit. Total harmonic distortion (THD) is a measure of harmonic distortions accumulated by a signal in an audio system. These devices have a very low THD of 0.003% meaning that the TL07x device adds little harmonic distortion when used in audio signal applications.

### 8.3.2 Slew Rate

The slew rate is the rate at which an operational amplifier can change the output when there is a change on the input. These devices have a 13-V/ $\mu$ s slew rate.

## 8.4 Device Functional Modes

These devices are powered on when the supply is connected. These devices can be operated as a single-supply operational amplifier or dual-supply amplifier depending on the application.

## 9 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 9.1 Application Information

A typical application for an operational amplifier is an inverting amplifier. This amplifier takes a positive voltage on the input, and makes the voltage a negative voltage. In the same manner, the amplifier makes negative voltages positive.

### 9.2 Typical Application

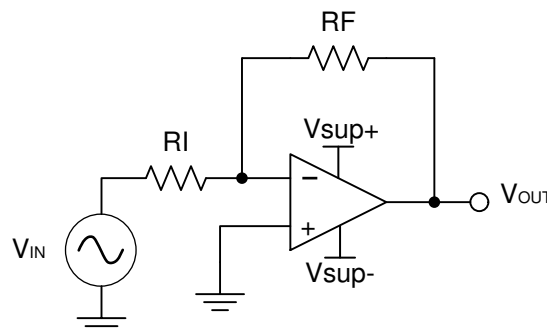


Figure 9-1. Inverting Amplifier

#### 9.2.1 Design Requirements

The supply voltage must be selected so the supply voltage is larger than the input voltage range and output range. For instance, this application scales a signal of  $\pm 0.5$  V to  $\pm 1.8$  V. Setting the supply at  $\pm 12$  V is sufficient to accommodate this application.

#### 9.2.2 Detailed Design Procedure

$$V_o = (V_i + V_{io}) * \left(1 + \frac{1M\Omega}{1k\Omega}\right) \quad (1)$$

Determine the gain required by the inverting amplifier:

$$A_v = \frac{V_{OUT}}{V_{IN}} \quad (2)$$

$$A_v = \frac{1.8}{-0.5} = -3.6 \quad (3)$$

Once the desired gain is determined, select a value for  $R_I$  or  $R_F$ . Selecting a value in the kilohm range is desirable because the amplifier circuit uses currents in the milliamp range. This ensures the part does not draw too much current. This example uses 10 k $\Omega$  for  $R_I$  which means 36 k $\Omega$  is used for  $R_F$ . This is determined by Equation 4.

$$A_v = -\frac{R_F}{R_I} \quad (4)$$



### 9.2.3 Application Curve

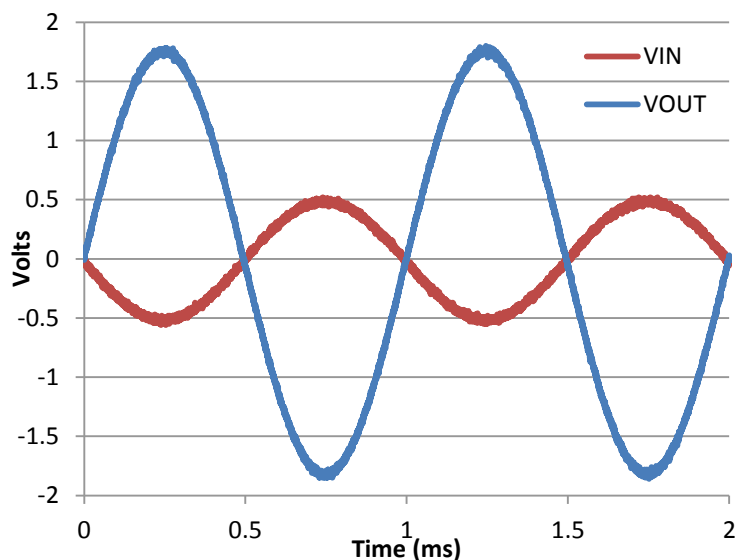
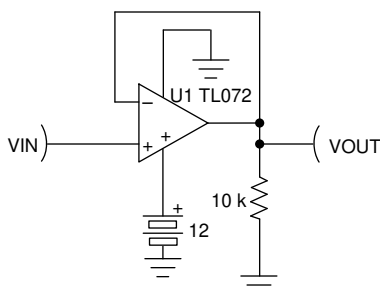


Figure 9-2. Input and Output Voltages of the Inverting Amplifier

### 9.3 Unity Gain Buffer



Copyright © 2017, Texas Instruments Incorporated

Figure 9-3. Single-Supply Unity Gain Amplifier

#### 9.3.1 Design Requirements

- $V_{CC}$  must be within valid range per [Section 6.6](#). This example uses a value of 12 V for  $V_{CC}$ .
- Input voltage must be within the recommended common-mode range, as shown in [Section 6.6](#). The valid common-mode range is 4 V to 12 V ( $V_{CC-} + 4$  V to  $V_{CC+}$ ).
- Output is limited by output range, which is typically 1.5 V to 10.5 V, or  $V_{CC-} + 1.5$  V to  $V_{CC+} - 1.5$  V.

#### 9.3.2 Detailed Design Procedure

- Avoid input voltage values below 1 V to prevent phase reversal where output goes high.
- Avoid input values below 4 V to prevent degraded  $V_{IO}$  that results in an apparent gain greater than 1. This may cause instability in some second-order filter designs.

### 9.3.3 Application Curves

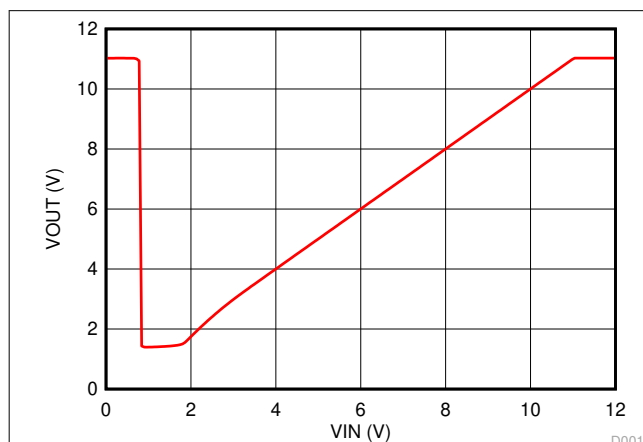


Figure 9-4. Output Voltage vs Input Voltage

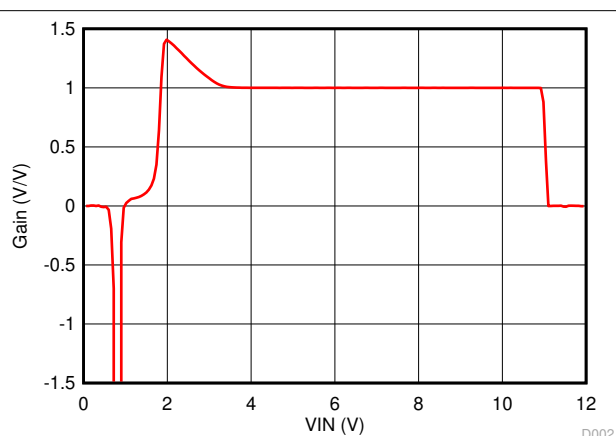


Figure 9-5. Gain vs Input Voltage

### 9.4 System Examples

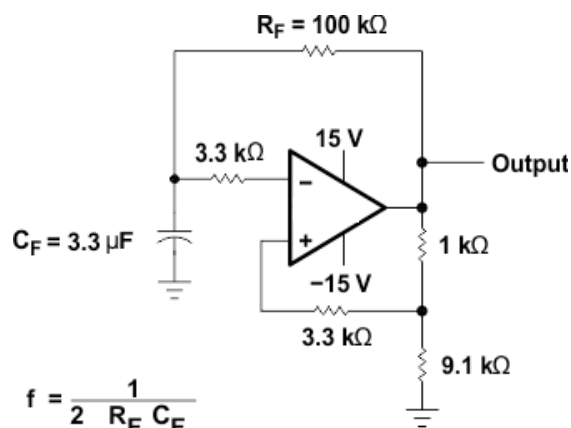


Figure 9-6. 0.5-Hz Square-Wave Oscillator

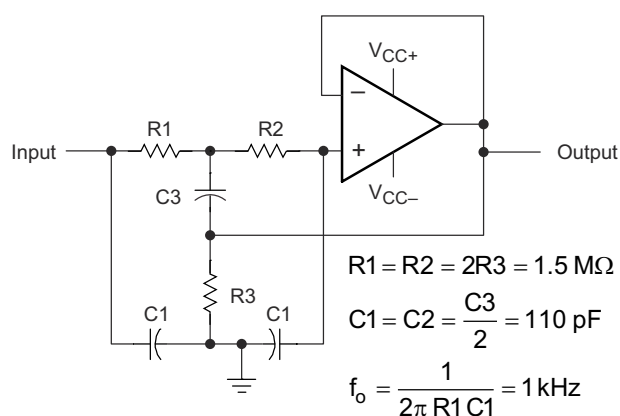


Figure 9-7. High-Q Notch Filter

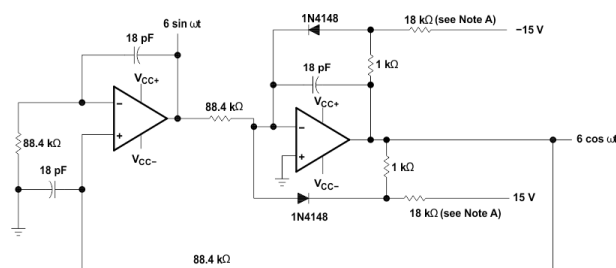


Figure 9-8. 100-kHz Quadrature Oscillator

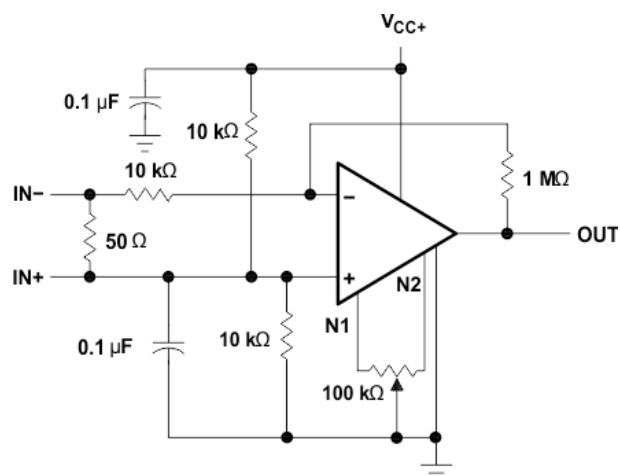


Figure 9-9. AC Amplifier

## 10 Power Supply Recommendations

### CAUTION

Supply voltages larger than 36 V for a single-supply or outside the range of  $\pm 18$  V for a dual-supply can permanently damage the device (see [Section 6.2](#)).

Place 0.1- $\mu$ F bypass capacitors close to the power-supply pins to reduce errors coupling in from noisy or high-impedance power supplies. For more detailed information on bypass capacitor placement, see [Section 11](#).

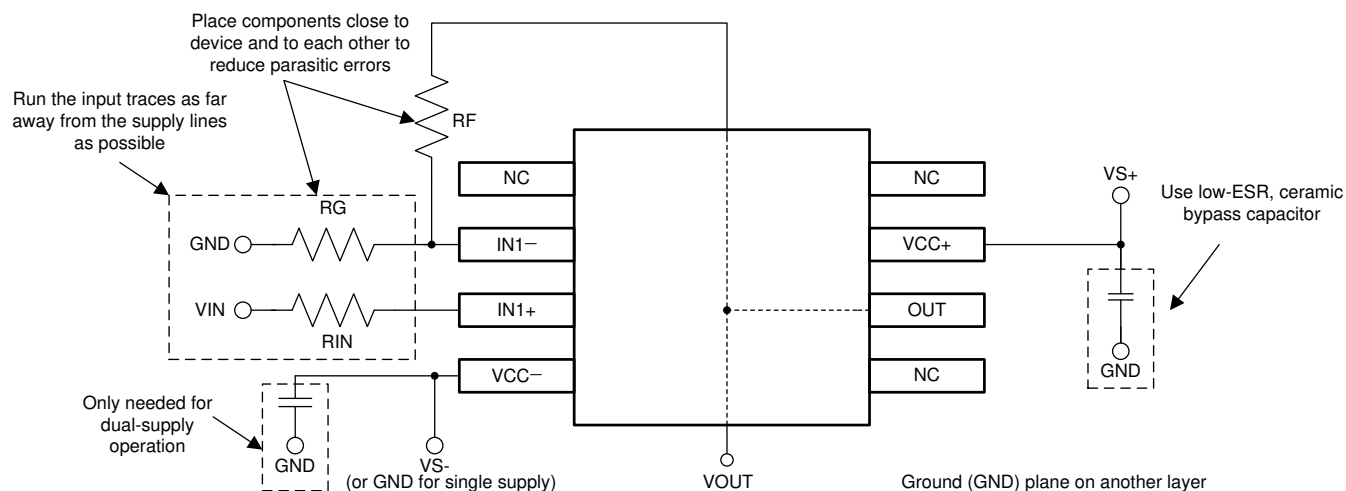
## 11 Layout

### 11.1 Layout Guidelines

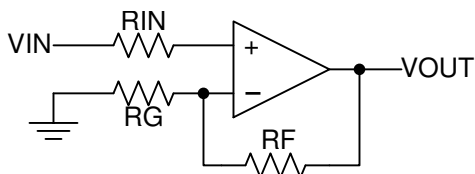
For best operational performance of the device, use good PCB layout practices, including:

- Noise can propagate into analog circuitry through the power pins of the circuit as a whole, as well as the operational amplifier. Bypass capacitors are used to reduce the coupled noise by providing low impedance power sources local to the analog circuitry.
  - Connect low-ESR, 0.1- $\mu$ F ceramic bypass capacitors between each supply pin and ground, placed as close to the device as possible. A single bypass capacitor from  $V_{CC+}$  to ground is applicable for single-supply applications.
- Separate grounding for analog and digital portions of circuitry is one of the simplest and most-effective methods of noise suppression. One or more layers on multilayer PCBs are usually devoted to ground planes. A ground plane helps distribute heat and reduces EMI noise pickup. Take care to physically separate digital and analog grounds, paying attention to the flow of the ground current.
- To reduce parasitic coupling, run the input traces as far away from the supply or output traces as possible. If it is not possible to keep them separate, it is much better to cross the sensitive trace perpendicular as opposed to in parallel with the noisy trace.
- Place the external components as close to the device as possible. Keeping RF and RG close to the inverting input minimizes parasitic capacitance, as shown in [Section 11.2](#).
- Keep the length of input traces as short as possible. Always remember that the input traces are the most sensitive part of the circuit.
- Consider a driven, low-impedance guard ring around the critical traces. A guard ring can significantly reduce leakage currents from nearby traces that are at different potentials.

## 11.2 Layout Example



**Figure 11-1. Operational Amplifier Board Layout for Noninverting Configuration**



**Figure 11-2. Operational Amplifier Schematic for Noninverting Configuration**

## 12 Device and Documentation Support

### 12.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 12.2 Support Resources

TI E2E™ [support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 12.3 Trademarks

TI E2E™ is a trademark of Texas Instruments.

All trademarks are the property of their respective owners.

### 12.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 12.5 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser based versions of this data sheet, refer to the left hand navigation.

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| 81023052A        | ACTIVE        | LCCC         | FK                 | 20   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 81023052A<br>TL072MFKB  | <a href="#">Samples</a> |
| 8102305HA        | ACTIVE        | CFP          | U                  | 10   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 8102305HA<br>TL072M     | <a href="#">Samples</a> |
| 8102305PA        | ACTIVE        | CDIP         | JG                 | 8    | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 8102305PA<br>TL072M     | <a href="#">Samples</a> |
| 81023062A        | ACTIVE        | LCCC         | FK                 | 20   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 81023062A<br>TL074MFKB  | <a href="#">Samples</a> |
| 8102306CA        | ACTIVE        | CDIP         | J                  | 14   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 8102306CA<br>TL074MJB   | <a href="#">Samples</a> |
| 8102306DA        | ACTIVE        | CFP          | W                  | 14   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 8102306DA<br>TL074MWB   | <a href="#">Samples</a> |
| JM38510/11905BPA | ACTIVE        | CDIP         | JG                 | 8    | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | JM38510<br>/11905BPA    | <a href="#">Samples</a> |
| M38510/11905BPA  | ACTIVE        | CDIP         | JG                 | 8    | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | JM38510<br>/11905BPA    | <a href="#">Samples</a> |
| TL071ACD         | LIFEBUY       | SOIC         | D                  | 8    | 75             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 071AC                   |                         |
| TL071ACDG4       | LIFEBUY       | SOIC         | D                  | 8    | 75             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 071AC                   |                         |
| TL071ACDR        | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 071AC                   | <a href="#">Samples</a> |
| TL071ACP         | ACTIVE        | PDIP         | P                  | 8    | 50             | RoHS & Green        | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL071ACP                | <a href="#">Samples</a> |
| TL071BCD         | LIFEBUY       | SOIC         | D                  | 8    | 75             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 071BC                   |                         |
| TL071BCDR        | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 071BC                   | <a href="#">Samples</a> |
| TL071BCP         | ACTIVE        | PDIP         | P                  | 8    | 50             | RoHS & Green        | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL071BCP                | <a href="#">Samples</a> |
| TL071CD          | LIFEBUY       | SOIC         | D                  | 8    | 75             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL071C                  |                         |
| TL071CDR         | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL071C                  | <a href="#">Samples</a> |
| TL071CDRE4       | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL071C                  | <a href="#">Samples</a> |
| TL071CDRG4       | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL071C                  | <a href="#">Samples</a> |
| TL071CP          | ACTIVE        | PDIP         | P                  | 8    | 50             | RoHS & Green        | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL071CP                 | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TL071CPE4        | ACTIVE        | PDIP         | P                  | 8    | 50             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL071CP                 | <a href="#">Samples</a> |
| TL071CPSR        | ACTIVE        | SO           | PS                 | 8    | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | T071                    | <a href="#">Samples</a> |
| TL071HIDBVR      | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | T71V                    | <a href="#">Samples</a> |
| TL071HIDCKR      | ACTIVE        | SC70         | DCK                | 5    | 3000           | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1IO                     | <a href="#">Samples</a> |
| TL071HIDR        | ACTIVE        | SOIC         | D                  | 8    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | TL071D                  | <a href="#">Samples</a> |
| TL071ID          | LIFEBUY       | SOIC         | D                  | 8    | 75             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL071I                  |                         |
| TL071IDR         | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL071I                  | <a href="#">Samples</a> |
| TL071IDRG4       | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL071I                  | <a href="#">Samples</a> |
| TL071IP          | ACTIVE        | PDIP         | P                  | 8    | 50             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | -40 to 85    | TL071IP                 | <a href="#">Samples</a> |
| TL072ACD         | LIFEBUY       | SOIC         | D                  | 8    | 75             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 072AC                   |                         |
| TL072ACDE4       | LIFEBUY       | SOIC         | D                  | 8    | 75             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 072AC                   |                         |
| TL072ACDR        | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 072AC                   | <a href="#">Samples</a> |
| TL072ACDRE4      | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 072AC                   | <a href="#">Samples</a> |
| TL072ACDRG4      | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 072AC                   | <a href="#">Samples</a> |
| TL072ACP         | ACTIVE        | PDIP         | P                  | 8    | 50             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL072ACP                | <a href="#">Samples</a> |
| TL072ACPE4       | ACTIVE        | PDIP         | P                  | 8    | 50             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL072ACP                | <a href="#">Samples</a> |
| TL072BCD         | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 072BC                   | <a href="#">Samples</a> |
| TL072BCDE4       | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 072BC                   | <a href="#">Samples</a> |
| TL072BCDG4       | ACTIVE        | SOIC         | D                  | 8    | 75             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 072BC                   | <a href="#">Samples</a> |
| TL072BCDR        | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 072BC                   | <a href="#">Samples</a> |
| TL072BCP         | ACTIVE        | PDIP         | P                  | 8    | 50             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL072BCP                | <a href="#">Samples</a> |
| TL072CD          | LIFEBUY       | SOIC         | D                  | 8    | 75             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL072C                  |                         |
| TL072CDE4        | LIFEBUY       | SOIC         | D                  | 8    | 75             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL072C                  |                         |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TL072CDG4        | LIFEBUY       | SOIC         | D                  | 8    | 75             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL072C                  |                         |
| TL072CDR         | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL072C                  | <a href="#">Samples</a> |
| TL072CDRE4       | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL072C                  | <a href="#">Samples</a> |
| TL072CDRG4       | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL072C                  | <a href="#">Samples</a> |
| TL072CP          | ACTIVE        | PDIP         | P                  | 8    | 50             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL072CP                 | <a href="#">Samples</a> |
| TL072CPE4        | ACTIVE        | PDIP         | P                  | 8    | 50             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL072CP                 | <a href="#">Samples</a> |
| TL072CPS         | ACTIVE        | SO           | PS                 | 8    | 80             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | T072                    | <a href="#">Samples</a> |
| TL072CPSR        | ACTIVE        | SO           | PS                 | 8    | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | T072                    | <a href="#">Samples</a> |
| TL072CPSRG4      | ACTIVE        | SO           | PS                 | 8    | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | T072                    | <a href="#">Samples</a> |
| TL072CPWR        | ACTIVE        | TSSOP        | PW                 | 8    | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | T072                    | <a href="#">Samples</a> |
| TL072CPWRE4      | ACTIVE        | TSSOP        | PW                 | 8    | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | T072                    | <a href="#">Samples</a> |
| TL072CPWRG4      | ACTIVE        | TSSOP        | PW                 | 8    | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | T072                    | <a href="#">Samples</a> |
| TL072HIDDFR      | ACTIVE        | SOT-23-THIN  | DDF                | 8    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | O72F                    | <a href="#">Samples</a> |
| TL072HIDR        | ACTIVE        | SOIC         | D                  | 8    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | TL072D                  | <a href="#">Samples</a> |
| TL072HIPWR       | ACTIVE        | TSSOP        | PW                 | 8    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 072HPW                  | <a href="#">Samples</a> |
| TL072ID          | LIFEBUY       | SOIC         | D                  | 8    | 75             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL072I                  |                         |
| TL072IDE4        | LIFEBUY       | SOIC         | D                  | 8    | 75             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL072I                  |                         |
| TL072IDG4        | LIFEBUY       | SOIC         | D                  | 8    | 75             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL072I                  |                         |
| TL072IDR         | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL072I                  | <a href="#">Samples</a> |
| TL072IDRE4       | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL072I                  | <a href="#">Samples</a> |
| TL072IDRG4       | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL072I                  | <a href="#">Samples</a> |
| TL072IP          | ACTIVE        | PDIP         | P                  | 8    | 50             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | -40 to 85    | TL072IP                 | <a href="#">Samples</a> |



| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TL072IPE4        | ACTIVE        | PDIP         | P                  | 8    | 50             | RoHS & Green        | NIPDAU                               | N / A for Pkg Type   | -40 to 85    | TL072IP                 | <a href="#">Samples</a> |
| TL072MFKB        | ACTIVE        | LCCC         | FK                 | 20   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 81023052A<br>TL072MFKB  | <a href="#">Samples</a> |
| TL072MJG         | ACTIVE        | CDIP         | JG                 | 8    | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | TL072MJG                | <a href="#">Samples</a> |
| TL072MJGB        | ACTIVE        | CDIP         | JG                 | 8    | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 8102305PA<br>TL072M     | <a href="#">Samples</a> |
| TL072MUB         | ACTIVE        | CFP          | U                  | 10   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 8102305HA<br>TL072M     | <a href="#">Samples</a> |
| TL074ACD         | ACTIVE        | SOIC         | D                  | 14   | 50             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074AC                 | <a href="#">Samples</a> |
| TL074ACDE4       | ACTIVE        | SOIC         | D                  | 14   | 50             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074AC                 | <a href="#">Samples</a> |
| TL074ACDR        | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074AC                 | <a href="#">Samples</a> |
| TL074ACDRE4      | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074AC                 | <a href="#">Samples</a> |
| TL074ACN         | ACTIVE        | PDIP         | N                  | 14   | 25             | RoHS & Green        | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL074ACN                | <a href="#">Samples</a> |
| TL074ACNE4       | ACTIVE        | PDIP         | N                  | 14   | 25             | RoHS & Green        | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL074ACN                | <a href="#">Samples</a> |
| TL074ACNSR       | ACTIVE        | SO           | NS                 | 14   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074A                  | <a href="#">Samples</a> |
| TL074BCD         | ACTIVE        | SOIC         | D                  | 14   | 50             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074BC                 | <a href="#">Samples</a> |
| TL074BCDE4       | ACTIVE        | SOIC         | D                  | 14   | 50             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074BC                 | <a href="#">Samples</a> |
| TL074BCDR        | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074BC                 | <a href="#">Samples</a> |
| TL074BCDRE4      | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074BC                 | <a href="#">Samples</a> |
| TL074BCDRG4      | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074BC                 | <a href="#">Samples</a> |
| TL074BCN         | ACTIVE        | PDIP         | N                  | 14   | 25             | RoHS & Green        | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL074BCN                | <a href="#">Samples</a> |
| TL074BCNE4       | ACTIVE        | PDIP         | N                  | 14   | 25             | RoHS & Green        | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL074BCN                | <a href="#">Samples</a> |
| TL074CD          | ACTIVE        | SOIC         | D                  | 14   | 50             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074C                  | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TL074CDBR        | ACTIVE        | SSOP         | DB                 | 14   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | T074                    | <a href="#">Samples</a> |
| TL074CDG4        | ACTIVE        | SOIC         | D                  | 14   | 50             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074C                  | <a href="#">Samples</a> |
| TL074CDR         | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green    | NIPDAU   SN                          | Level-1-260C-UNLIM   | 0 to 70      | TL074C                  | <a href="#">Samples</a> |
| TL074CDRG4       | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074C                  | <a href="#">Samples</a> |
| TL074CN          | ACTIVE        | PDIP         | N                  | 14   | 25             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL074CN                 | <a href="#">Samples</a> |
| TL074CNE4        | ACTIVE        | PDIP         | N                  | 14   | 25             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | TL074CN                 | <a href="#">Samples</a> |
| TL074CNSR        | ACTIVE        | SO           | NS                 | 14   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | TL074                   | <a href="#">Samples</a> |
| TL074CPW         | ACTIVE        | TSSOP        | PW                 | 14   | 90             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | T074                    | <a href="#">Samples</a> |
| TL074CPWR        | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | T074                    | <a href="#">Samples</a> |
| TL074CPWRE4      | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | T074                    | <a href="#">Samples</a> |
| TL074CPWRG4      | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | T074                    | <a href="#">Samples</a> |
| TL074HIDR        | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | TL074HID                | <a href="#">Samples</a> |
| TL074HIDYYR      | ACTIVE        | SOT-23-THIN  | DYY                | 14   | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | T074HDYY                | <a href="#">Samples</a> |
| TL074HIPWR       | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | TL074PW                 | <a href="#">Samples</a> |
| TL074ID          | ACTIVE        | SOIC         | D                  | 14   | 50             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL074I                  | <a href="#">Samples</a> |
| TL074IDE4        | ACTIVE        | SOIC         | D                  | 14   | 50             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL074I                  | <a href="#">Samples</a> |
| TL074IDG4        | ACTIVE        | SOIC         | D                  | 14   | 50             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL074I                  | <a href="#">Samples</a> |
| TL074IDR         | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL074I                  | <a href="#">Samples</a> |
| TL074IDRE4       | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL074I                  | <a href="#">Samples</a> |
| TL074IDRG4       | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | TL074I                  | <a href="#">Samples</a> |
| TL074IN          | ACTIVE        | PDIP         | N                  | 14   | 25             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | -40 to 85    | TL074IN                 | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TL074MFK         | ACTIVE        | LCCC         | FK                 | 20   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | TL074MFK                | <a href="#">Samples</a> |
| TL074MFKB        | ACTIVE        | LCCC         | FK                 | 20   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 81023062A<br>TL074MFKB  | <a href="#">Samples</a> |
| TL074MJ          | ACTIVE        | CDIP         | J                  | 14   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | TL074MJ                 | <a href="#">Samples</a> |
| TL074MJB         | ACTIVE        | CDIP         | J                  | 14   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 8102306CA<br>TL074MJB   | <a href="#">Samples</a> |
| TL074MWB         | ACTIVE        | CFP          | W                  | 14   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 8102306DA<br>TL074MWB   | <a href="#">Samples</a> |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

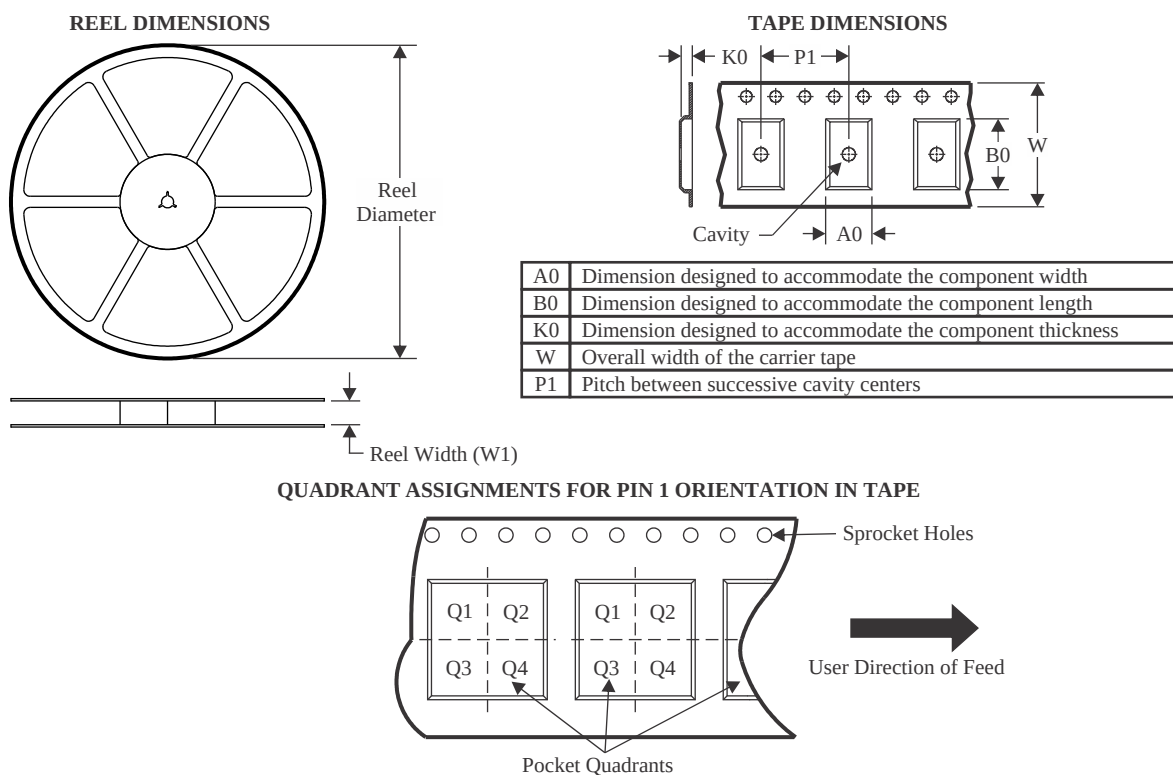
**OTHER QUALIFIED VERSIONS OF TL072, TL072M, TL074, TL074M :**

- Catalog : [TL072](#), [TL074](#)
- Enhanced Product : [TL072-EP](#), [TL072-EP](#), [TL074-EP](#), [TL074-EP](#)
- Military : [TL072M](#), [TL074M](#)

**NOTE:** Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications
- Military - QML certified for Military and Defense Applications

## TAPE AND REEL INFORMATION

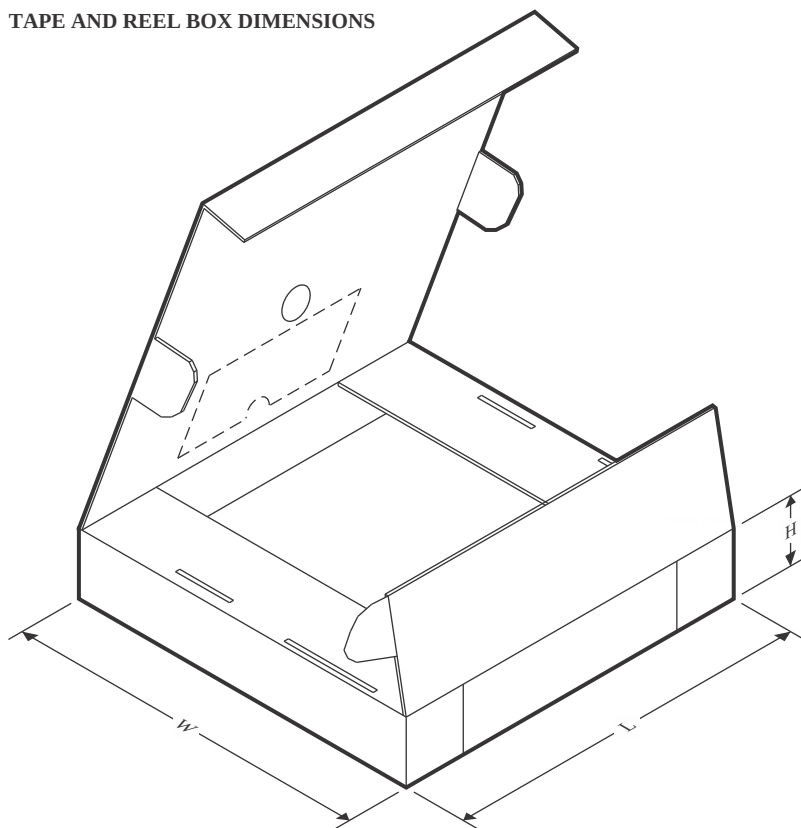


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TL071ACDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL071BCDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL071CDR    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL071CDR    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL071CPSR   | SO           | PS              | 8    | 2000 | 330.0              | 16.4               | 8.35    | 6.6     | 2.4     | 12.0    | 16.0   | Q1            |
| TL071HIDBVR | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TL071HIDCKR | SC70         | DCK             | 5    | 3000 | 178.0              | 9.0                | 2.4     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| TL071HIDR   | SOIC         | D               | 8    | 3000 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL071IDR    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL072ACDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL072BCDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL072CDR    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL072CDR    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL072CPSR   | SO           | PS              | 8    | 2000 | 330.0              | 16.4               | 8.35    | 6.6     | 2.4     | 12.0    | 16.0   | Q1            |
| TL072CPWR   | TSSOP        | PW              | 8    | 2000 | 330.0              | 12.4               | 7.0     | 3.6     | 1.6     | 8.0     | 12.0   | Q1            |

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TL072HIDDFR | SOT-23-THIN  | DDF             | 8    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TL072HIDR   | SOIC         | D               | 8    | 3000 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL072HIPWR  | TSSOP        | PW              | 8    | 3000 | 330.0              | 12.4               | 7.0     | 3.6     | 1.6     | 8.0     | 12.0   | Q1            |
| TL072IDR    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL072IDR    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL074ACDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TL074ACNSR  | SO           | NS              | 14   | 2000 | 330.0              | 16.4               | 8.2     | 10.5    | 2.5     | 12.0    | 16.0   | Q1            |
| TL074BCDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TL074CDBR   | SSOP         | DB              | 14   | 2000 | 330.0              | 16.4               | 8.35    | 6.6     | 2.4     | 12.0    | 16.0   | Q1            |
| TL074CDR    | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TL074CDRG4  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TL074CNSR   | SO           | NS              | 14   | 2000 | 330.0              | 16.4               | 8.2     | 10.5    | 2.5     | 12.0    | 16.0   | Q1            |
| TL074CPWR   | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| TL074HIDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TL074HIDYYR | SOT-23-THIN  | DYY             | 14   | 3000 | 330.0              | 12.4               | 4.8     | 3.6     | 1.6     | 8.0     | 12.0   | Q3            |
| TL074HIPWR  | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| TL074IDR    | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS

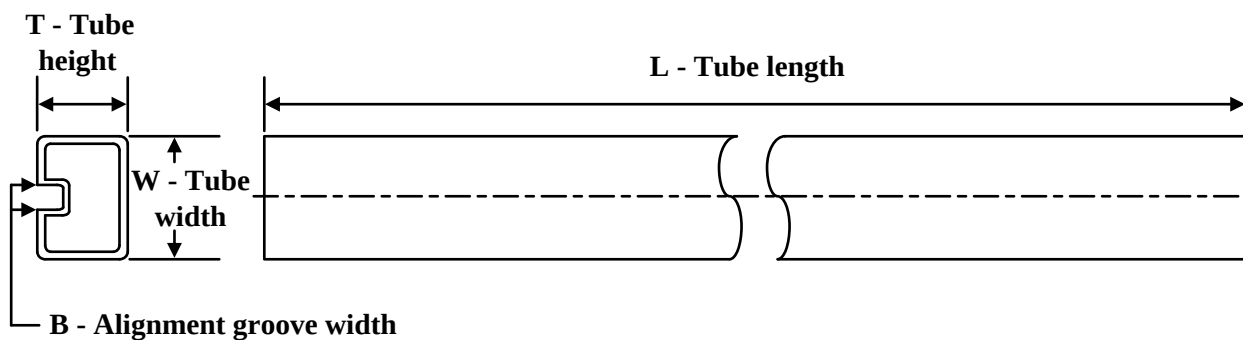


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TL071ACDR   | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| TL071BCDR   | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| TL071CDR    | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| TL071CDR    | SOIC         | D               | 8    | 2500 | 356.0       | 356.0      | 35.0        |
| TL071CPSR   | SO           | PS              | 8    | 2000 | 356.0       | 356.0      | 35.0        |
| TL071HIDBVR | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| TL071HIDCKR | SC70         | DCK             | 5    | 3000 | 190.0       | 190.0      | 30.0        |
| TL071HIDR   | SOIC         | D               | 8    | 3000 | 356.0       | 356.0      | 35.0        |
| TL071IDR    | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| TL072ACDR   | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| TL072BCDR   | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| TL072CDR    | SOIC         | D               | 8    | 2500 | 356.0       | 356.0      | 35.0        |
| TL072CDR    | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| TL072CPSR   | SO           | PS              | 8    | 2000 | 356.0       | 356.0      | 35.0        |
| TL072CPWR   | TSSOP        | PW              | 8    | 2000 | 356.0       | 356.0      | 35.0        |
| TL072HIDDFR | SOT-23-THIN  | DDF             | 8    | 3000 | 210.0       | 185.0      | 35.0        |
| TL072HIDR   | SOIC         | D               | 8    | 3000 | 356.0       | 356.0      | 35.0        |
| TL072HIPWR  | TSSOP        | PW              | 8    | 3000 | 356.0       | 356.0      | 35.0        |

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TL072IDR    | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| TL072IDR    | SOIC         | D               | 8    | 2500 | 356.0       | 356.0      | 35.0        |
| TL074ACDR   | SOIC         | D               | 14   | 2500 | 340.5       | 336.1      | 32.0        |
| TL074ACNSR  | SO           | NS              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| TL074BCDR   | SOIC         | D               | 14   | 2500 | 340.5       | 336.1      | 32.0        |
| TL074CDBR   | SSOP         | DB              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| TL074CDR    | SOIC         | D               | 14   | 2500 | 340.5       | 336.1      | 32.0        |
| TL074CDRG4  | SOIC         | D               | 14   | 2500 | 340.5       | 336.1      | 32.0        |
| TL074CNSR   | SO           | NS              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| TL074CPWR   | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| TL074HIDR   | SOIC         | D               | 14   | 2500 | 356.0       | 356.0      | 35.0        |
| TL074HIDYYR | SOT-23-THIN  | DYY             | 14   | 3000 | 336.6       | 336.6      | 31.8        |
| TL074HIPWR  | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| TL074IDR    | SOIC         | D               | 14   | 2500 | 340.5       | 336.1      | 32.0        |



**TUBE**


\*All dimensions are nominal

| Device     | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 81023052A  | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |
| 8102305HA  | U            | CFP          | 10   | 1   | 506.98 | 26.16  | 6220   | NA     |
| 81023062A  | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |
| 8102306DA  | W            | CFP          | 14   | 1   | 506.98 | 26.16  | 6220   | NA     |
| TL071ACD   | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL071ACDG4 | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL071ACP   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL071BCD   | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL071BCP   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL071CD    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| TL071CD    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL071CP    | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL071CPE4  | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL071ID    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL071IP    | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL072ACD   | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL072ACDE4 | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL072ACP   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL072ACPE4 | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL072BCD   | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL072BCDE4 | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL072BCDG4 | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL072BCP   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL072CD    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL072CD    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| TL072CDE4  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| TL072CDE4  | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL072CDG4  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| TL072CDG4  | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |

| Device     | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TL072CP    | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL072CPE4  | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL072CPS   | PS           | SOP          | 8    | 80  | 530    | 10.5   | 4000   | 4.1    |
| TL072ID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| TL072ID    | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL072IDE4  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| TL072IDE4  | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL072IDG4  | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TL072IDG4  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| TL072IP    | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL072IPE4  | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL072MFKB  | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |
| TL072MUB   | U            | CFP          | 10   | 1   | 506.98 | 26.16  | 6220   | NA     |
| TL074ACD   | D            | SOIC         | 14   | 50  | 507    | 8      | 3940   | 4.32   |
| TL074ACDE4 | D            | SOIC         | 14   | 50  | 507    | 8      | 3940   | 4.32   |
| TL074ACN   | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TL074ACNE4 | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TL074BCD   | D            | SOIC         | 14   | 50  | 507    | 8      | 3940   | 4.32   |
| TL074BCDE4 | D            | SOIC         | 14   | 50  | 507    | 8      | 3940   | 4.32   |
| TL074BCN   | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TL074BCNE4 | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TL074CD    | D            | SOIC         | 14   | 50  | 507    | 8      | 3940   | 4.32   |
| TL074CDG4  | D            | SOIC         | 14   | 50  | 507    | 8      | 3940   | 4.32   |
| TL074CN    | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TL074CN    | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TL074CNE4  | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TL074CNE4  | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TL074CPW   | PW           | TSSOP        | 14   | 90  | 530    | 10.2   | 3600   | 3.5    |
| TL074ID    | D            | SOIC         | 14   | 50  | 507    | 8      | 3940   | 4.32   |
| TL074IDE4  | D            | SOIC         | 14   | 50  | 507    | 8      | 3940   | 4.32   |
| TL074IDG4  | D            | SOIC         | 14   | 50  | 507    | 8      | 3940   | 4.32   |
| TL074IN    | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TL074MFK   | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |
| TL074MFKB  | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |
| TL074MWB   | W            | CFP          | 14   | 1   | 506.98 | 26.16  | 6220   | NA     |

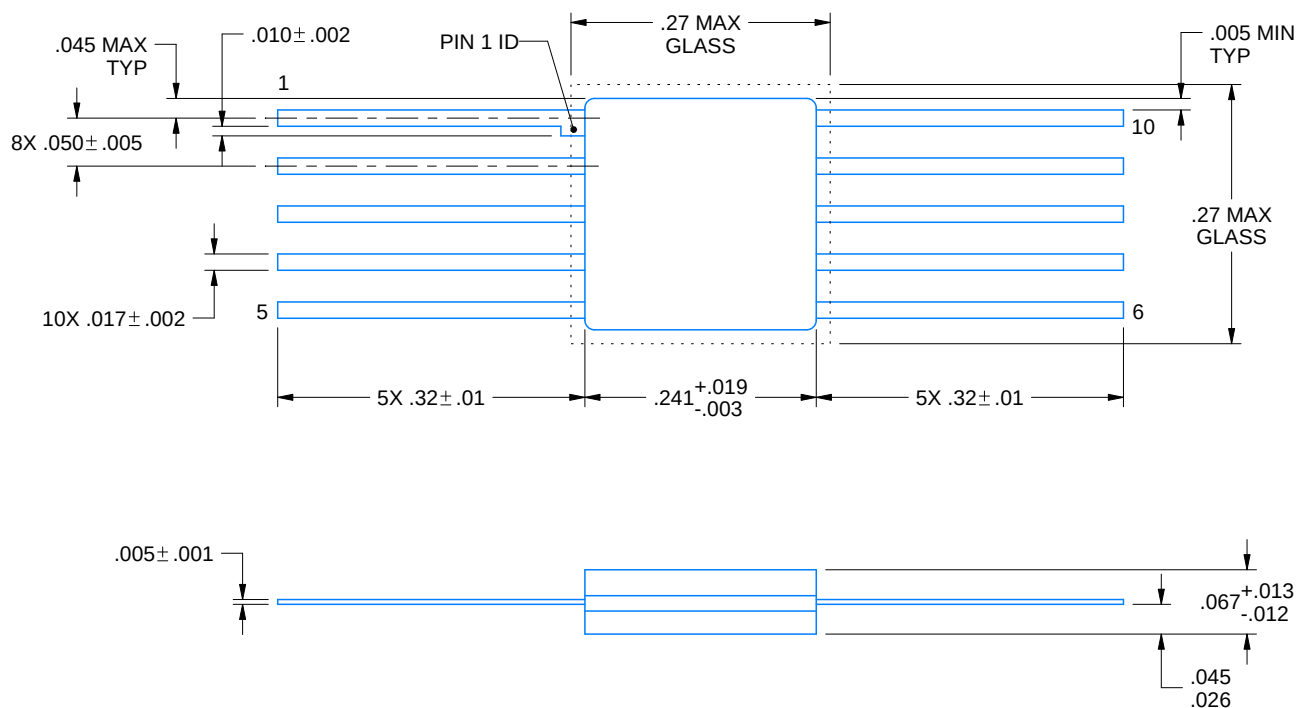
U0010A



## PACKAGE OUTLINE

CFP - 2.03 mm max height

CERAMIC FLATPACK



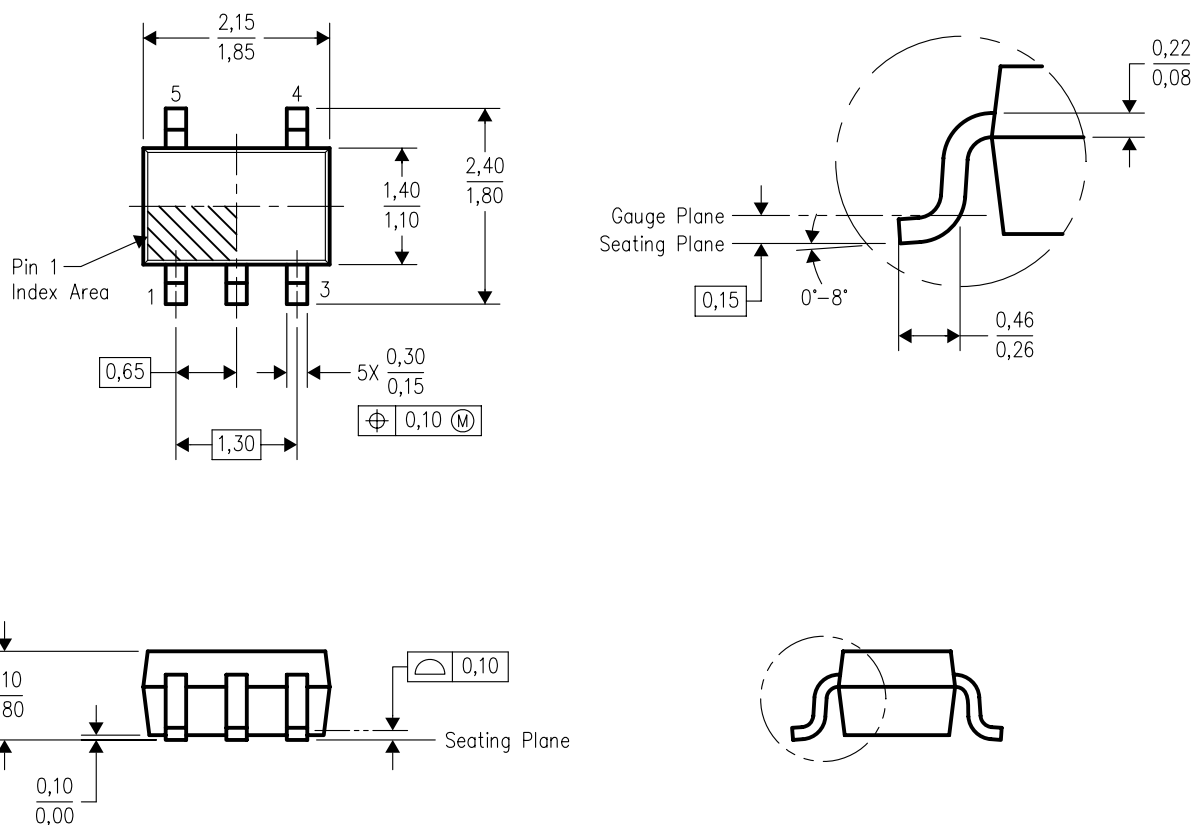
4225582/A 01/2020

### NOTES:

1. All linear dimensions are in inches. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

## DCK (R-PDSO-G5)

## PLASTIC SMALL-OUTLINE PACKAGE

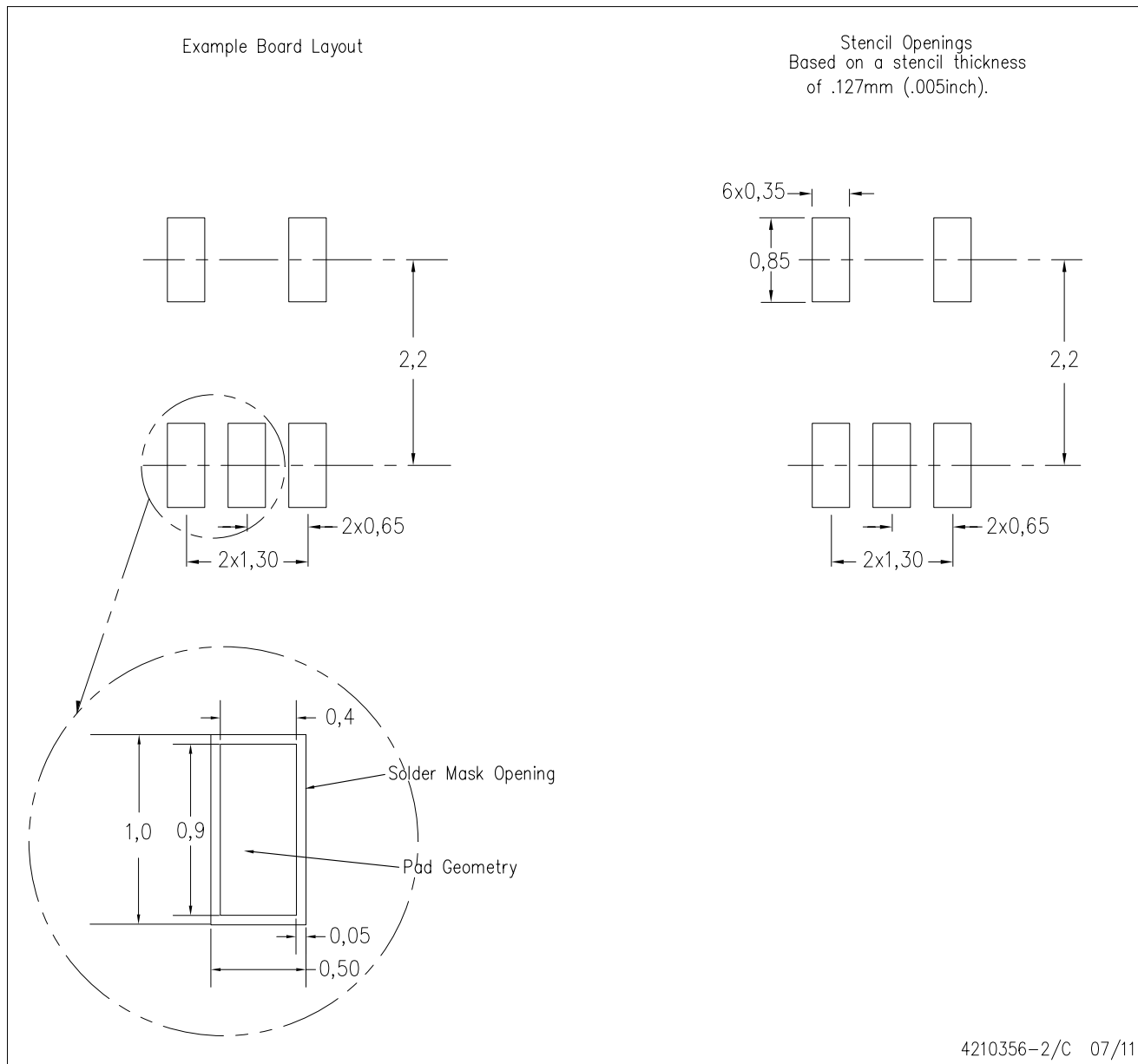


4093553-3/G 01/2007

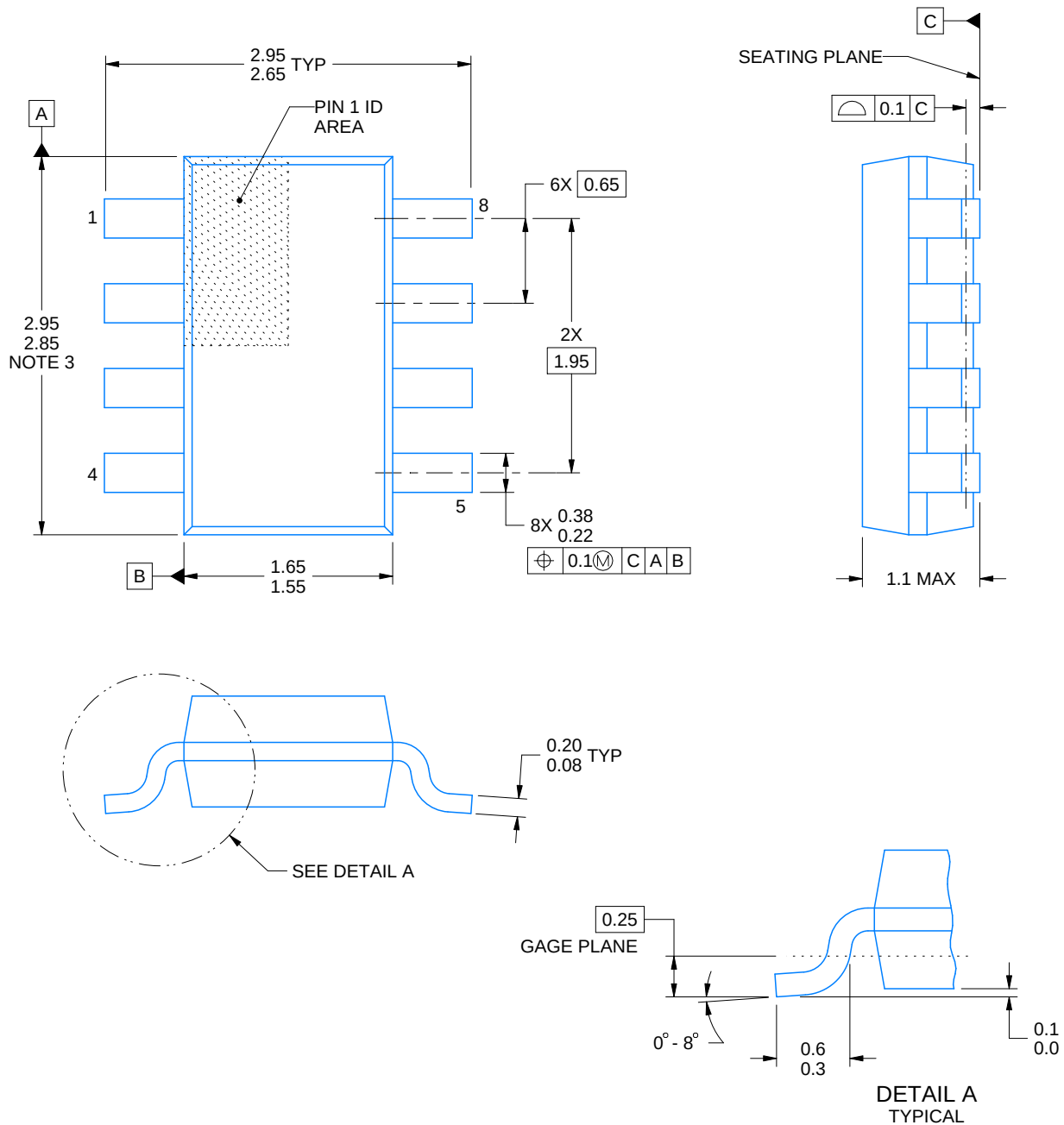
- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - Falls within JEDEC MO-203 variation AA.

DCK (R-PDSO-G5)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
  - D. Publication IPC-7351 is recommended for alternate designs.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



4222047/C 10/2022

## NOTES:

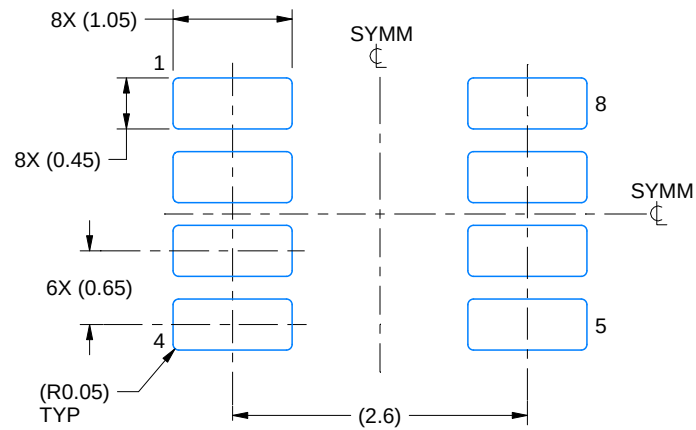
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.

# EXAMPLE BOARD LAYOUT

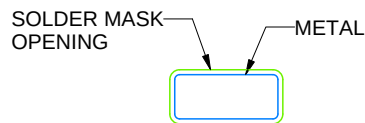
DDF0008A

SOT-23 - 1.1 mm max height

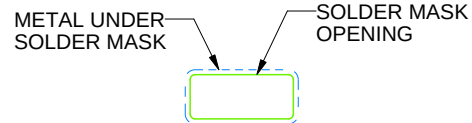
PLASTIC SMALL OUTLINE



LAND PATTERN EXAMPLE  
SCALE:15X



NON SOLDER MASK  
DEFINED



SOLDER MASK  
DEFINED

SOLDER MASK DETAILS

4222047/C 10/2022

NOTES: (continued)

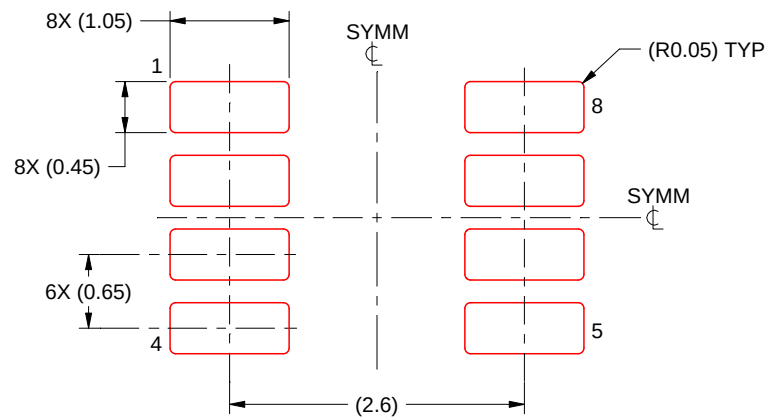
4. Publication IPC-7351 may have alternate designs.
5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DDF0008A

SOT-23 - 1.1 mm max height

PLASTIC SMALL OUTLINE



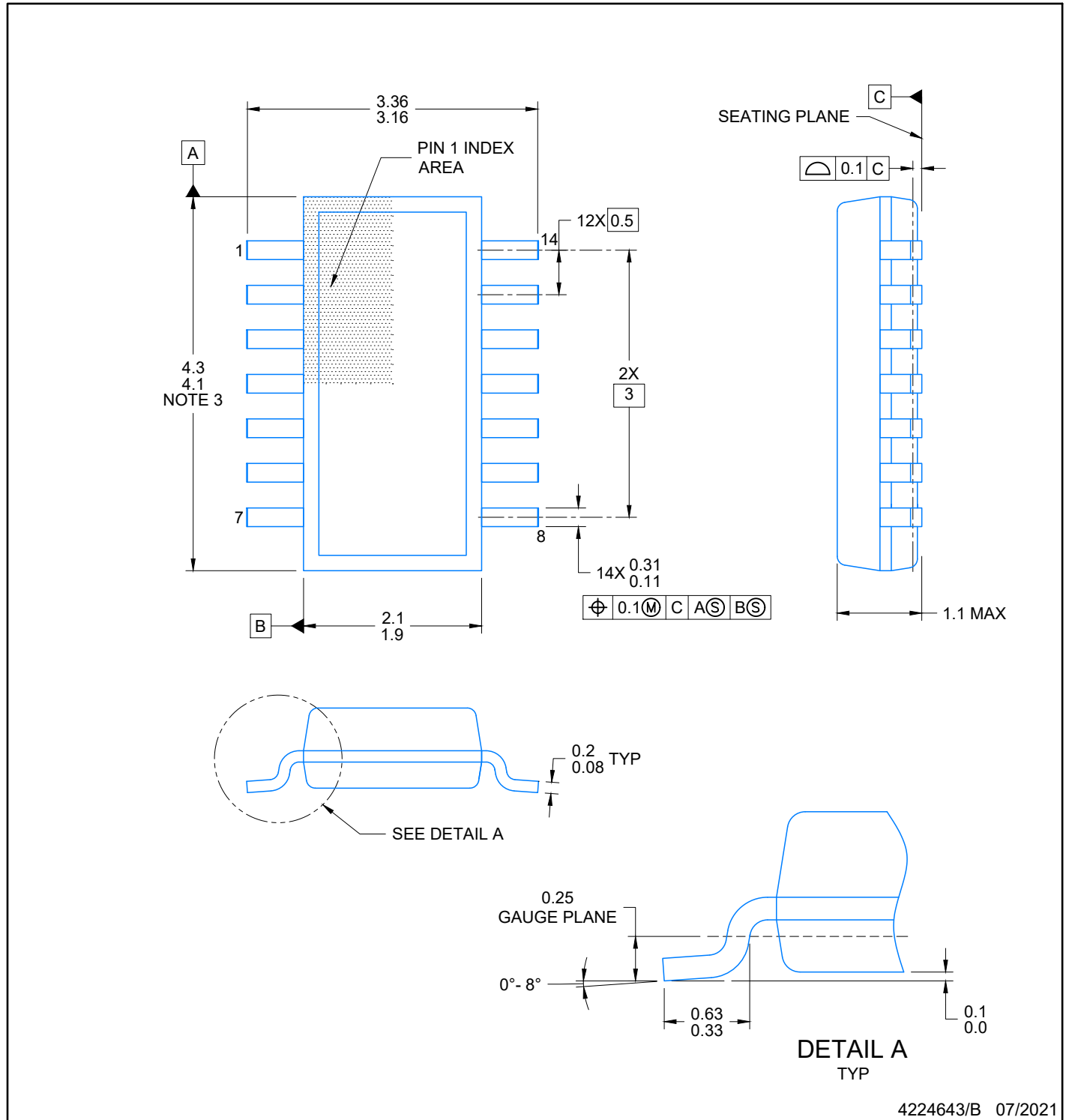
SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4222047/C 10/2022

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
7. Board assembly site may have different recommendations for stencil design.

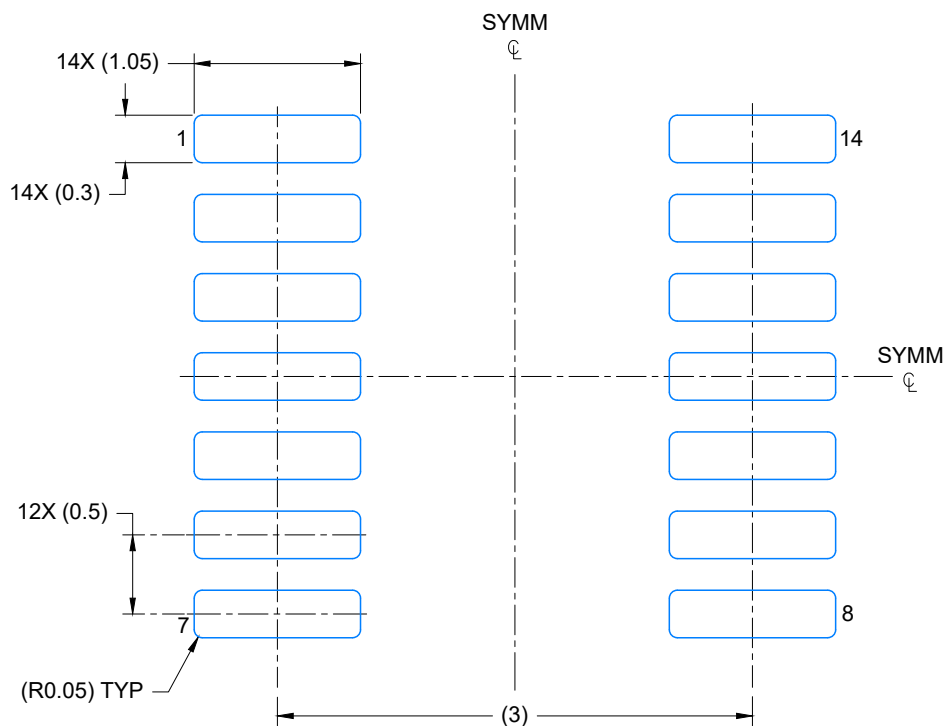




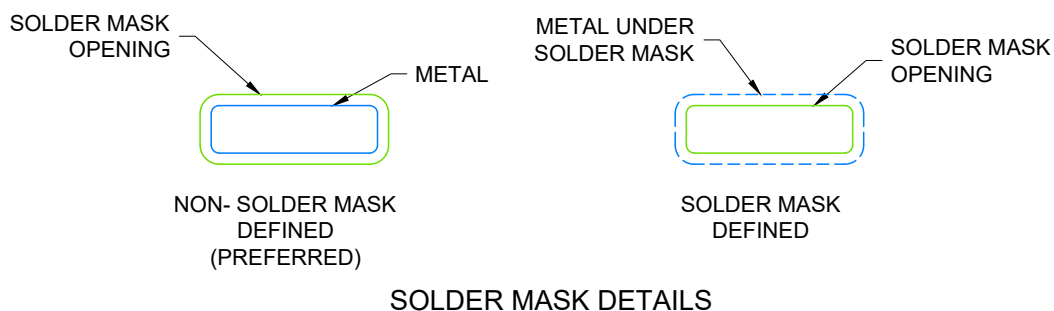
4224643/B 07/2021

#### NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
5. Reference JEDEC Registration MO-345, Variation AB



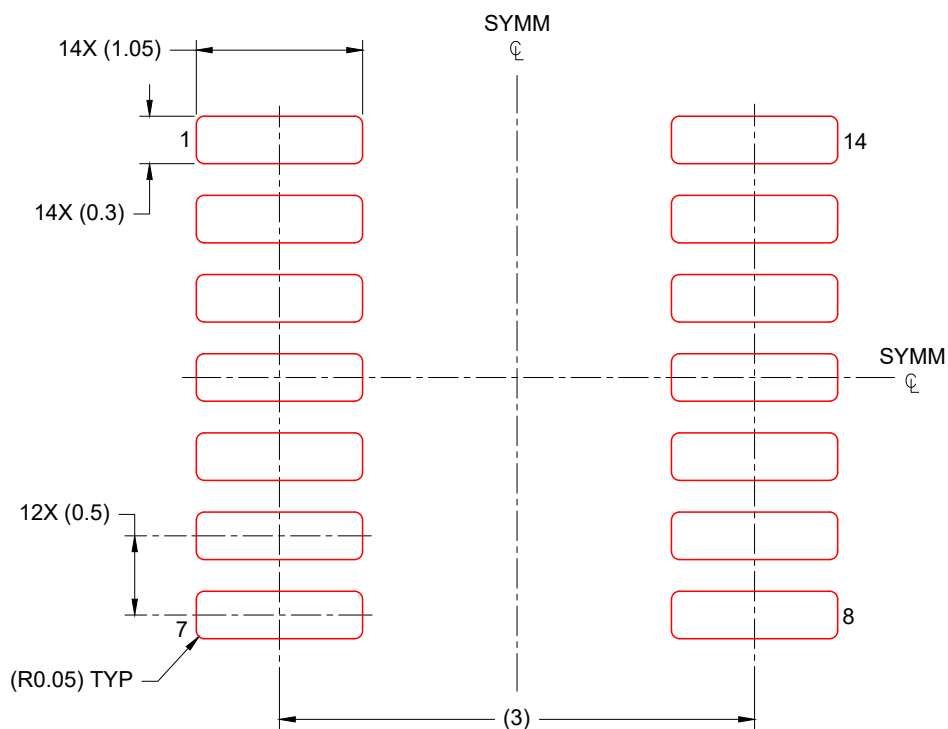
LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 20X



4224643/B 07/2021

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 20X

4224643/B 07/2021

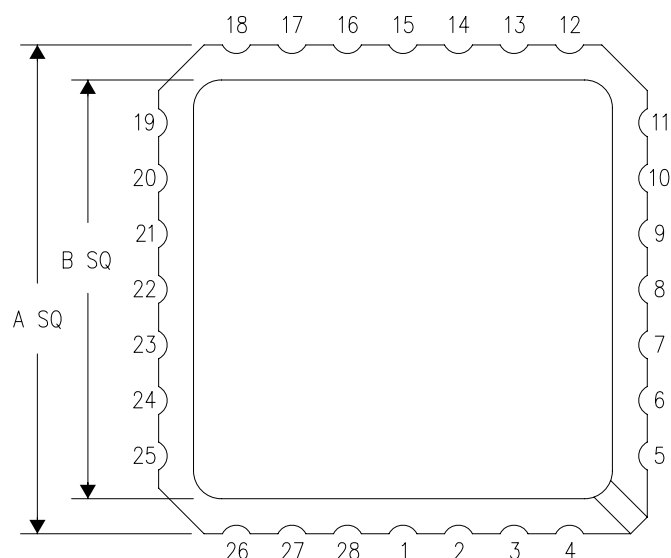
## NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

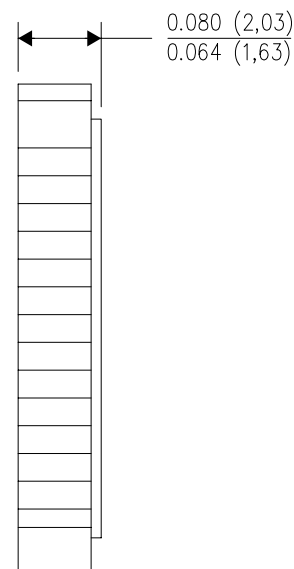
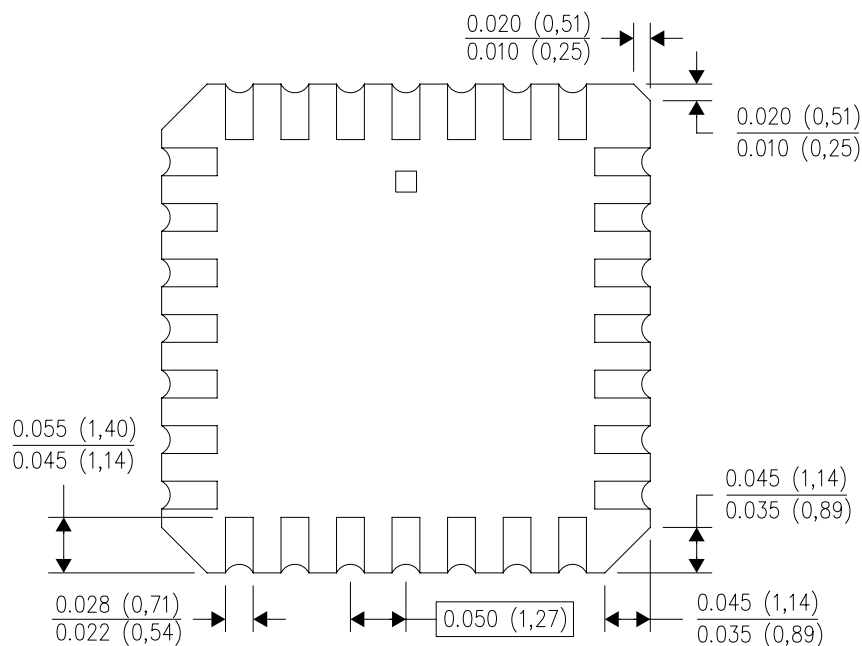
FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



| NO. OF<br>TERMINALS<br>** | A                |                  | B                |                  |
|---------------------------|------------------|------------------|------------------|------------------|
|                           | MIN              | MAX              | MIN              | MAX              |
| 20                        | 0.342<br>(8,69)  | 0.358<br>(9,09)  | 0.307<br>(7,80)  | 0.358<br>(9,09)  |
| 28                        | 0.442<br>(11,23) | 0.458<br>(11,63) | 0.406<br>(10,31) | 0.458<br>(11,63) |
| 44                        | 0.640<br>(16,26) | 0.660<br>(16,76) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 52                        | 0.740<br>(18,78) | 0.761<br>(19,32) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 68                        | 0.938<br>(23,83) | 0.962<br>(24,43) | 0.850<br>(21,6)  | 0.858<br>(21,8)  |
| 84                        | 1.141<br>(28,99) | 1.165<br>(29,59) | 1.047<br>(26,6)  | 1.063<br>(27,0)  |



4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - Falls within JEDEC MS-004

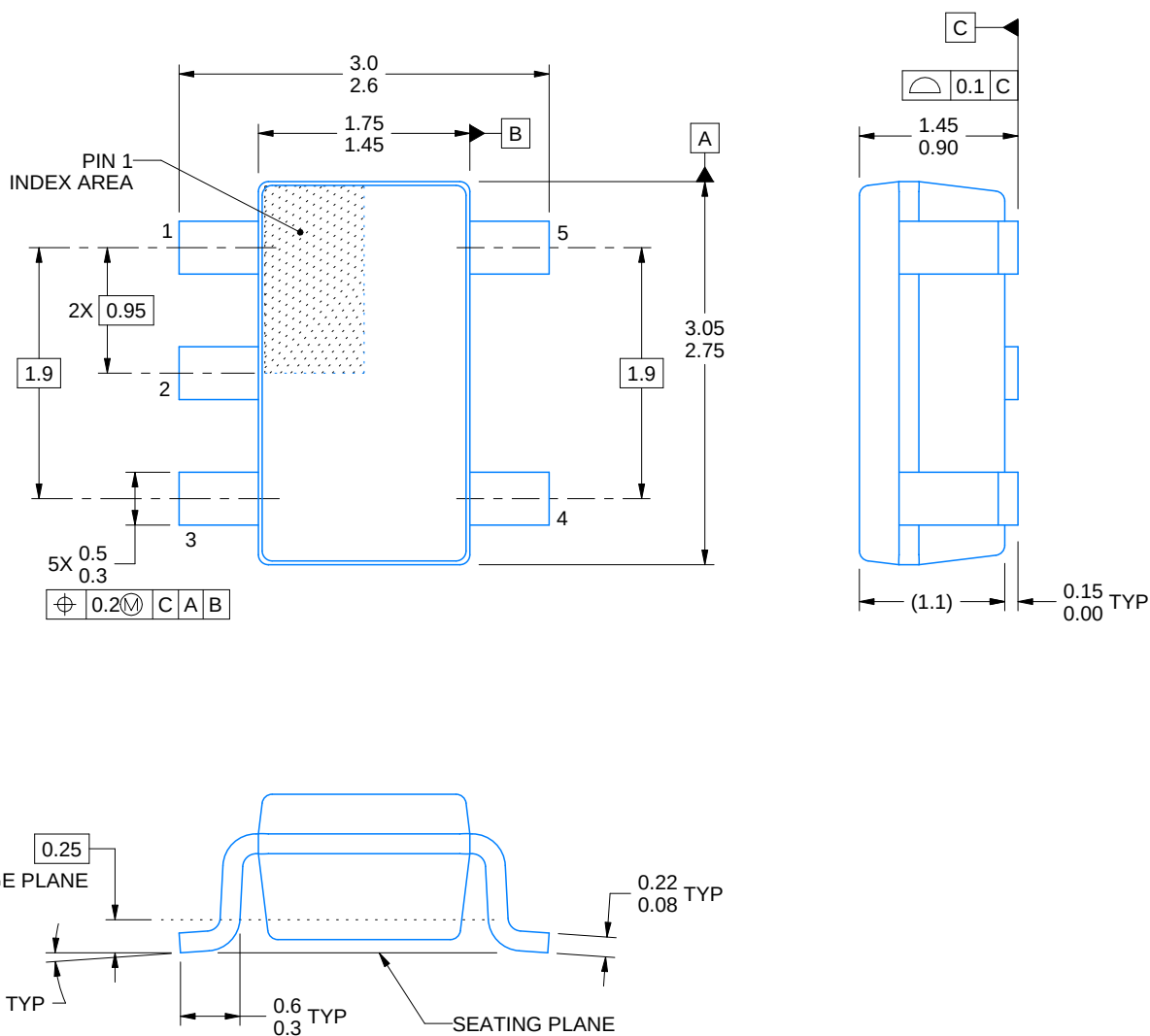


DBV0005A

# PACKAGE OUTLINE

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



4214839/F 06/2021

## NOTES:

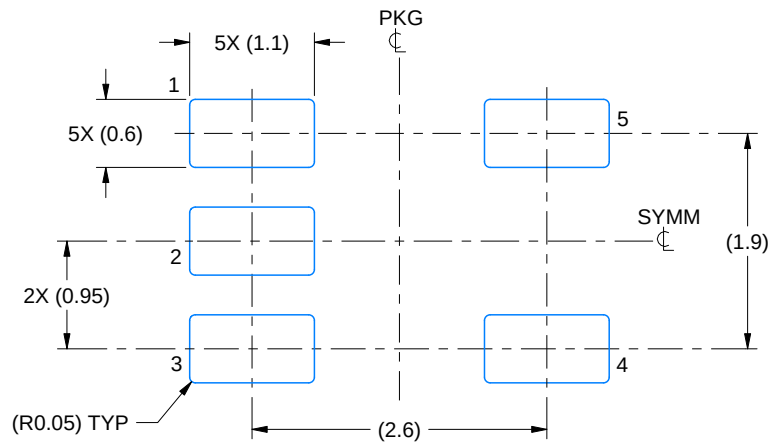
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.

# EXAMPLE BOARD LAYOUT

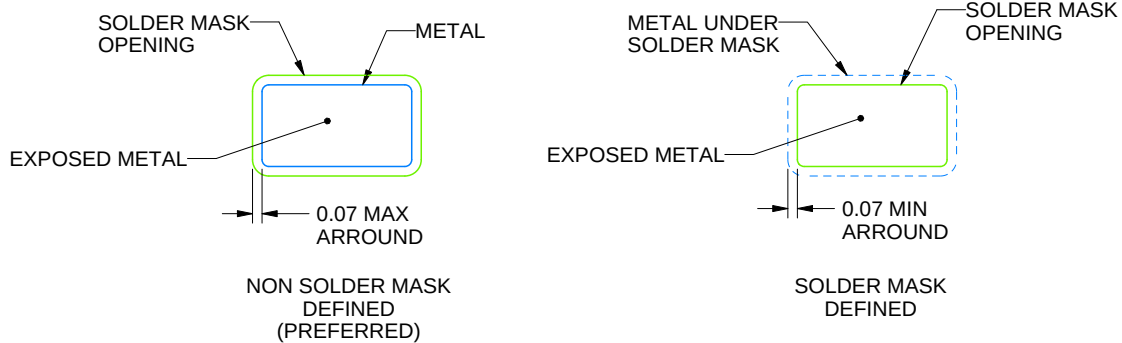
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/F 06/2021

NOTES: (continued)

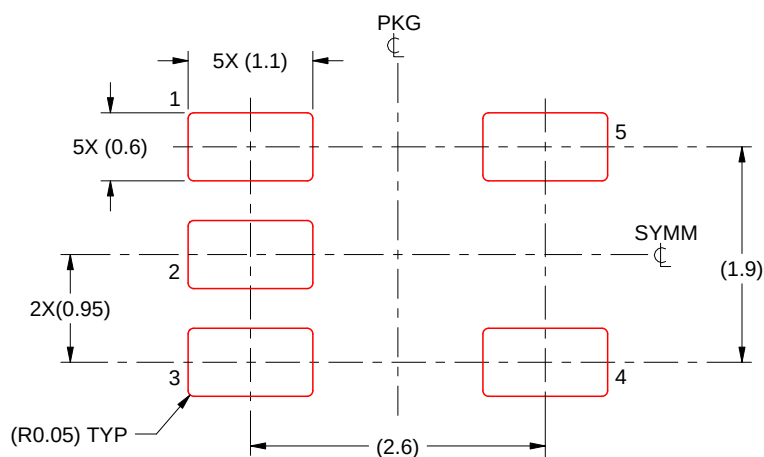
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4214839/F 06/2021

NOTES: (continued)

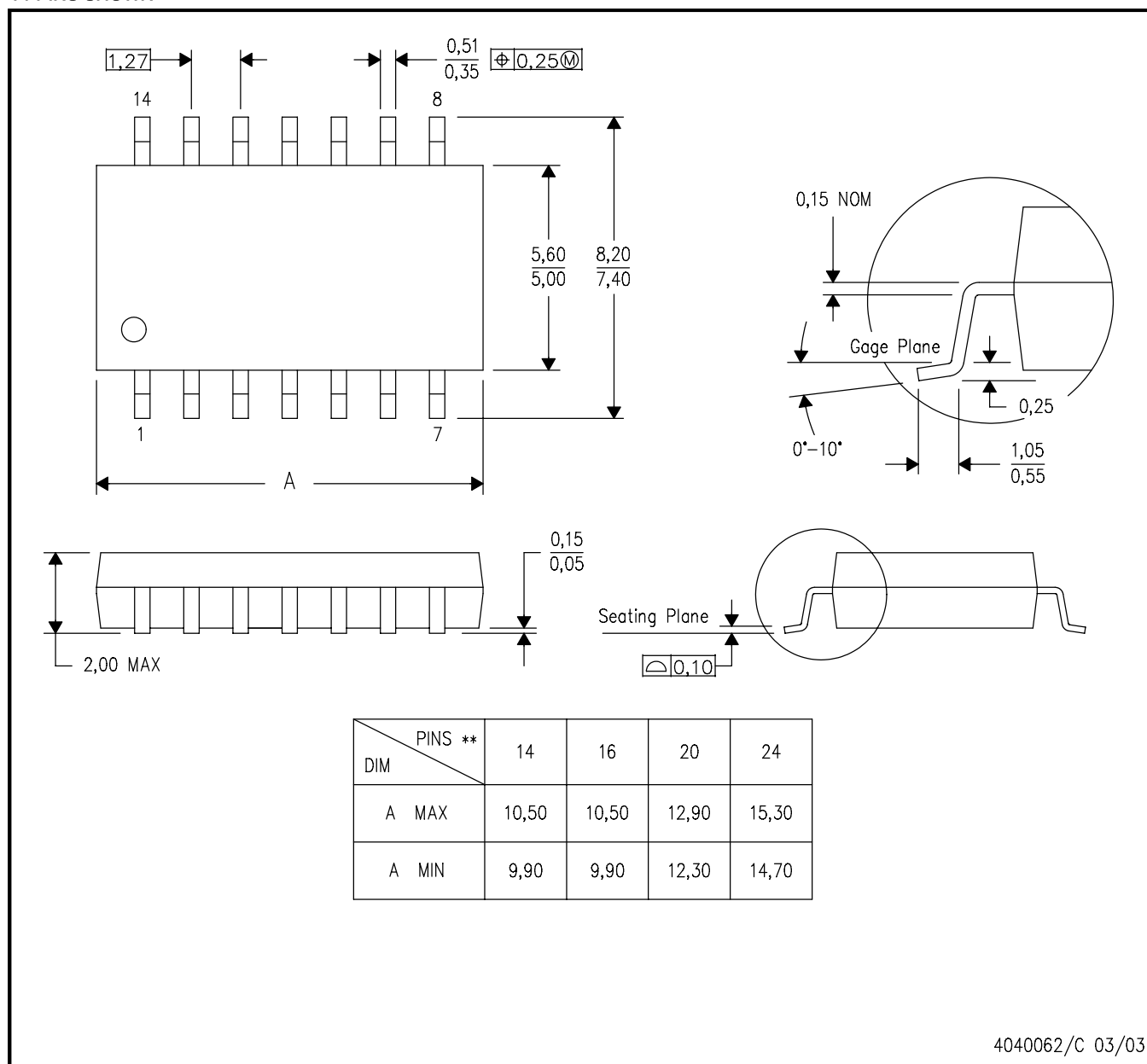
7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

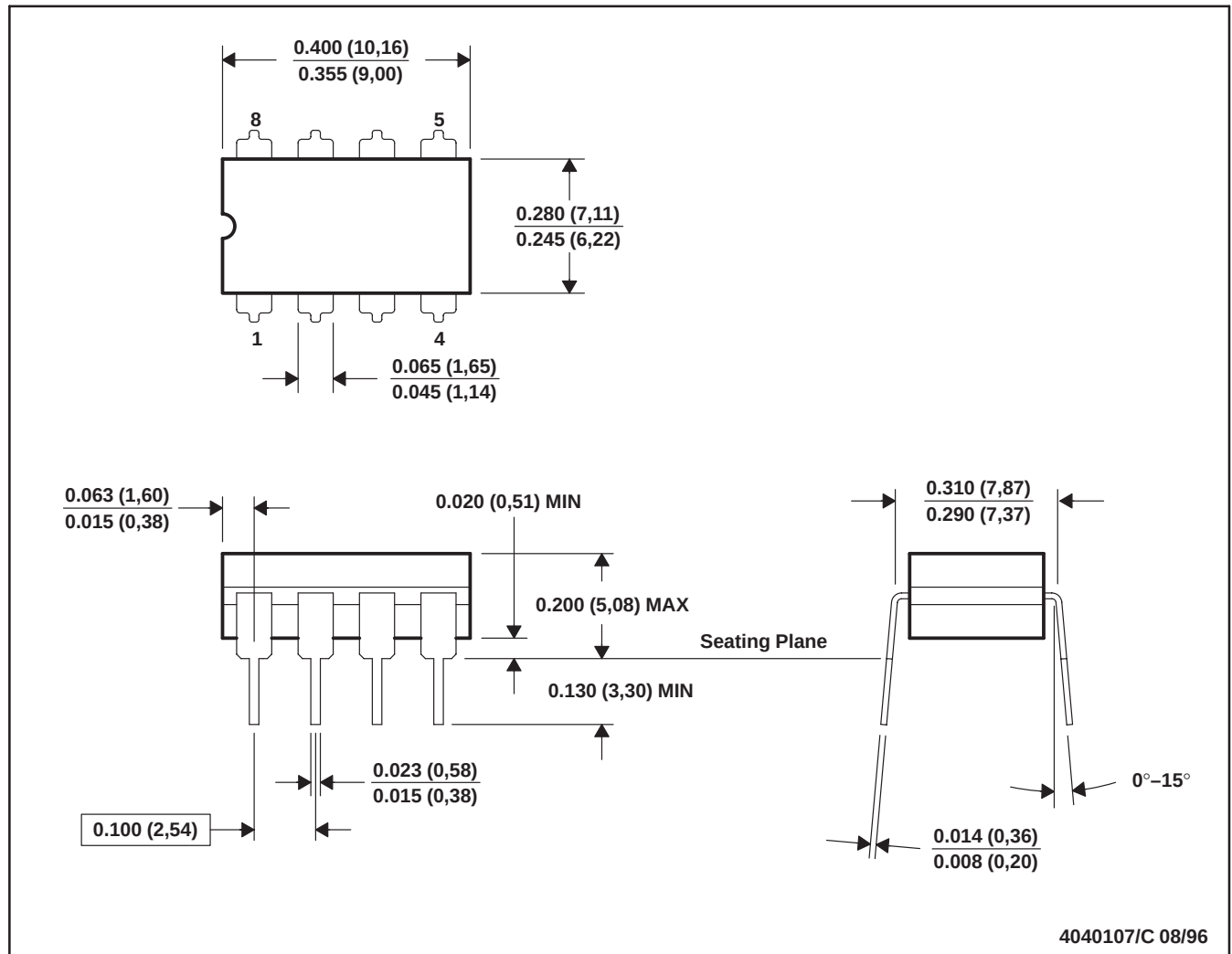


- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## JG (R-GDIP-T8)

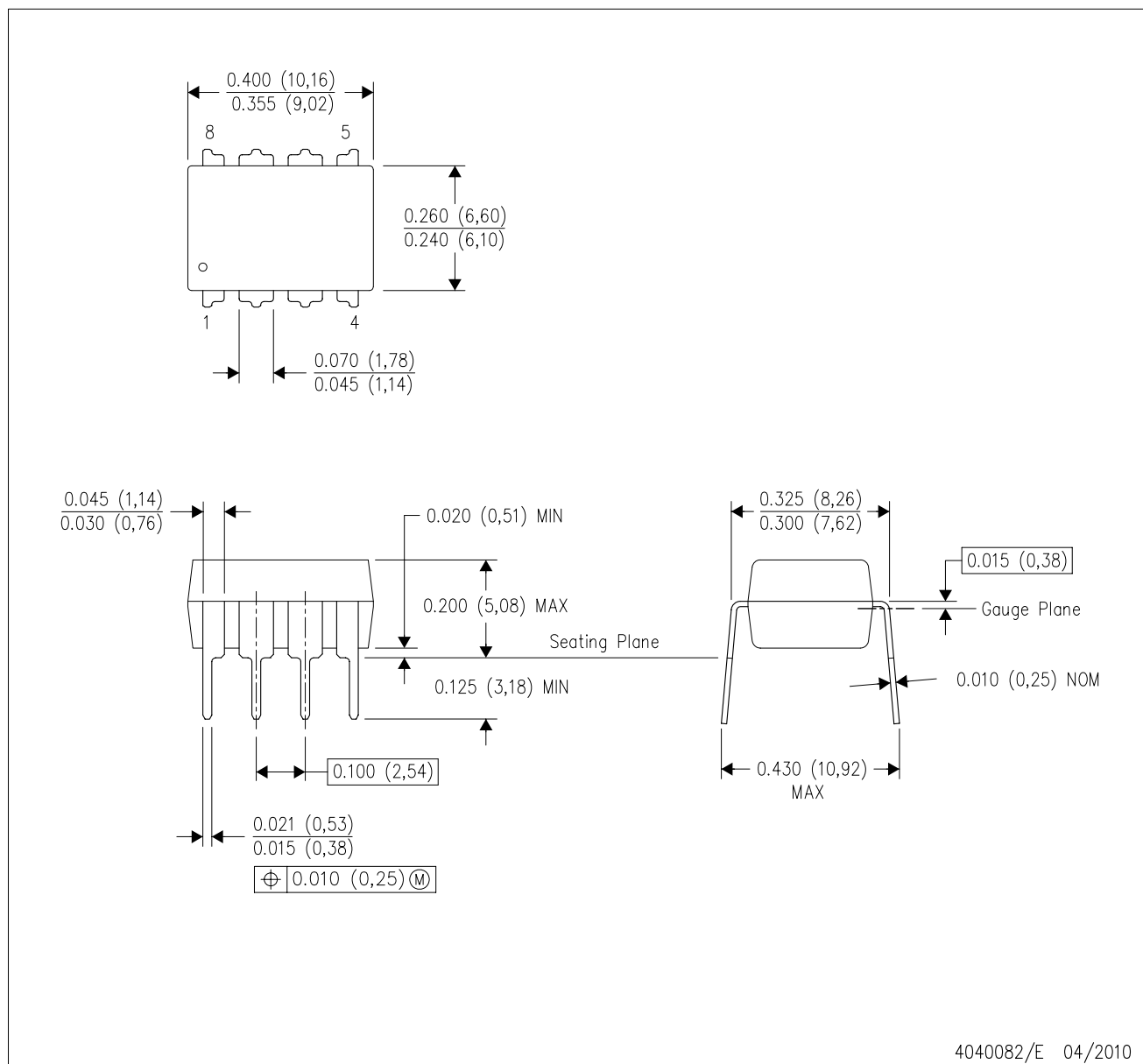
## CERAMIC DUAL-IN-LINE



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification.  
 E. Falls within MIL STD 1835 GDIP1-T8

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE

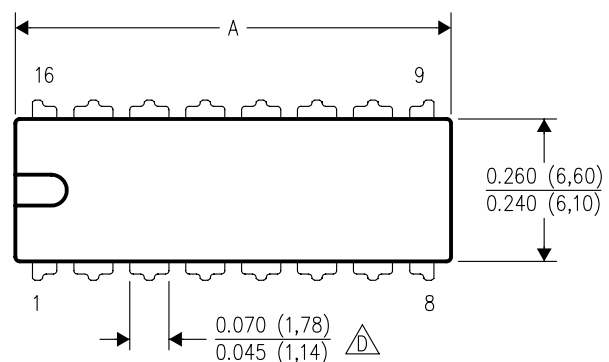


- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.

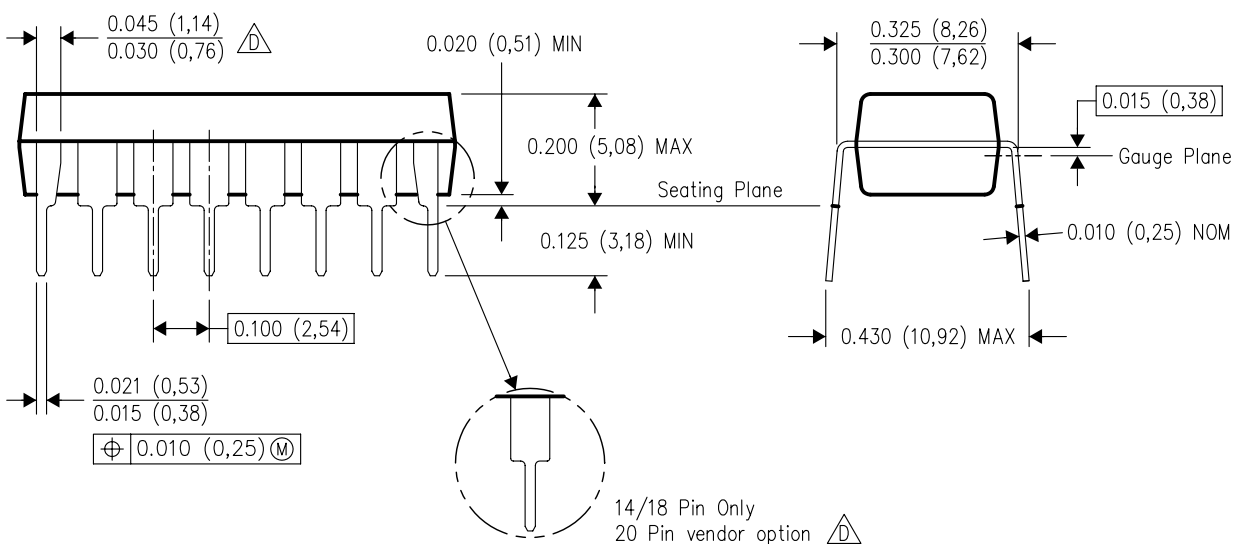
N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  -  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  -  The 20 pin end lead shoulder width is a vendor option, either half or full width.

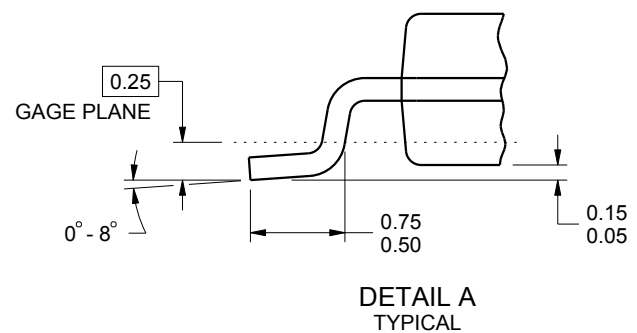
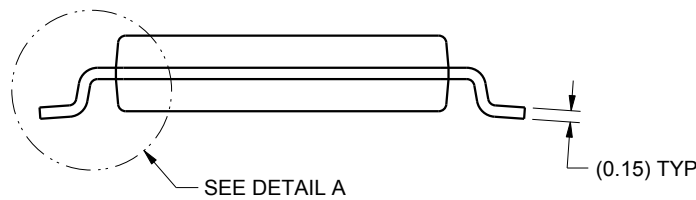
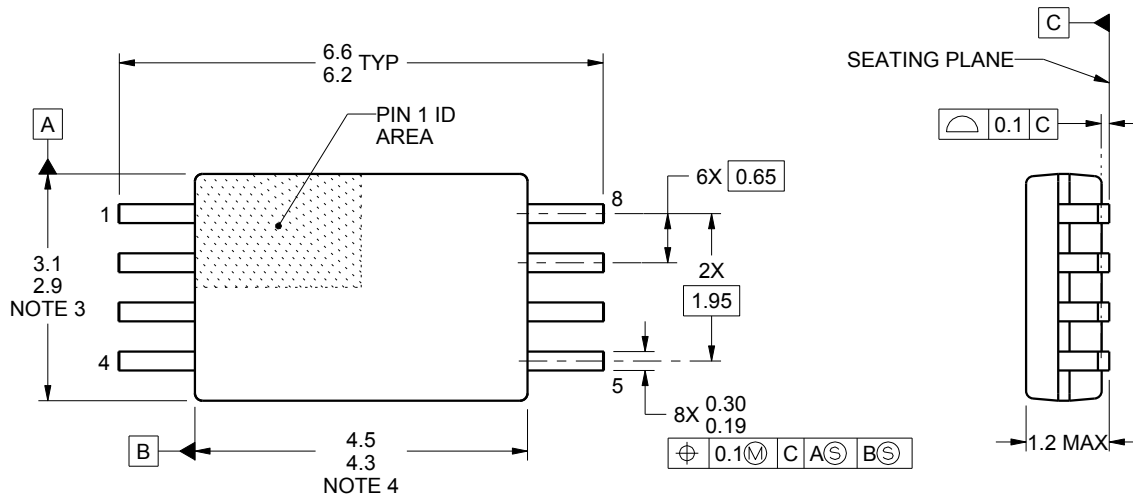
PW0008A



# PACKAGE OUTLINE

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



4221848/A 02/2015

### NOTES:

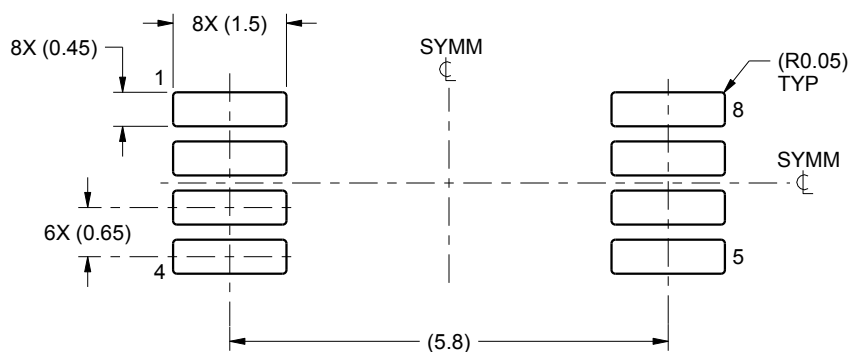
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153, variation AA.

# EXAMPLE BOARD LAYOUT

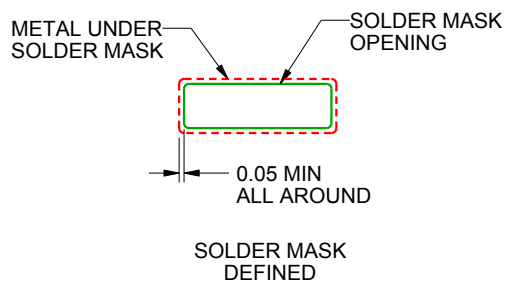
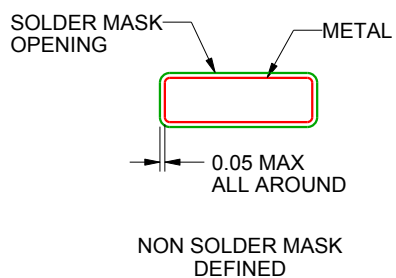
PW0008A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
SCALE:10X



SOLDER MASK DETAILS  
NOT TO SCALE

4221848/A 02/2015

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

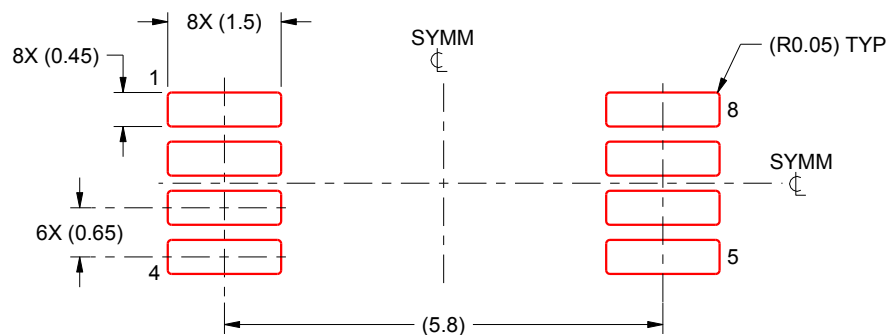
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

PW0008A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:10X

4221848/A 02/2015

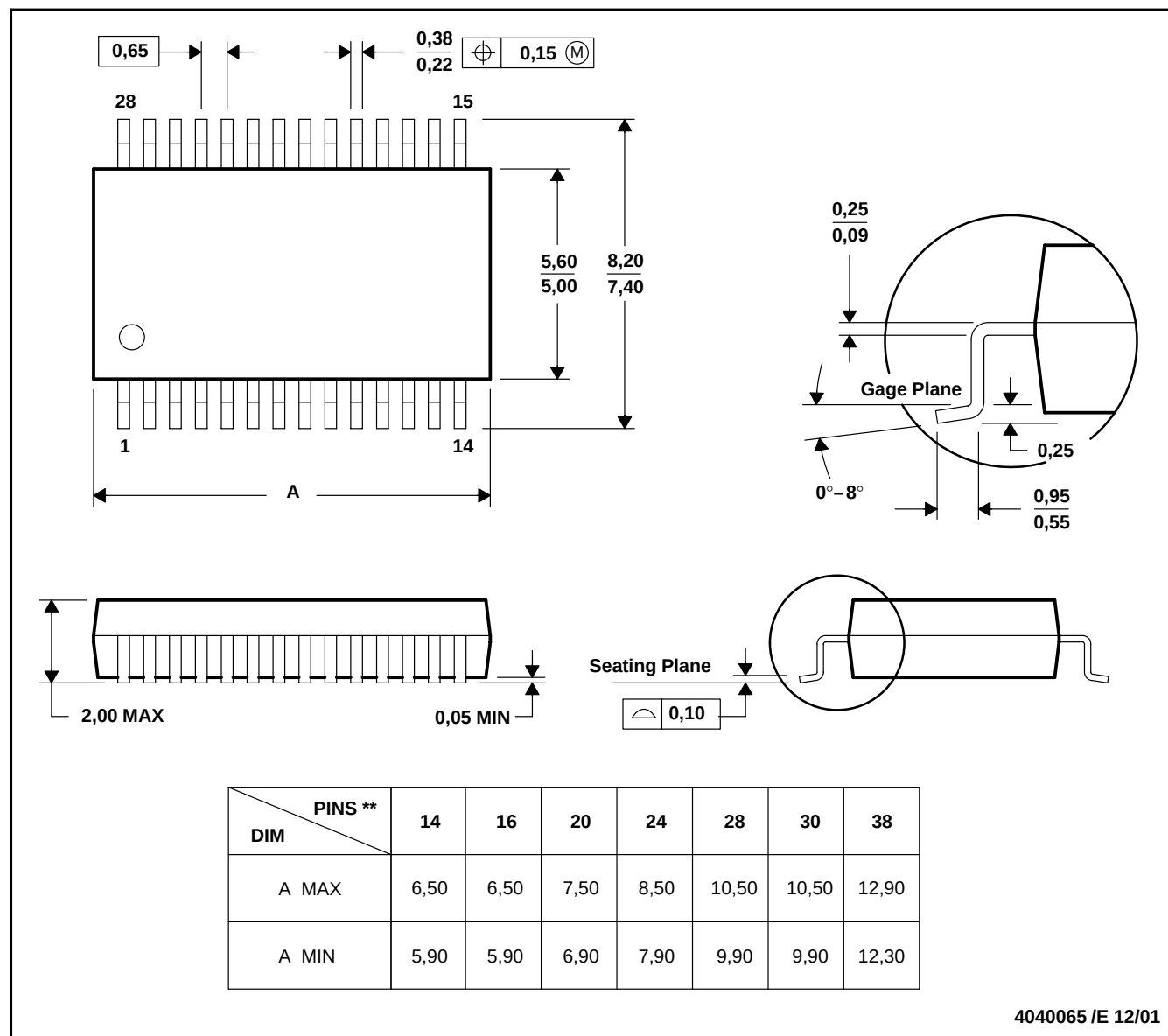
NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

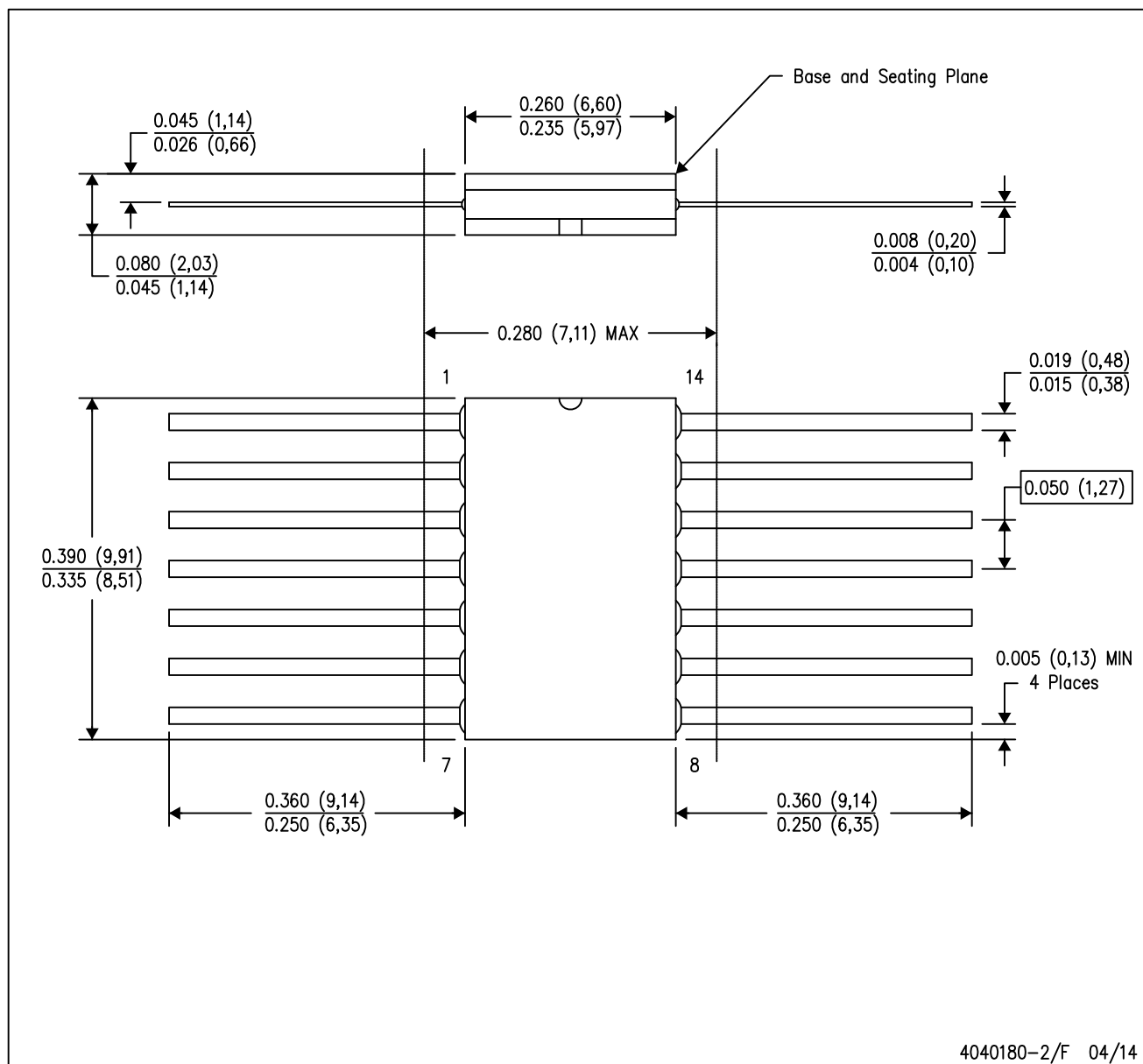
28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



## NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14

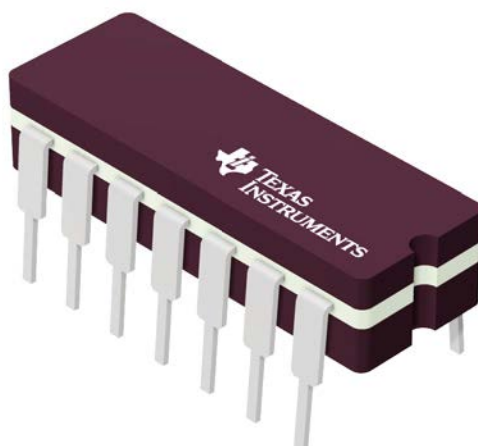


**J 14**

## GENERIC PACKAGE VIEW

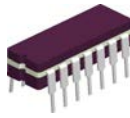
**CDIP - 5.08 mm max height**

CERAMIC DUAL IN LINE PACKAGE

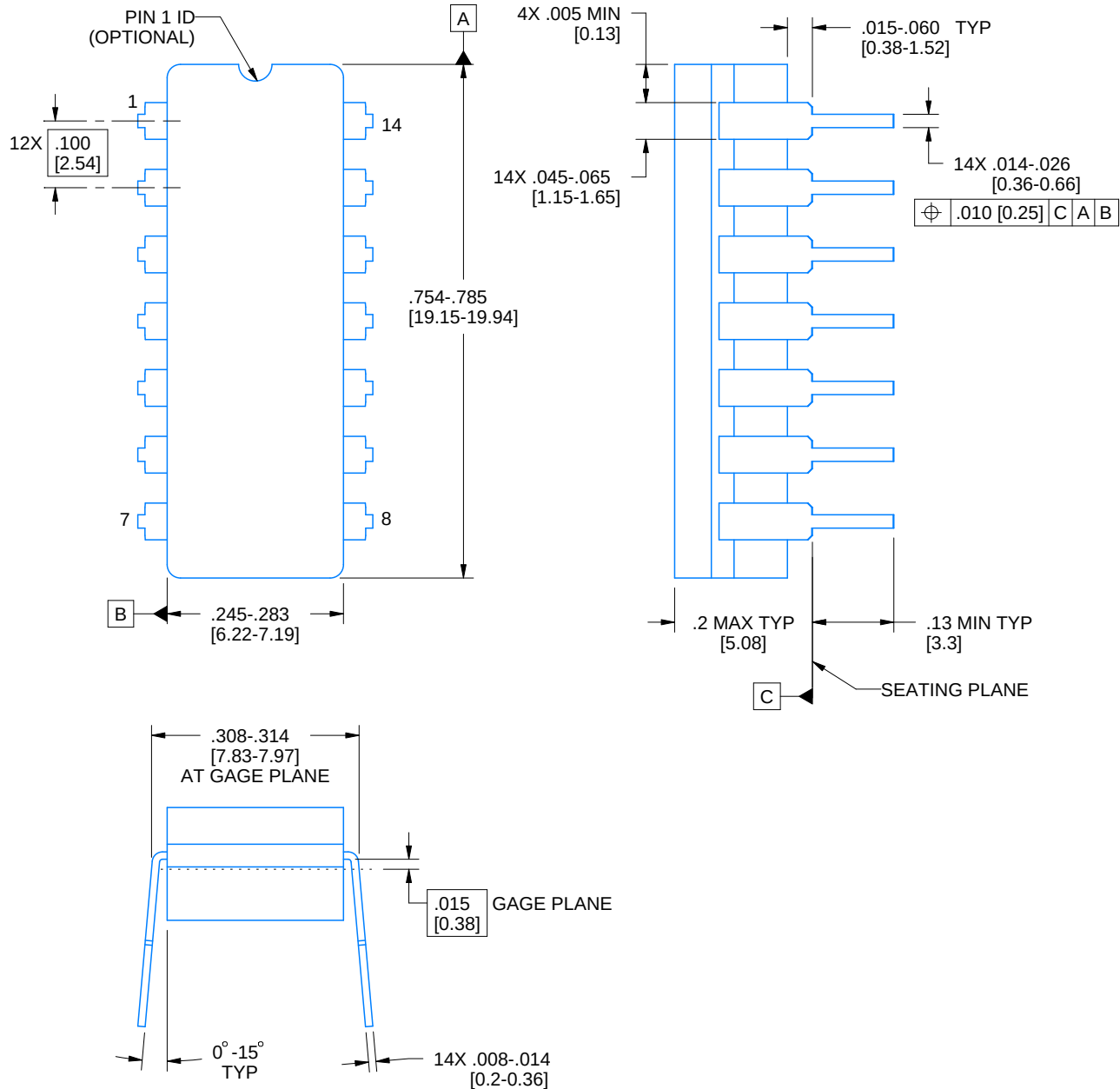


Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4040083-5/G

**J0014A****PACKAGE OUTLINE****CDIP - 5.08 mm max height**

CERAMIC DUAL IN LINE PACKAGE



4214771/A 05/2017

**NOTES:**

1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package is hermetically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
5. Falls within MIL-STD-1835 and GDIP1-T14.



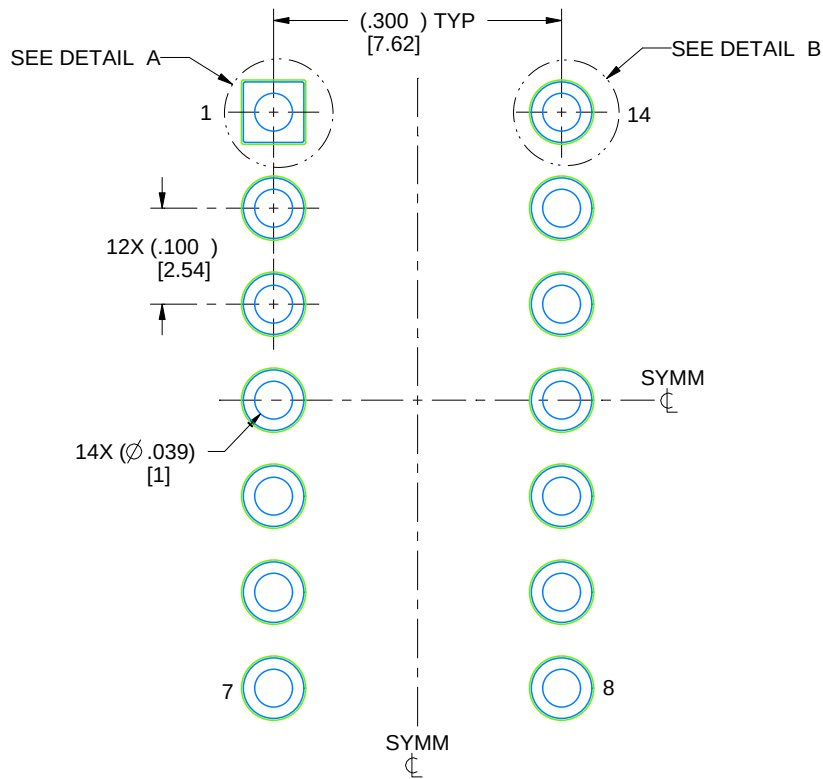
**TEXAS  
INSTRUMENTS**  
www.ti.com

# EXAMPLE BOARD LAYOUT

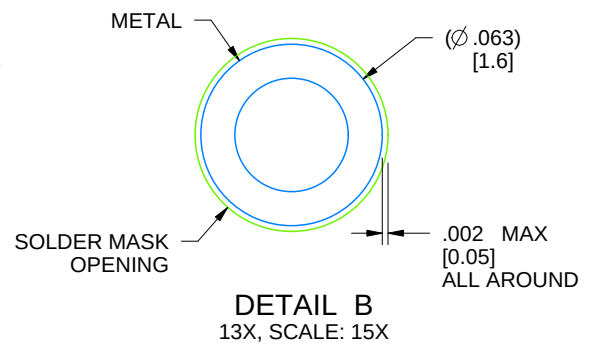
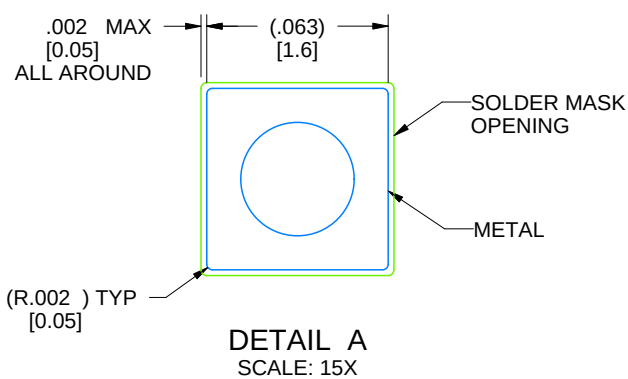
J0014A

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



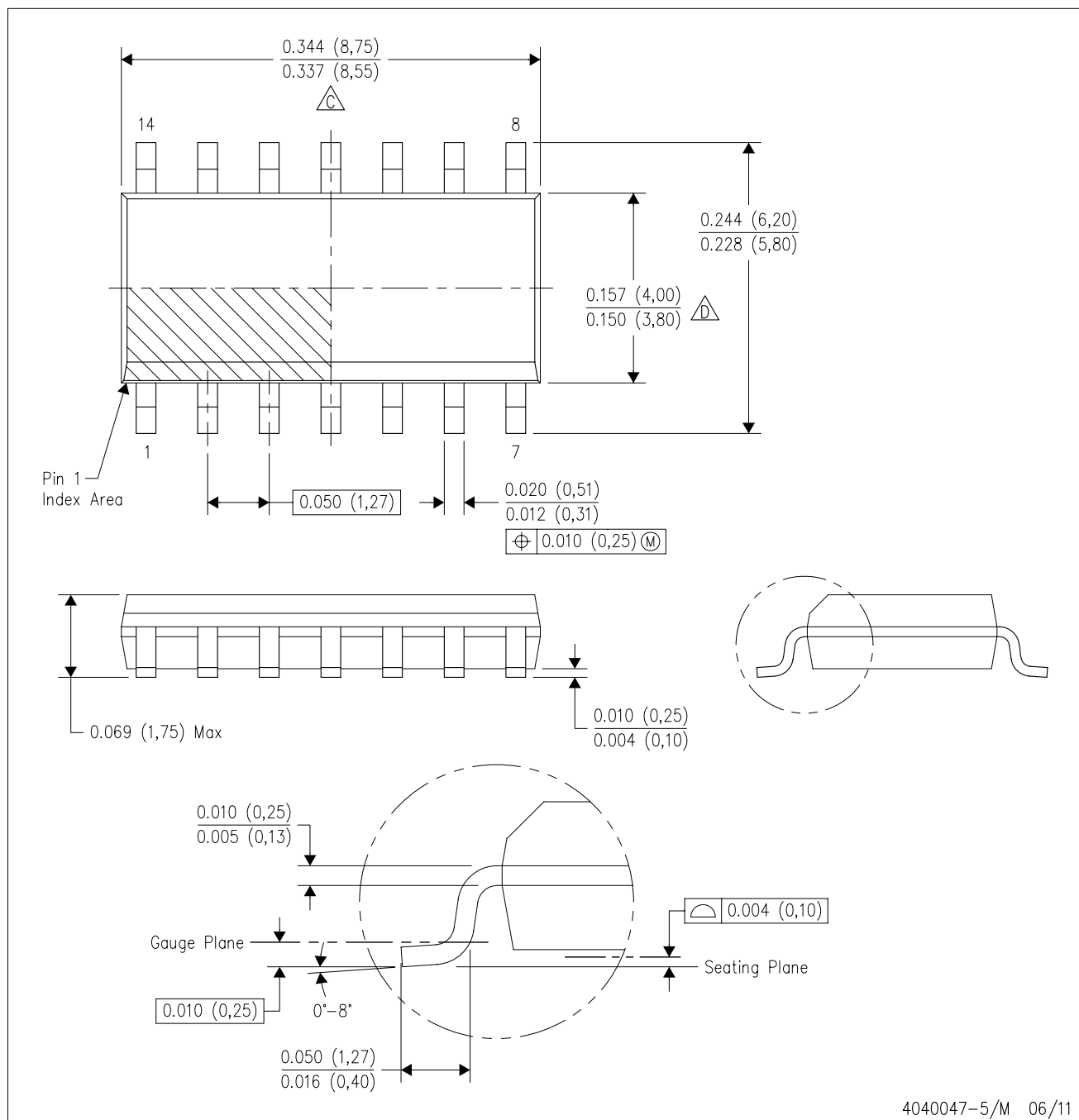
LAND PATTERN EXAMPLE  
NON-SOLDER MASK DEFINED  
SCALE: 5X



4214771/A 05/2017

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



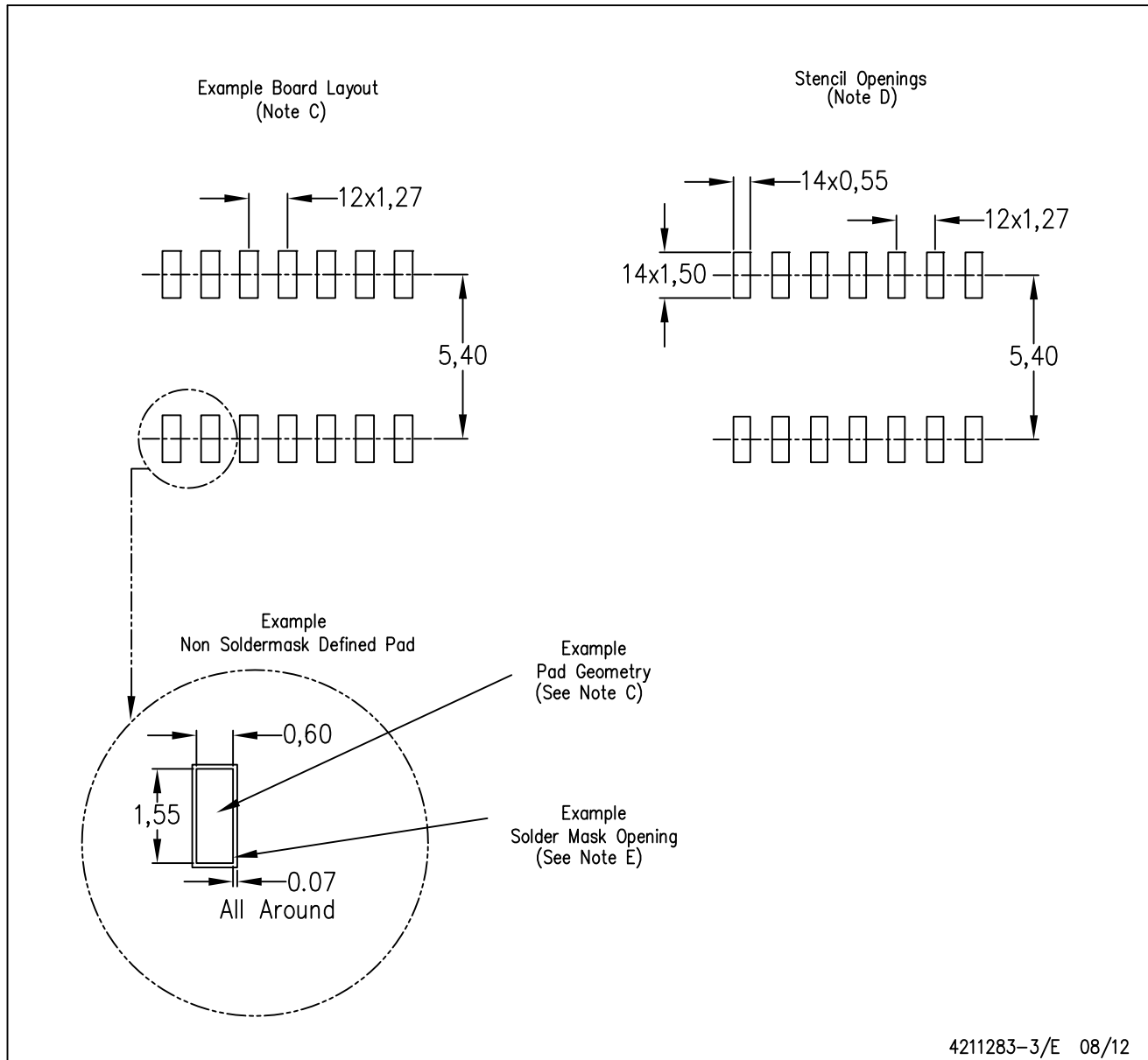
4040047-5/M 06/11

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

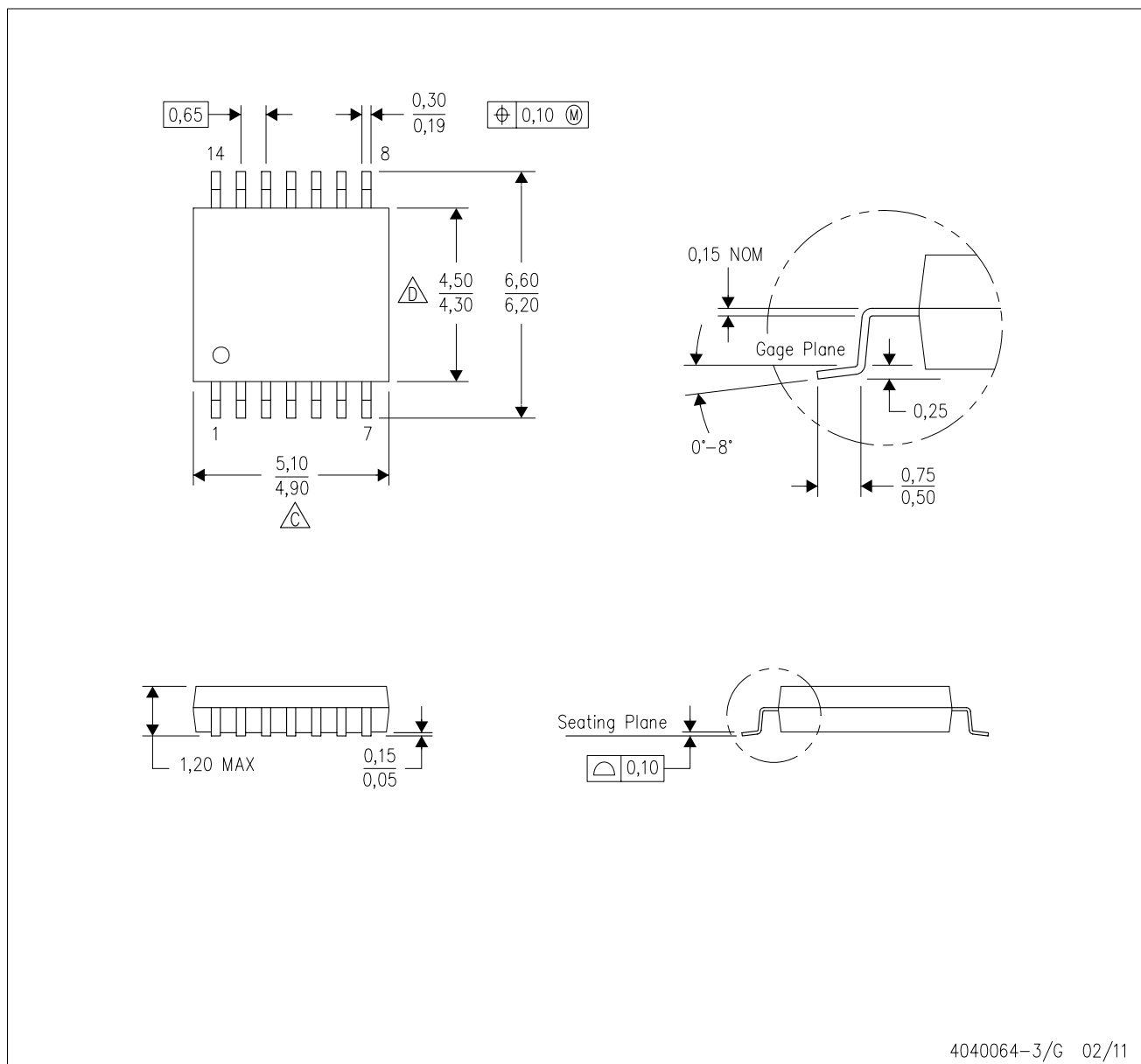
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE

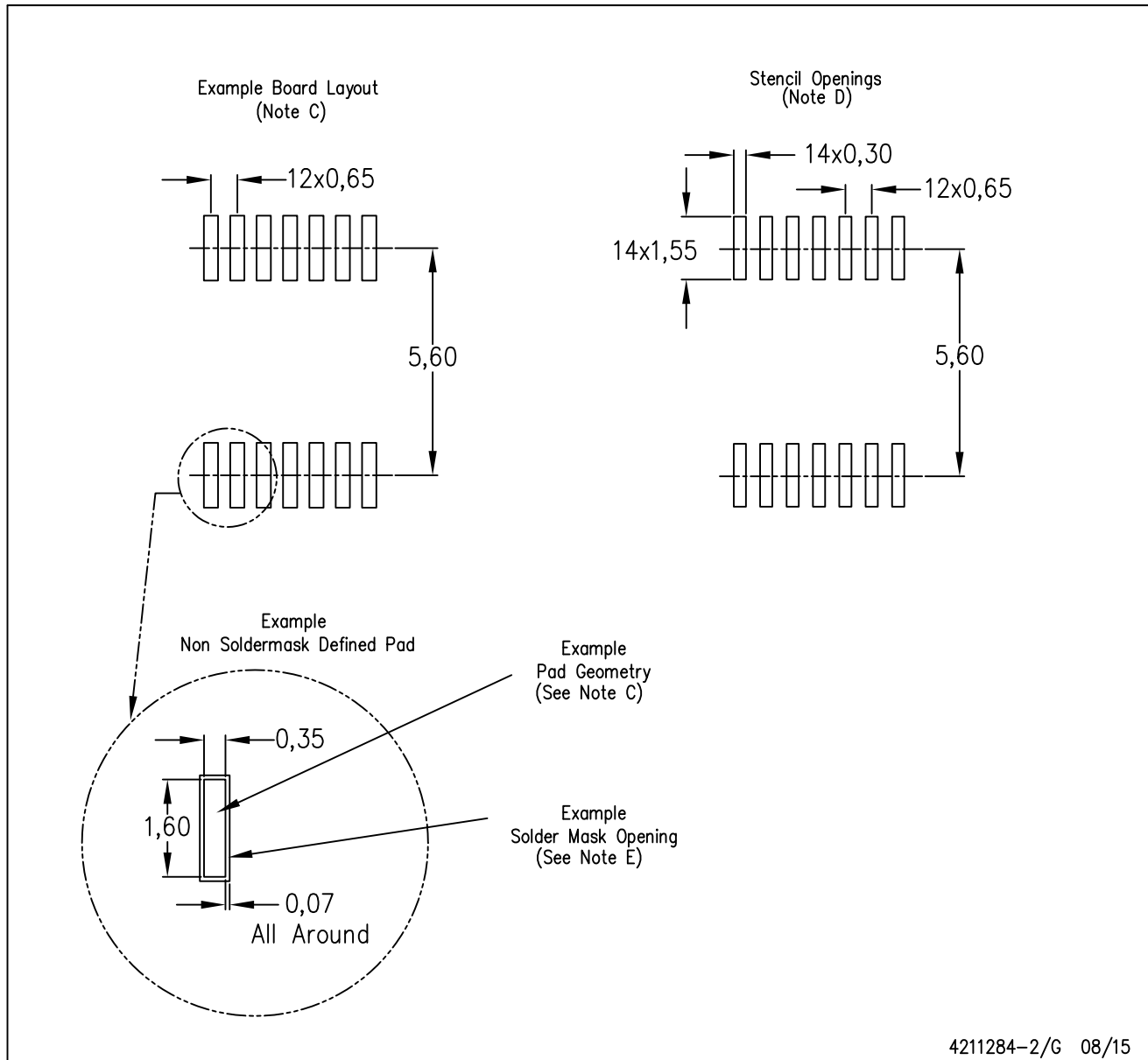


4040064-3/G 02/11

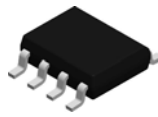
- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

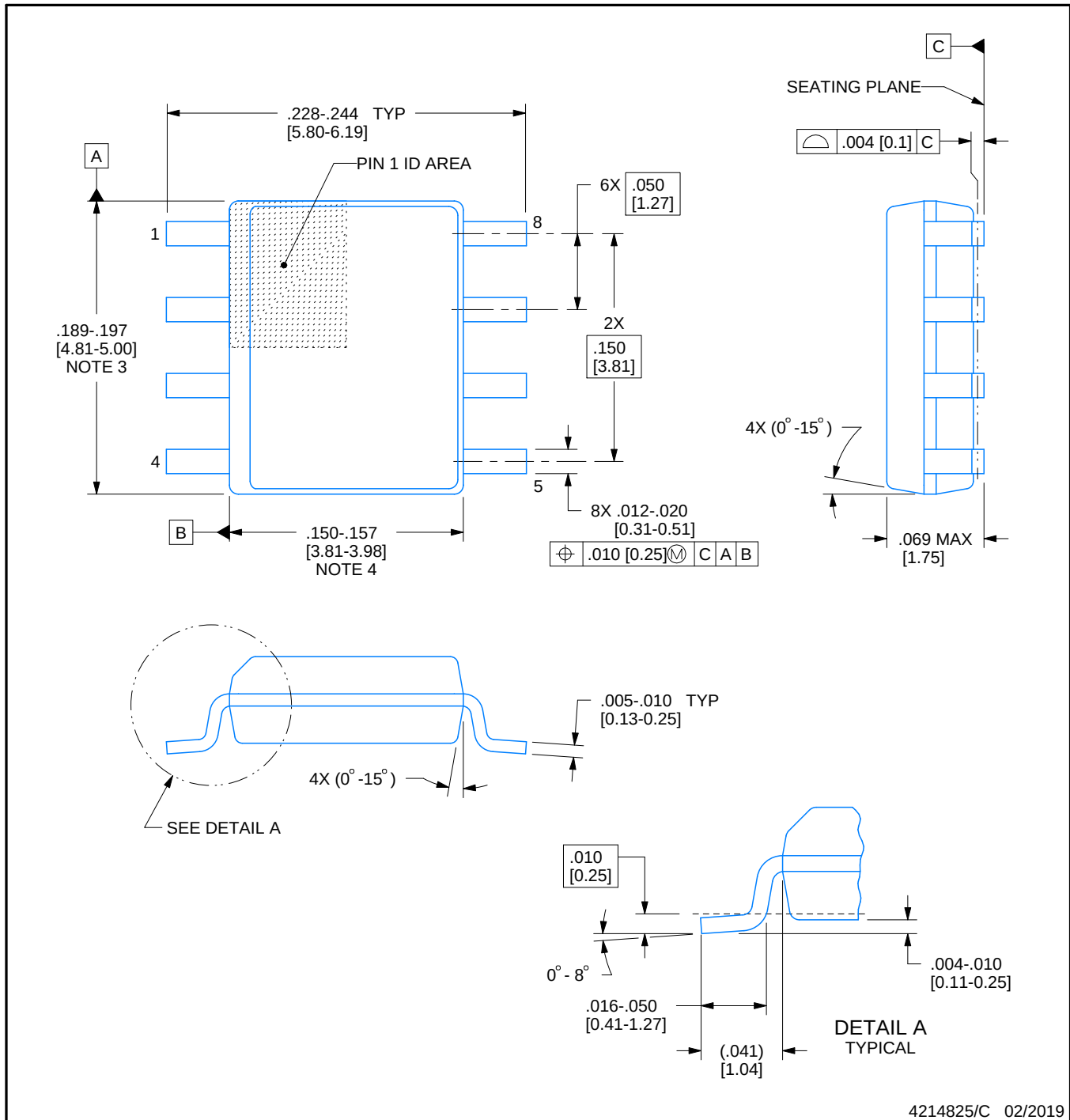


**D0008A**

# PACKAGE OUTLINE

**SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

## NOTES:

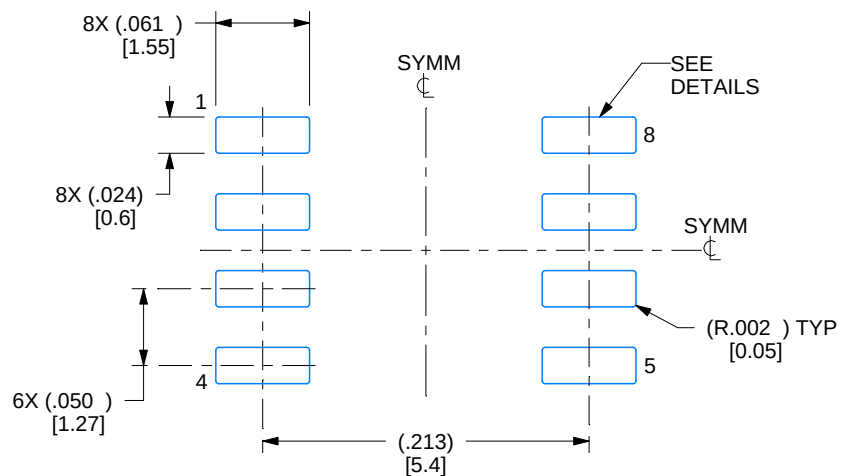
1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.



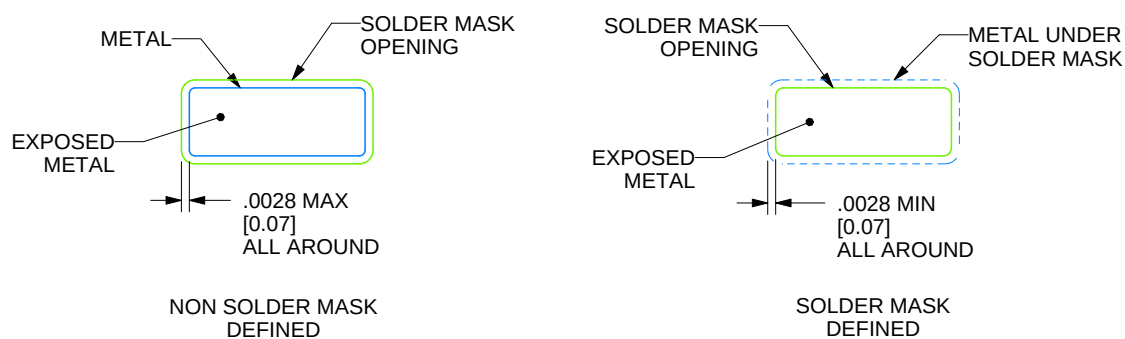
**D0008A**

**SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:8X



## SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

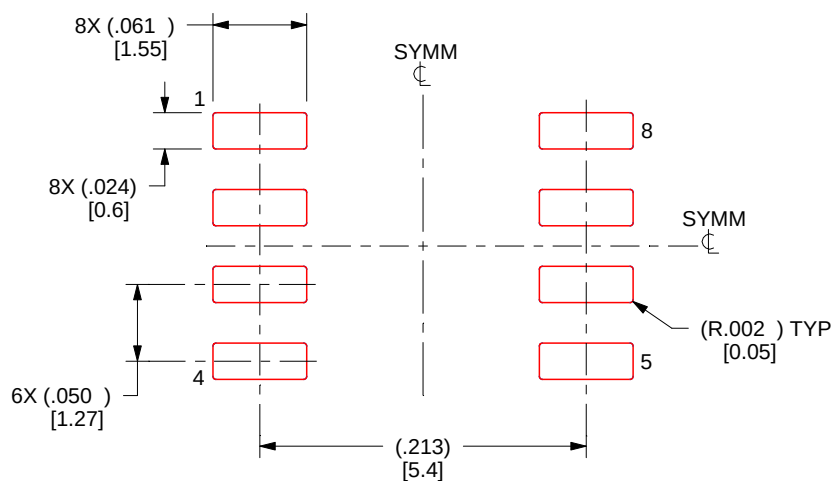
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

4214825/C 02/2019

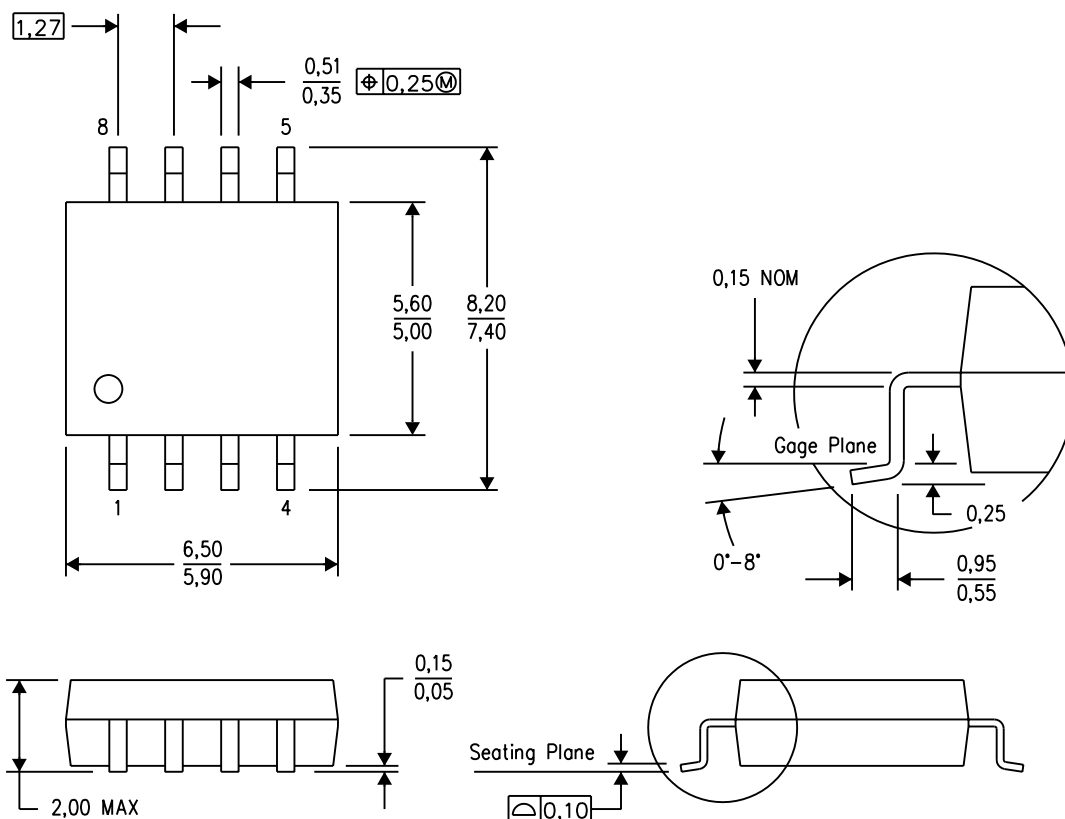
NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

# MECHANICAL DATA

PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE

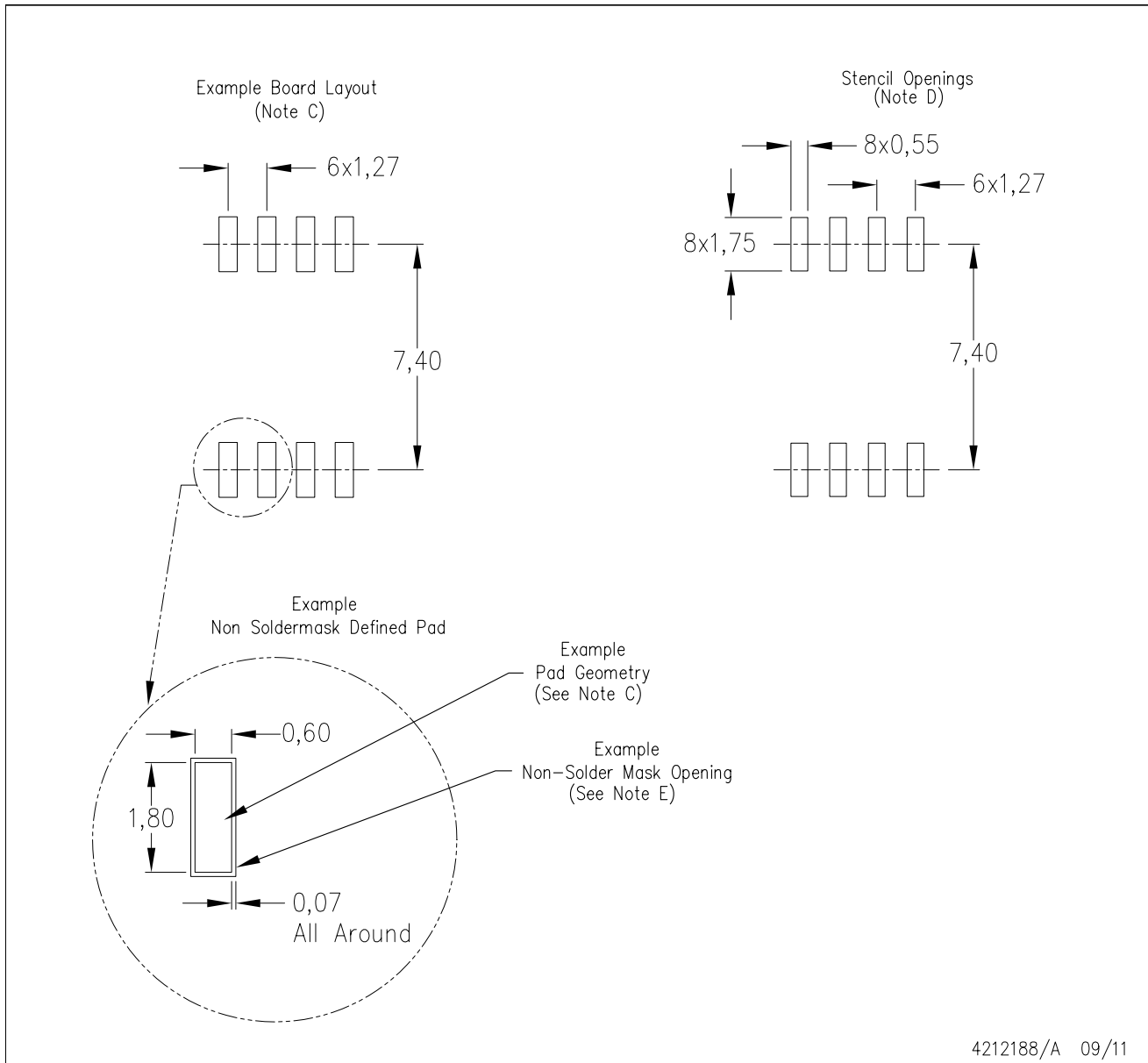


4040063/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

PS (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2022, Texas Instruments Incorporated